#### **Description**

The M16C/61 group of single-chip microcomputers are built using the high-performance silicon gate CMOS process using a M16C/60 Series CPU core and are packaged in a 100-pin plastic molded QFP. These single-chip microcomputers operate using sophisticated instructions featuring a high level of instruction efficiency. With 1M bytes of address space, they are capable of executing instructions at high speed. They also feature a built-in multiplier and DMAC, making them ideal for controlling office, communications, industrial equipment, and other high-speed processing applications.

The M16C/61 group includes a wide range of products with different internal memory types and sizes and various package types.

#### **Features**

Memory capacity	ROM (See Figure 1.1.4. ROM Expansion)
	RAM 4K to 10K bytes
Shortest instruction execution time	100ns (f(XIN)=10MHz)
Supply voltage	4.0 to 5.5V (f(XIN)=10MHz)
	2.7 to 5.5V (f(XIN)=7MHz with software one-wait)
Low power consumption	18mW ( $f(XIN)=7MHz$ , with software one-wait, $VCC=3V$ )
• Interrupts	20 internal and 5 external interrupt sources, 4 software
	interrupt sources; 7 levels (including key input interrupt)
Multifunction 16-bit timer	5 output timers + 3 input timers
Serial I/O (UART or clock synchronous)	3 channels
• DMAC	2 channels (trigger: 16 sources)
A-D converter	10 bits X 8 channels
	(Expandable up to 10 channels)
D-A converter	8 bits X 2 channels
CRC calculation circuit	1 circuit
Watchdog timer	1 line
Programmable I/O	87 lines
Input port	1 line (P85 shared with NMI pin)
Memory expansion	Available (to a maximum of 1M bytes)
Chip select output	4 lines
Clock generating circuit	2 built-in clock generation circuits
	(built-in feedback resistor, and external ceramic or quartz oscillator)

# **Applications**

Audio, cameras, office equipment, communications equipment, portable equipment

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# **Pin Configuration**

Figures 1.1.1 and 1.1.2 show the pin configurations (top view).

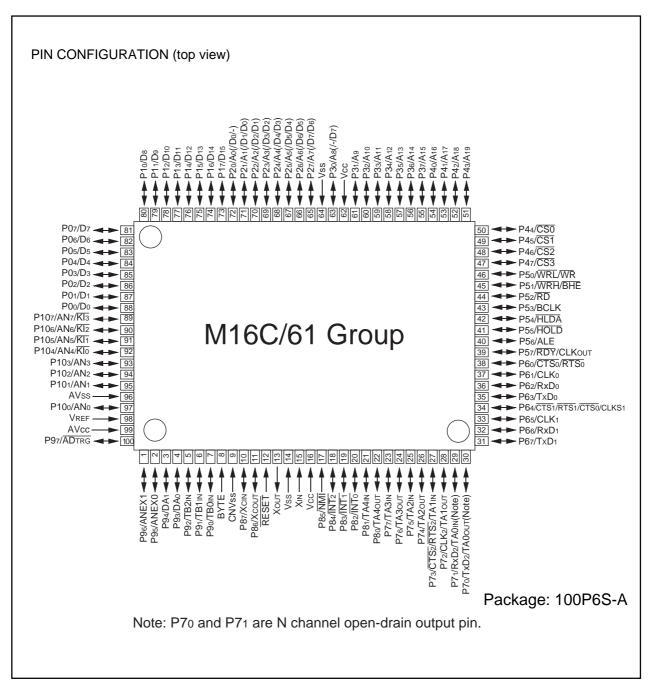


Figure 1.1.1. Pin configuration (top view)



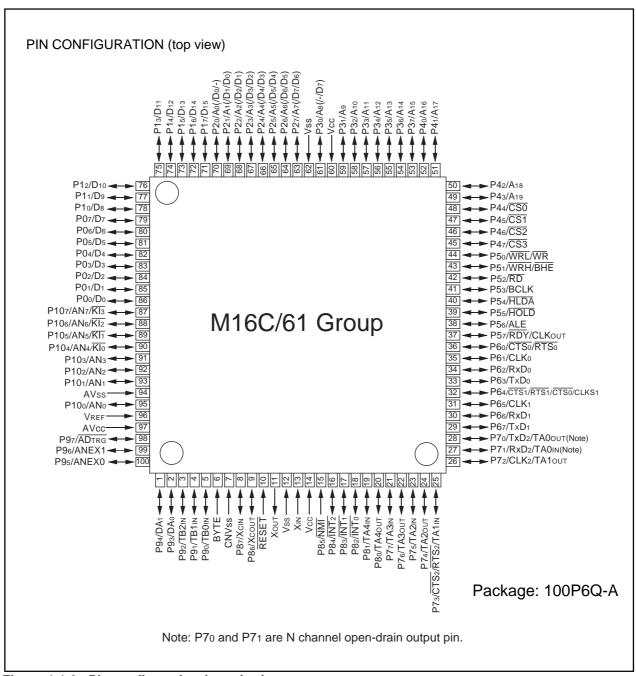


Figure 1.1.2. Pin configuration (top view)

# **Block Diagram**

Figure 1.1.3 is a block diagram of the M16C/61 group.

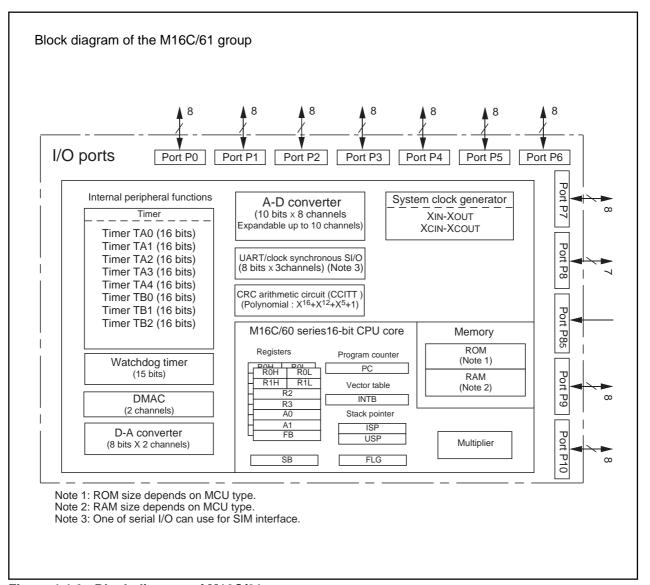


Figure 1.1.3. Block diagram of M16C/61 group

# **Performance Outline**

Table 1.1.1 is a performance outline of M16C/61 group.

Table 1.1.1. Performance outline of M16C/61 group

	Item	Performance		
Number of basic instructions		91 instructions		
Shortest instruction	n execution time	100ns(f(XIN)=10MHz)		
Memory	ROM	(See the Figure 4. ROM Expansion)		
capacity	RAM	4K to 10K bytes		
I/O port	P0 to P10 (except P85)	8 bits x 10, 7 bits x 1		
Input port	P85	1 bit x 1		
Multifunction	TA0, TA1, TA2, TA3, TA4	16 bits x 5		
timer	TB0, TB1, TB2	16 bits x 3		
Serial I/O	UART0, UART1, UART2	(UART or clock synchronous) x 3		
A-D converter		10 bits x (8 + 2) channels		
D-A converter		8 bits x 2		
DMAC		2 channels (trigger: 16 sources)		
CRC calculation ci	rcuit	CRC - CCITT		
Watchdog timer		15 bits x 1 (with prescaler)		
Interrupt		20 internal and 5 external sources, 4 software sources, 7 levels		
Clock generating c	ircuit	2 built-in clock generation circuits		
		(built-in feedback resistor, and external ceramic or quartz oscillato		
Supply voltage		4.0 to 5.5V (f(XIN) = 10MHz)		
		2.7 to 5.5V(f(XIN)=7MHz with software one-wait)		
Power consumptio	n	18mW (f(XIN) = 7MHz with software one-wait, VCC = 3V)		
I/O	I/O withstand voltage	5V		
characteristics	Output current	5mA		
Memory expansion	1	Available (to a maximum of 1M bytes)		
Device configuration	on	CMOS silicon gate		
Package		100-pin plastic mold QFP		



Mitsubishi plans to release the following products in the M16C/61 group:

- (1) Support for mask ROM version, external ROM version, one-time PROM version, and EPROM version
- (2) ROM capacity
- (3) Package

100P6S-A : Plastic molded QFP (mask ROM version and one-time PROM version) 100P6Q-A : Plastic molded QFP (mask ROM version and one-time PROM version)

100D0 : Ceramic LCC (EPROM version)

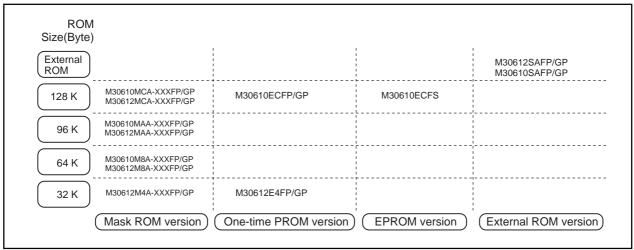


Figure 1.1.4. ROM expansion

The M16C/61 group products currently supported are listed in Table 2.

Table 1.1.2. M16C/61 group

Apr. 1999

Type No	ROM capacity	RAM capacity	Package type	Remarks
M30612M4A-XXXFP	, ,		100P6S-A	
M30612M4A-XXXGP	32K byte	4K byte	100P6Q-A	
M30610M8A-XXXFP			100P6S-A	
M30610M8A-XXXGP	_	10K byte	100P6Q-A	
M30612M8A-XXXFP	64K byte	ALC I	100P6S-A	
M30612M8A-XXXGP		4K byte	100P6Q-A	
M30610MAA-XXXFP		40K by #6	100P6S-A	
M30610MAA-XXXGP	OCK byte	10K byte	100P6Q-A	Mask ROM version
M30612MAA-XXXFP	96K byte	ALC I	100P6S-A	Wask ROW Version
M30612MAA-XXXGP		4K byte	100P6Q-A	
M30610MCA-XXXFP		10K byte	100P6S-A	
M30610MCA-XXXGP	128K byte	Tork byte	100P6Q-A	
M30612MCA-XXXFP		5K byte	100P6S-A	
M30612MCA-XXXGP		SK byte	100P6Q-A	
M30612E4FP	32K byte	4K byte	100P6S-A	
M30612E4GP	32K byte	4K byte	100P6Q-A	
M30610ECFP	128K byte	10K byte	100P6S-A	One-time PROM version
M30610ECGP	126K byte	Tok byte	100P6Q-A	
M30610ECFS	128K byte	10K byte	100D0	EPROM version (Note)
M30610SAFP		10K byte	100P6S-A	
M30610SAGP		Tork byte	100P6Q-A	External ROM version
M30612SAFP		4K byte	100P6S-A	External NOW Version
M30612SAGP		4K byte	100P6Q-A	

Note: Do not use the EPROM version for mass production, because it is a tool for program development (for evaluation).



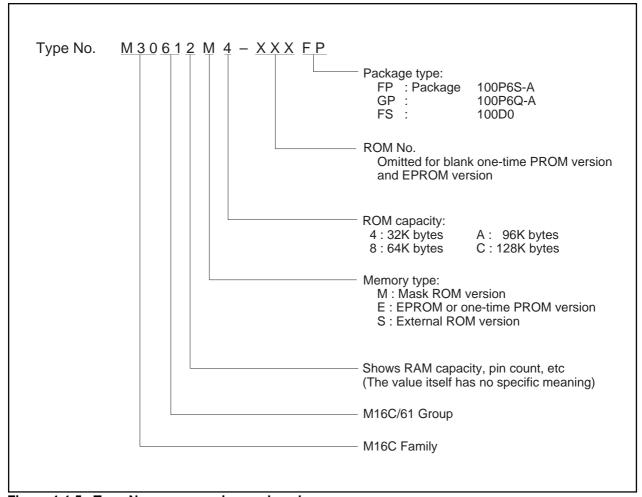


Figure 1.1.5. Type No., memory size, and package

# **Pin Description**

Pin name	Signal name	I/O type	Function
Vcc, Vss	Power supply input		Supply 2.7 to 5.5 V to the Vcc pin. Supply 0 V to the Vss pin.
CNVss	CNVss	Input	This pin switches between processor modes. Connect it to the Vss pin when operating in single-chip or memory expansion mode. Connect it to the Vcc pin when in microprocessor mode.
RESET	Reset input	Input	A "L" on this input resets the microcomputer.
XIN	Clock input	Input	These pins are provided for the main clock generating circuit.Connect
Xout	Clock output	Output	a ceramic resonator or crystal between the XIN and the XOUT pins. To use an externally derived clock, input it to the XIN pin and leave the XOUT pin open.
BYTE	External data bus width select input	Input	This pin selects the width of an external data bus. A 16-bit width is selected when this input is "L"; an 8-bit width is selected when this input is "H". This input must be fixed to either "H" or "L". When operating in single-chip mode, connect this pin to VSs.
AVcc	Analog power supply input		This pin is a power supply input for the A-D converter. Connect this pin to Vcc.
AVss	Analog power supply input		This pin is a power supply input for the A-D converter. Connect this pin to Vss.
VREF	Reference voltage input	Input	This pin is a reference voltage input for the A-D converter.
P00 to P07	I/O port P0	Input/output	This is an 8-bit CMOS I/O port. It has an input/output port direction register that allows the user to set each pin for input or output individually. When used for input in single-chip mode, the port can be set to have or not have a pull-up resistor in units of four bits by software. In memory expansion and microprocessor modes, selection of the internal pull-resistor is not available.
Do to D7		Input/output	When set as a separate bus, these pins input and output data (Do-D7)
P10 to P17	I/O port P1	Input/output	This is an 8-bit I/O port equivalent to P0.
D8 to D15		Input/output	When set as a separate bus, these pins input and output data (D8-D15)
P20 to P27	I/O port P2	Input/output	This is an 8-bit I/O port equivalent to P0.
Ao to A7		Output	These pins output 8 low-order address bits (A <sub>0</sub> –A <sub>7</sub> ).
A0/D0 to A7/D7		Input/output	If the external bus is set as an 8-bit wide multiplexed bus, these pins input and output data (Do–D7) and output 8 low-order address bits (Ao–A7) separated in time by multiplexing.
A0, A1/D0 to A7/D6		Output Input/output	If the external bus is set as a 16-bit wide multiplexed bus, these pins input and output data (Do–D6) and output address (A1–A7) separated in time by multiplexing. They also output address (A0).
P30 to P37	I/O port P3	Input/output	This is an 8-bit I/O port equivalent to P0.
A8 to A15		Output	These pins output 8 middle-order address bits (A8–A15).
A8/D7, A9 to A15		Input/output Output	If the external bus is set as a 16-bit wide multiplexed bus, these pins input and output data (D7) and output address (A8) separated in time by multiplexing. They also output address (A9–A15).
P40 to P47	I/O port P4	Input/output	This is an 8-bit I/O port equivalent to P0.
CS0 to CS3, A16 to A19		Output Output	These pins output CS0–CS3 signals and A16–A19. CS0–CS3 are chip select signals used to specify an access space. A16–A19 are 4 high-order address bits.



# **Pin Description**

Pin name	Signal name	I/O type	Function
P50 to P57	I/O port P5	Input/output	This is an 8-bit I/O port equivalent to P0. In single-chip mode, P57 in this port outputs a divide-by-8 or divide-by-32 clock of XIN or a clock of the same frequency as XCIN as selected by software.
WRL / WR, WRH / BHE, RD, BCLK, HLDA, HOLD,		Output Output Output Output Input Output Input	Output WRL, WRH (WR and BHE), RD, BCLK, HLDA, and ALE signals. WRL and WRH, and BHE and WR can be switched using software control.  WRL, WRH, and RD selected With a 16-bit external data bus, data is written to even addresses when the WRL signal is "L" and to the odd addresses when the WRH signal is "L". Data is read when RD is "L".  WR, BHE, and RD selected Data is written when WR is "L". Data is read when RD is "L". Odd addresses are accessed when BHE is "L". Use this mode when using an 8-bit external data bus. While the input level at the HOLD pin is "L", the microcomputer is placed in the hold state. While in the hold state, HLDA outputs a "L" level. ALE is used to latch the address. While the input level of the RDY pin is "L", the microcomputer is in the ready state.
P60 to P67	I/O port P6	Input/output	This is an 8-bit I/O port equivalent to P0. When used for input in single-chip, memory expansion, and microprocessor modes, the port can be set to have or not have a pull-up resistor in units of four bits by software. Pins in this port also function as UART0 and UART1 I/O pins as selected by software.
P70 to P77	I/O port P7	Input/output	This is an 8-bit I/O port equivalent to P6 (P70 and P71 are N channel open-drain output). Pins in this port also function as timer A0–A3 or UART2 I/O pins as selected by software.
P80 to P84, P86, P87, P85	I/O port P8	Input/output Input/output Input/output Input	P80 to P84, P86, and P87 are I/O ports with the same functions as P6. Using software, they can be made to function as the I/O pins for timer A4 and the input pins for external interrupts. P86 and P87 can be set using software to function as the I/O pins for a sub clock generation circuit. In this case, connect a quartz oscillator between P86 (XCOUT pin) and P87 (XCIN pin). P85 is an input-only port that also functions for NMI. The NMI interrupt is generated when the input at this pin changes from "H" to "L". The NMI function cannot be cancelled using software. The pull-up cannot be set for this pin.
P90 to P97	I/O port P9	Input/output	This is an 8-bit I/O port equivalent to P6. Pins in this port also function as Timer B0–B2 input pins, D-A converter output pins, A-D converter extended input pins, or A-D trigger input pins as selected by software.
P100 to P107	I/O port P10	Input/output	This is an 8-bit I/O port equivalent to P6. Pins in this port also function as A-D converter input pins. Furthermore, P104–P107 also function as input pins for the key input interrupt function.



# **Operation of Functional Blocks**

The M16C/61 group accommodates certain units in a single chip. These units include ROM and RAM to store instructions and data and the central processing unit (CPU) to execute arithmetic/logic operations. Also included are peripheral units such as timers, serial I/O, D-A converter, DMAC, CRC calculation circuit, A-D converter, and I/O ports.

The following explains each unit.

# Memory

Figure 1.4.1 is a memory map of the M16C/61 group. The address space extends the 1M bytes from address 0000016 to FFFF16. From FFFF16 down is ROM. For example, in the M30612M4A-XXXFP, there is 32K bytes of internal ROM from F800016 to FFFF16. The vector table for fixed interrupts such as the reset and  $\overline{\text{NMI}}$  are mapped to FFFDC16 to FFFFF16. The starting address of the interrupt routine is stored here. The address of the vector table for timer interrupts, etc., can be set as desired using the internal register (INTB). See the section on interrupts for details.

From 0040016 up is RAM. For example, in the M30612M4A-XXXFP, 4K bytes of internal RAM is mapped to the space from 0040016 to 013FF16. In addition to storing data, the RAM also stores the stack used when calling subroutines and when interrupts are generated.

The SFR area is mapped to 0000016 to 003FF16. This area accommodates the control registers for peripheral devices such as I/O ports, A-D converter, serial I/O, and timers, etc. Any part of the SFR area that is not occupied is reserved and cannot be used for other purposes.

The special page vector table is mapped to FFE0016 to FFFDB16. If the starting addresses of subroutines or the destination addresses of jumps are stored here, subroutine call instructions and jump instructions can be used as 2-byte instructions, reducing the number of program steps.

In memory expansion mode and microprocessor mode, a part of the spaces are reserved and cannot be used. For example, in the M30612M4A-XXXFP, the following spaces cannot be used.

- The space between 0140016 and 03FFF16
- The space between D000016 and F7FFF16 (When external area do not expand in memory expansion mode)

Do not expand the external area in single chip mode. A part of internal memory cannot be used depending on MCU.

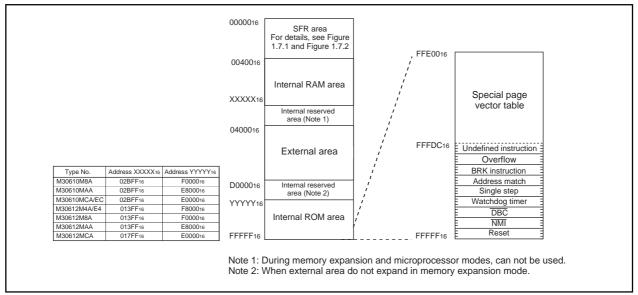


Figure 1.4.1. Memory map



# **Central Processing Unit (CPU)**

The CPU has a total of 13 registers shown in Figure 1.5.1. Seven of these registers (R0, R1, R2, R3, A0, A1, and FB) come in two sets; therefore, these have two register banks.

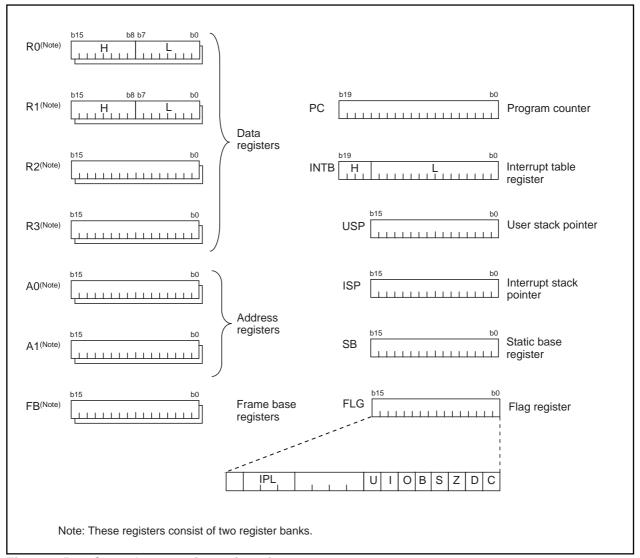


Figure 1.5.1. Central processing unit register

#### (1) Data registers (R0, R0H, R0L, R1, R1H, R1L, R2, and R3)

Data registers (R0, R1, R2, and R3) are configured with 16 bits, and are used primarily for transfer and arithmetic/logic operations.

Registers R0 and R1 each can be used as separate 8-bit data registers, high-order bits as (R0H/R1H), and low-order bits as (R0L/R1L). In some instructions, registers R2 and R0, as well as R3 and R1 can use as 32-bit data registers (R2R0/R3R1).

# (2) Address registers (A0 and A1)

Address registers (A0 and A1) are configured with 16 bits, and have functions equivalent to those of data registers. These registers can also be used for address register indirect addressing and address register relative addressing.

In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).



# (3) Frame base register (FB)

Frame base register (FB) is configured with 16 bits, and is used for FB relative addressing.

# (4) Program counter (PC)

Program counter (PC) is configured with 20 bits, indicating the address of an instruction to be executed.

# (5) Interrupt table register (INTB)

Interrupt table register (INTB) is configured with 20 bits, indicating the start address of an interrupt vector table.

### (6) Stack pointer (USP/ISP)

Stack pointer comes in two types: user stack pointer (USP) and interrupt stack pointer (ISP), each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by a stack pointer select flag (U flag). This flag is located at the position of bit 7 in the flag register (FLG).

# (7) Static base register (SB)

Static base register (SB) is configured with 16 bits, and is used for SB relative addressing.

# (8) Flag register (FLG)

Flag register (FLG) is configured with 11 bits, each bit is used as a flag. Figure 1.5.2 shows the flag register (FLG). The following explains the function of each flag:

### • Bit 0: Carry flag (C flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

#### • Bit 1: Debug flag (D flag)

This flag enables a single-step interrupt.

When this flag is "1", a single-step interrupt is generated after instruction execution. This flag is cleared to "0" when the interrupt is acknowledged.

# • Bit 2: Zero flag (Z flag)

This flag is set to "1" when an arithmetic operation resulted in 0; otherwise, cleared to "0".

#### • Bit 3: Sign flag (S flag)

This flag is set to "1" when an arithmetic operation resulted in a negative value; otherwise, cleared to "0".

# • Bit 4: Register bank select flag (B flag)

This flag chooses a register bank. Register bank 0 is selected when this flag is "0"; register bank 1 is selected when this flag is "1".

#### • Bit 5: Overflow flag (O flag)

This flag is set to "1" when an arithmetic operation resulted in overflow; otherwise, cleared to "0".

#### • Bit 6: Interrupt enable flag (I flag)

This flag enables a maskable interrupt.

An interrupt is disabled when this flag is "0", and is enabled when this flag is "1". This flag is cleared to "0" when the interrupt is acknowledged.



#### • Bit 7: Stack pointer select flag (U flag)

Interrupt stack pointer (ISP) is selected when this flag is "0"; user stack pointer (USP) is selected when this flag is "1".

This flag is cleared to "0" when a hardware interrupt is acknowledged or an INT instruction of software interrupt Nos. 0 to 31 is executed.

#### • Bits 8 to 11: Reserved area

#### • Bits 12 to 14: Processor interrupt priority level (IPL)

Processor interrupt priority level (IPL) is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than the processor interrupt priority level (IPL), the interrupt is enabled.

#### • Bit 15: Reserved area

The C, Z, S, and O flags are changed when instructions are executed. See the software manual for details.

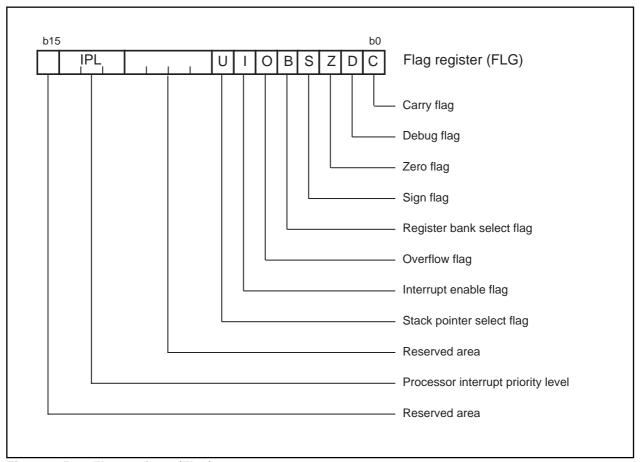


Figure 1.5.2. Flag register (FLG)

#### Reset

There are two kinds of resets; hardware and software. In both cases, operation is the same after the reset. (See "Software Reset" for details of software resets.) This section explains on hardware resets.

When the supply voltage is in the range where operation is guaranteed, a reset is effected by holding the reset pin level "L" (0.2Vcc max.) for at least 20 cycles. When the reset pin level is then returned to the "H" level while main clock is stable, the reset status is cancelled and program execution resumes from the address in the reset vector table.

Figure 1.6.1 shows the example reset circuit. Figure 1.6.2 shows the reset sequence.

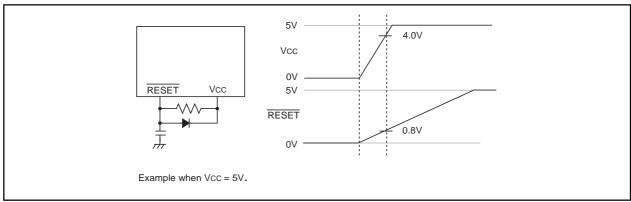


Figure 1.6.1. Example reset circuit

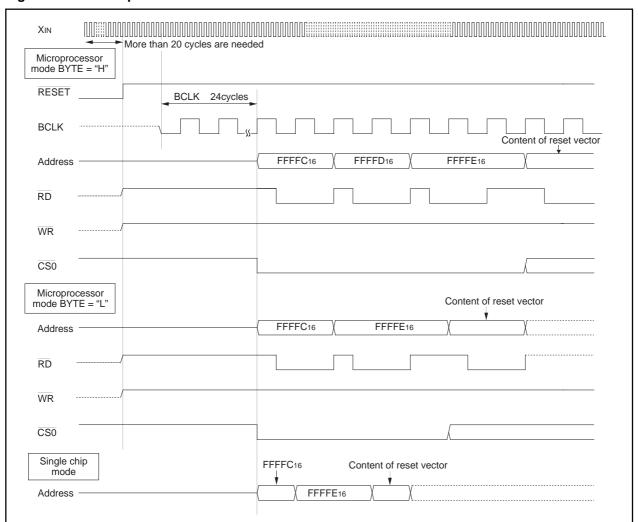


Figure 1.6.2. Reset sequence



Table 1.6.1 shows the statuses of the other pins while the  $\overline{\text{RESET}}$  pin level is "L". Figure 1.6.3 shows the internal status of the microcomputer immediately after the reset is cancelled.

Table 1.6.1. Pin status when RESET pin level is "L"

	Status				
Pin name	ONIVes Ves	CNVss = Vcc			
	CNVss = Vss	BYTE = Vss	BYTE = Vcc		
P0	Input port (floating)	Data input (floating)	Data input (floating)		
P1	Input port (floating)	Data input (floating)	Input port (floating)		
P2, P3, P40 to P43	Input port (floating)	Address output (undefined)	Address output (undefined)		
P44	Input port (floating)	CS0 output ("H" level is output)	CS0 output ("H" level is output)		
P45 to P47	Input port (floating)	Input port (floating)	Input port (floating)		
P50	Input port (floating)	WR output ("H" level is output)	WR output ("H" level is output)		
P51	Input port (floating)	BHE output (undefined)	BHE output (undefined)		
P52	Input port (floating)	RD output ("H" level is output)	RD output ("H" level is output)		
P53	Input port (floating)	BCLK output	BCLK output		
P54	Input port (floating)	HLDA output (The output value depends on the input to the HOLD pin)	HLDA output (The output value depends on the input to the HOLD pin)		
P55	Input port (floating)	HOLD input (floating)	HOLD input (floating)		
P56	Input port (floating)	ALE output ("L" level is output)	ALE output ("L" level is output)		
P57	Input port (floating)	RDY input (floating)	RDY input (floating)		
P6, P7, P80 to P84, P86, P87, P9, P10	Input port (floating)	Input port (floating)	Input port (floating)		



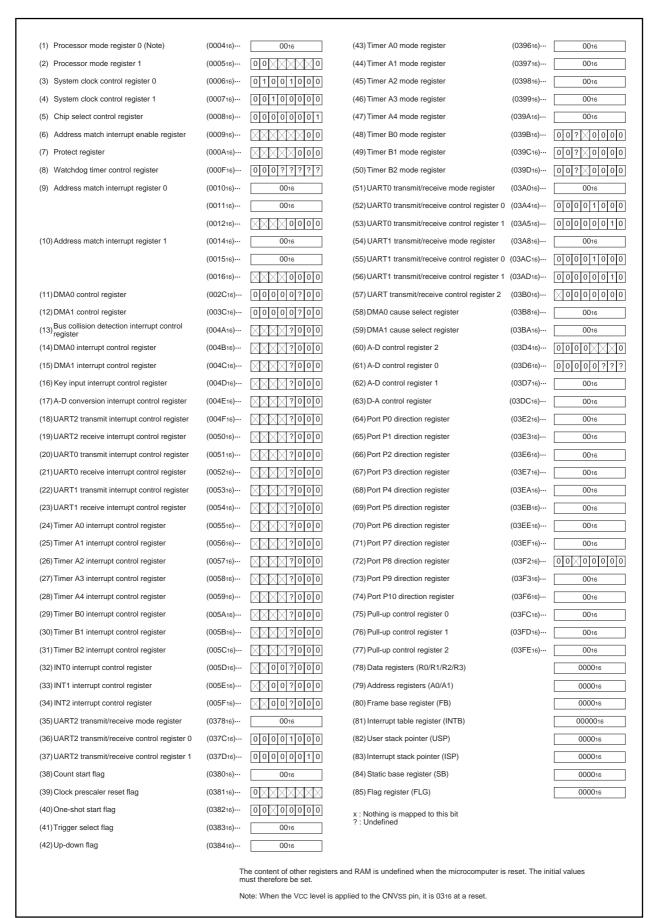


Figure 1.6.3. Device's internal status after a reset is cleared



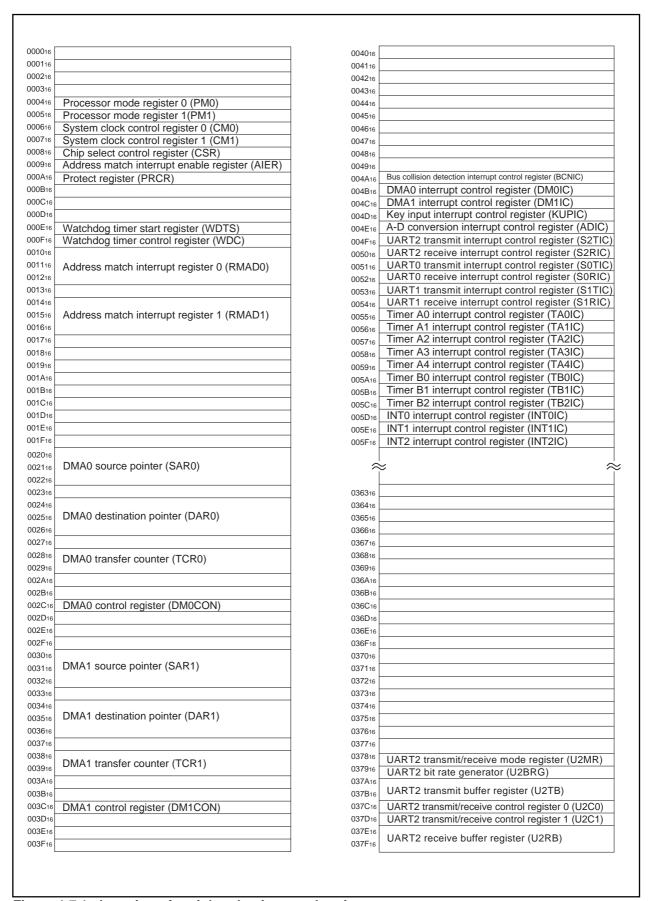


Figure 1.7.1. Location of peripheral unit control registers



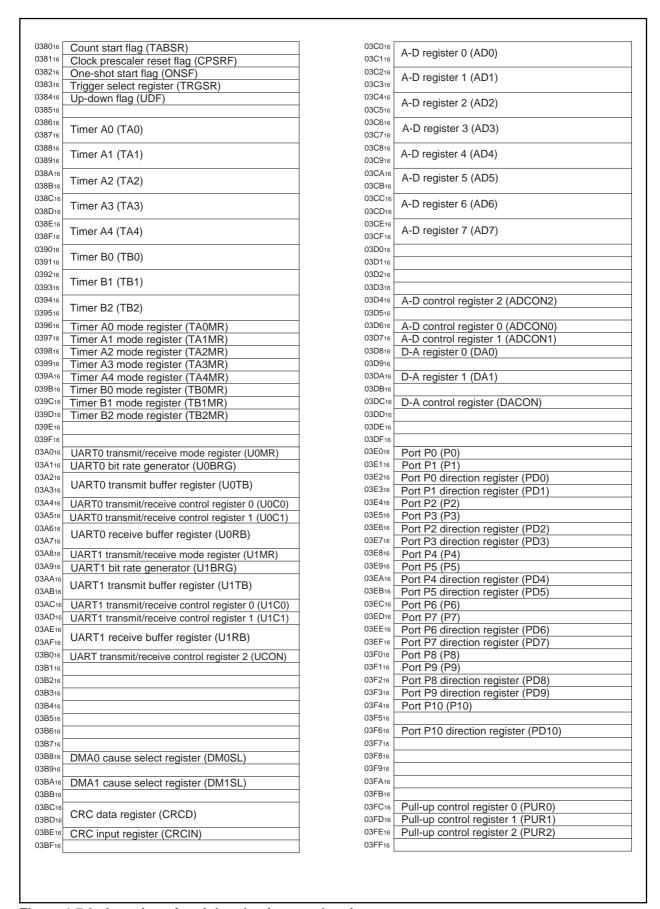


Figure 1.7.2. Location of peripheral unit control registers



#### Software Reset

Writing "1" to bit 3 of the processor mode register 0 (address 000416) applies a (software) reset to the microcomputer. A software reset has almost the same effect as a hardware reset. The contents of internal RAM are preserved.

#### **Processor Mode**

### (1) Types of Processor Mode

One of three processor modes can be selected: single-chip mode, memory expansion mode, and microprocessor mode. The functions of some pins, the memory map, and the access space differ according to the selected processor mode.

#### Single-chip mode

In single-chip mode, only internal memory space (SFR, internal RAM, and internal ROM) can be accessed. Ports P0 to P10 can be used as programmable I/O ports or as I/O ports for the internal peripheral functions.

# • Memory expansion mode

In memory expansion mode, external memory can be accessed in addition to the internal memory space (SFR, internal RAM, and internal ROM).

In this mode, some of the pins function as the address bus, the data bus, and as control signals. The number of pins assigned to these functions depends on the bus and register settings. (See "Bus Settings" for details.)

#### Microprocessor mode

In microprocessor mode, the SFR, internal RAM, and external memory space can be accessed. The internal ROM area cannot be accessed.

In this mode, some of the pins function as the address bus, the data bus, and as control signals. The number of pins assigned to these functions depends on the bus and register settings. (See "Bus Settings" for details.)

#### (2) Setting Processor Modes

The processor mode is set using the CNVss pin and the processor mode bits (bits 1 and 0 at address 000416). Do not set the processor mode bits to "102".

Regardless of the level of the CNVss pin, changing the processor mode bits selects the mode. Therefore, never change the processor mode bits when changing the contents of other bits. Also do not attempt to shift to or from the microprocessor mode within the program stored in the internal ROM area.

#### • Applying Vss to CNVss pin

The microcomputer begins operation in single-chip mode after being reset. Memory expansion mode is selected by writing "012" to the processor mode is selected bits.

#### • Applying Vcc to CNVss pin

The microcomputer starts to operate in microprocessor mode after being reset.

Figure 1.8.1 shows the processor mode register 0 and 1. Figure 1.9.1 shows the memory maps applicable for each of the modes.



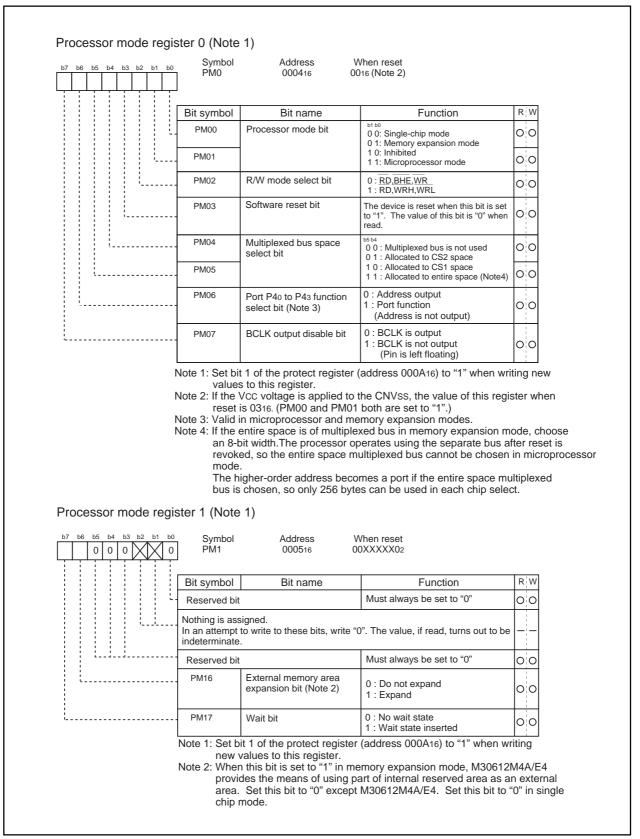


Figure 1.8.1. Processor mode register 0 and 1



	ingle-chip mod	e M	emory expansion mode	Microprocessor mo	ode	
0000016	SFR area		SFR area	SFR area		
0040016						
	Internal RAM		Internal RAM	Internal RAM		
	area		area	area		
XXXXX16		L				
			Internally	Internally		
0400016			reserved area	reserved area		
0400016						
	Inhibited		External area			
	minbited		External area			
D000016			Internally reserved	External area		
YYYYY <sub>16</sub>			area (Note 1)			
1111116						
	Internal ROM		Internal ROM			
FFFFF16	area (Note 2)		area			
FFFF16		L			l	
	Address	Address	External area	: Accessing this area allo	ows the user to	
Type No.	XXXXX16	YYYYY16	External area	access a device conne		
M30610M8A	02BFF16	F000016		to the microcomputer.	,	
M30610MAA	02BFF16	E800016		•		
M30610MCA/EC	02BFF16	E000016	Note 1. This area has	amaa aytaraal araa wha	n DM16 (avtornal	
M30612M4A/E4	013FF16	F800016		omes external area where		
M30612M8A	013FF16	F000016		expansion bit ) = "1" in $N$ $1 \le M30612M4A/E4$ .	/ISUU I ZIVI4/V E4.	
M30612MAA	013FF16	E800016			a avpanaion hit	
M30612MCA	017FF16	E000016	Note 2: Set "0" to PM16 (external memory area expansion bit) in single chip mode.			

Figure 1.9.1. Memory maps in each processor mode

# **Bus Settings**

The BYTE pin and bits 4 to 6 of the processor mode register 0 (address 000416) are used to change the bus settings.

Table 1.10.1 shows the factors used to change the bus settings.

Table 1.10.1. Factors for switching bus settings

Bus setting	Switching factor
Switching external address bus width	Bit 6 of processor mode register 0
Switching external data bus width	BYTE pin
Switching between separate and multiplex bus	Bits 4 and 5 of processor mode register 0

### (1) Selecting external address bus width

The address bus width for external output in the 1M bytes of address space can be set to 16 bits (64K bytes address space) or 20 bits (1M bytes address space). When bit 6 of the processor mode register 0 is set to "1", the external address bus width is set to 16 bits, and P2 and P3 become part of the address bus. P40 to P43 can be used as programmable I/O ports. When bit 6 of processor mode register 0 is set to "0", the external address bus width is set to 20 bits, and P2, P3, and P40 to P43 become part of the address bus.

# (2) Selecting external data bus width

The external data bus width can be set to 8 or 16 bits. (Note, however, that only the separate bus can be set.) When the BYTE pin is "L", the bus width is set to 16 bits; when "H", it is set to 8 bits. (The internal bus width is permanently set to 16 bits.) While operating, fix the BYTE pin either to "H" or to "L".

#### (3) Selecting separate/multiplex bus

The bus format can be set to multiplex or separate bus using bits 4 and 5 of the processor mode register 0.

#### Separate bus

In this mode, the data and address are input and output separately. The data bus can be set using the BYTE pin to be 8 or 16 bits. When the BYTE pin is "H", the data bus is set to 8 bits and P0 functions as the data bus and P1 as a programmable I/O port. When the BYTE pin is "L", the data bus is set to 16 bits and P0 and P1 are both used for the data bus.

When the separate bus is used for access, a software wait can be selected.

#### Multiplex bus

In this mode, data and address I/O are time multiplexed. With an 8-bit data bus selected (BYTE pin = "H"), the 8 bits from D<sub>0</sub> to D<sub>7</sub> are multiplexed with A<sub>0</sub> to A<sub>7</sub>.

With a 16-bit data bus selected (BYTE pin = "L"), the 8 bits from Do to D7 are multiplexed with A1 to A8. D8 to D15 are not multiplexed. In this case, the external devices connected to the multiplexed bus are mapped to the microcomputer's even addresses (every 2nd address). To access these external devices, access the even addresses as bytes.

The ALE signal latches the address. It is output from P56.

Before using the multiplex bus for access, be sure to insert a software wait.

If the entire space is of multiplexed bus in memory expansion mode, choose an 8-bit width.

The processor operates using the separate bus after reset is revoked, so the entire space multiplexed bus cannot be chosen in microprocessor mode.

The higher-order address becomes a port if the entire space multiplexed bus is chosen, so only 256 bytes can be used in each chip select.



Table 1.10.2. Pin functions for each processor mode

Processor mode	Single-chip mode	Memory expansion mode/microprocessor modes				Memory expansion mode	
Multiplexed bus space select bit		"01", "10"  Either CS1 or CS2 is for multiplexed bus and others are for separate bus		"00" (separate bus)		"11" (Note 1) multiplexed bus for the entire space	
Data bus width BYTE pin level		8 bits "H"	16 bits "L"	8 bits "H"	16 bits "L"	8 bit "H"	
P00 to P07	I/O port	Data bus	Data bus	Data bus	Data bus	I/O port	
P10 to P17	I/O port	I/O port	Data bus	I/O port	Data bus	I/O port	
P20	I/O port	Address bus /data bus(Note 2)	Address bus	Address bus	Address bus	Address bus /data bus	
P21 to P27	I/O port	Address bus /data bus(Note 2)	Address bus /data bus(Note 2)	Address bus	Address bus	Address bus /data bus	
P30	I/O port	Address bus /data bus(Note 2)	Address bus	Address bus	Address bus	A8/D7	
P31 to P37	I/O port	Address bus	Address bus	Address bus	Address bus	I/O port	
P40 to P43 Port P40 to P43 function select bit = 1	I/O port	I/O port	I/O port	/O port	I/O port	I/O port	
P40 to P43 Port P40 to P43 function select bit = 0	I/O port	Address bus	Address bus	Address bus	Address bus	I/O port	
P44 to P47	I/O port	CS (chip select (For de	) or programmat tails, refer to "Bu	ole I/O port us control")			
P50 to P53	I/O port		Outputs $\overline{RD}$ , $\overline{WRL}$ , $\overline{WRH}$ , and BCLK or $\overline{RD}$ , $\overline{BHE}$ , $\overline{WR}$ , and BCLK (For details, refer to "Bus control")				
P54	I/O port	HLDA	HLDA	HLDA	HLDA	HLDA	
P55	I/O port	HOLD	HOLD	HOLD	HOLD	HOLD	
P56	I/O port	ALE	ALE	ALE	ALE	ALE	
P57	I/O port	RDY	RDY	RDY	RDY	RDY	

Note 2: Address bus when in separate bus mode.



Note 1: If the entire space is of multiplexed bus in memory expansion mode, choose an 8-bit width.

The processor operates using the separate bus after reset is revoked, so the entire space multiplexed bus cannot be chosen in microprocessor mode.

The higher-order address becomes a port if the entire space multiplexed bus is chosen, so only 256 bytes can be used in each chip select.

#### **Bus Control**

The following explains the signals required for accessing external devices and software waits. The signals required for accessing the external devices are valid when the processor mode is set to memory expansion mode and microprocessor mode. The software waits are valid in all processor modes.

### (1) Address bus/data bus

The address bus consists of the 20 pins A<sub>0</sub> to A<sub>19</sub> for accessing the 1M bytes of address space.

The data bus consists of the pins for data I/O. When the BYTE pin is "H", the 8 ports D<sub>0</sub> to D<sub>7</sub> function as the data bus. When BYTE is "L", the 16 ports D<sub>0</sub> to D<sub>15</sub> function as the data bus.

Both the address and data bus retain their previous states when internal ROM or RAM is accessed. Also, when a change is made from single-chip mode to memory expansion mode, the value of the address bus is undefined until external memory is accessed.

# (2) Chip select signal

The chip select signal is output using the same pins as P44 to P47. Bits 0 to 3 of the chip select control register (address 000816) set each pin to function as a port or to output the chip select signal. The chip select control register is valid in memory expansion mode and microprocessor mode. In single-chip mode, P44 to P47 function as programmable I/O ports regardless of the value in the chip select control register.

In microprocessor mode, only  $\overline{\text{CS0}}$  outputs the chip select signal after the reset state has been cancelled.  $\overline{\text{CS1}}$  to  $\overline{\text{CS3}}$  function as input ports. Therefore, when using  $\overline{\text{CS1}}$  to  $\overline{\text{CS3}}$ , external pull-up resistors are required. Figure 1.11.1 shows the chip select control register.

The chip select signal can be used to split the external area into as many as four blocks. Table 1.11.1 shows the external memory areas specified using the chip select signal.

Table 1.11.1. External areas specified by the chip select signals

Chin coloct	Specified address range				
Chip select	Memory expansion mode	Microprocessor mode			
	3000016 to CFFFF16 (640K)	3000016 to FFFFF16 (832K)			
CS0	3000016 to F7FFF16 (800K) (Note)	3000010101111110 (03211)			
CS1	2800016 to 2FFFF16 (32K)	2800016 to 2FFFF16 (32K)			
CS2	0800016 to 27FFF16 (128K)	0800016 to 27FFF16 (128K)			
CS3	0400016 to 07FFF16 (16K)	0400016 to 07FFF16 (16K)			

Note: When PM16 (External memory area expansion bit) = "1". (Only M30612M4A/E4 is valid.)

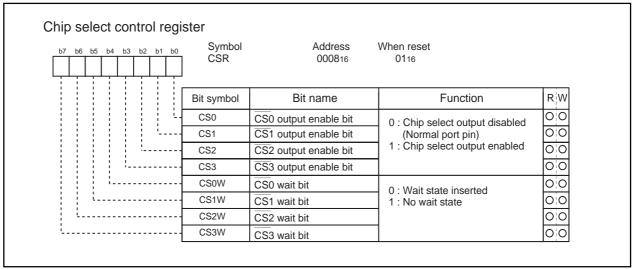


Figure 1.11.1. Chip select control register



# (3) Read/write signals

With a 16-bit data bus (BYTE pin = "L"), bit 2 of the processor mode register 0 (address 000416) select the combinations of  $\overline{RD}$ ,  $\overline{BHE}$ , and  $\overline{WR}$  signals or  $\overline{RD}$ ,  $\overline{WRL}$ , and  $\overline{WRH}$  signals. With an 8-bit data bus (BYTE pin = "H"), use the combination of  $\overline{RD}$ ,  $\overline{WR}$ , and  $\overline{BHE}$  signals. (Set bit 2 of the processor mode register 0 (address 000416) to "0".) Tables 1.11.2 and 1.11.3 show the operation of these signals.

After a reset has been cancelled, the combination of  $\overline{RD}$ ,  $\overline{WR}$ , and  $\overline{BHE}$  signals is automatically selected. When switching to the  $\overline{RD}$ ,  $\overline{WRL}$ , and  $\overline{WRH}$  combination, do not write to external memory until bit 2 of the processor mode register 0 (address 000416) has been set (Note).

Note: Before attempting to change the contents of the processor mode register 0, set bit 1 of the protect register (address 000A<sub>16</sub>) to "1".

•	Table 1.11.2. Ope	ration of R	D, WRL, an	d WRH signa	ls
	Data bus width	RD	WRL	WRH	

Data bus width	RD	WRL	WRH	Status of external data bus
	L	Н	Н	Read data
16-bit	Н	L	Н	Write 1 byte of data to even address
(BYTE = "L")	Н	Н	L	Write 1 byte of data to odd address
	Н	L	L	Write data to both even and odd addresses

Table 1.11.3. Operation of RD, WR, and BHE signals

Data bus width	RD	WR	BHE	A0	Status of external data bus	
	Н	L	L	Н	Write 1 byte of data to odd address	
	L	Н	L	Н	Read 1 byte of data from odd address	
16-bit	Н	L	Н	L	Write 1 byte of data to even address	
(BYTE = "L")	L	Н	Н	L	Read 1 byte of data from even address	
	Н	L	L	L	Write data to both even and odd addresses	
L H		L	L	Read data from both even and odd addresses		
8-bit	Н	L	Not used	H/L	Write 1 byte of data	
(BYTE = "H")	L	Н	Not used	H/L	Read 1 byte of data	

#### (4) ALE signal

The ALE signal latches the address when accessing the multiplex bus space. Latch the address when the ALE signal falls.

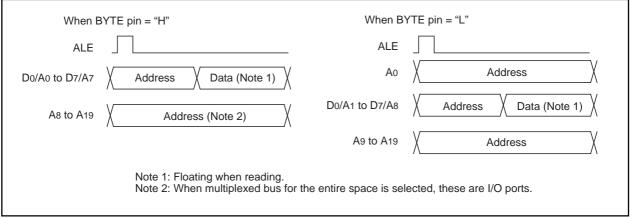


Figure 1.11.2. ALE signal and address/data bus



# (5) The RDY signal

RDY is a signal that facilitates access to an external device that requires long access time. As shown in Figure 1.11.3, if an "L" is being input to the RDY at the BCLK falling edge, the bus turns to the wait state. If an "H" is being input to the RDY pin at the BCLK falling edge, the bus cancels the wait state. Table 1.11.4 shows the state of the microcomputer with the bus in the wait state, and Figure 1.11.3 shows an example in which the RD signal is prolonged by the RDY signal.

The  $\overline{RDY}$  signal is valid when accessing the external area during the bus cycle in which bits 4 to 7 of the chip select control register (address 000816) are set to "0". The  $\overline{RDY}$  signal is invalid when setting "1" to all bits 4 to 7 of the chip select control register (address 000816), but the  $\overline{RDY}$  pin should be treated as properly as in non-using.

Table 1.11.4. Microcomputer status in ready state (Note)

Item	Status		
Oscillation	On		
R/W signal, address bus, data bus, CS	Maintain status when RDY signal received		
ALE signal, HLDA, programmable I/O ports			
Internal peripheral circuits	On		

Note: The RDY signal cannot be received immediately prior to a software wait.

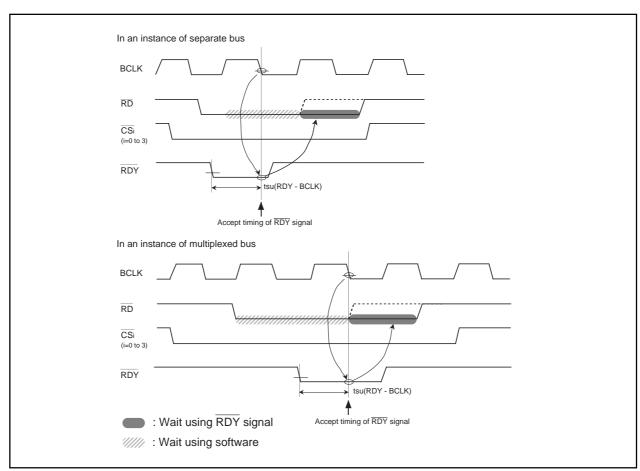


Figure 1.11.3. Example of RD signal extended by RDY signal



# (6) Hold signal

The hold signal is used to transfer the bus privileges from the CPU to the external circuits. Inputting "L" to the  $\overline{\text{HOLD}}$  pin places the microcomputer in the hold state at the end of the current bus access. This status is maintained and "L" is output from the  $\overline{\text{HLDA}}$  pin as long as "L" is input to the  $\overline{\text{HOLD}}$  pin. Table 1.11.5 shows the microcomputer status in the hold state.

Bus-using priorities are given to HOLD, DMAC, and CPU in order of decreasing precedence.

# HOLD > DMAC > CPU

Figure 1.11.4. Bus-using priorities

Table 1.11.5. Microcomputer status in hold state

Ite	m	Status	
Oscillation		ON	
R/W signal, address bus, data l	ous, CS, BHE	Floating	
Programmable I/O ports P0, P1, P2, P3, P4, P5		Floating	
P6, P7, P8, P9, P10		Maintains status when hold signal is received	
HLDA		Output "L"	
Internal peripheral circuits		ON (but watchdog timer stops)	
ALE signal		Undefined	

#### (7) External bus status when the internal area is accessed

Table 1.11.6 shows the external bus status when the internal area is accessed.

Table 1.11.6. External bus status when the internal area is accessed

Item		SFR accessed	Internal ROM/RAM accessed
Address bus		Address output	Maintain status before accessed
			address of external area
Data bus	When read	Floating	Floating
	When write Output data		Undefined
$\overline{RD},\overline{WR},\overline{WF}$	RL, WRH	RD, WR, WRL, WRH output	Output "H"
BHE		BHE output	Maintain status before accessed
			status of external area
CS		Output "H"	Output "H"
ALE		Output "L"	Output "L"



#### (8) BCLK output

The user can choose the BCLK output by use of bit 7 of processor mode register 0 (000416) (Note). When set to "1", the output floating.

Note: Before attempting to change the contents of the processor mode register 0, set bit 1 of the protect register (address 000A<sub>16</sub>) to "1".

### (9) Software wait

A software wait can be inserted by setting the wait bit (bit 7) of the processor mode register 1 (address 000516) (Note) and bits 4 to 7 of the chip select control register (address 000816).

A software wait is inserted in the internal ROM/RAM area and in the external memory area by setting the wait bit of the processor mode register 1. When set to "0", each bus cycle is executed in one BCLK cycle. When set to "1", each bus cycle is executed in two or three BCLK cycles. After the microcomputer has been reset, this bit defaults to "0". When set to "1", a wait is applied to all memory areas (two or three BCLK cycles), regardless of the contents of bits 4 to 7 of the chip select control register. Set this bit after referring to the recommended operating conditions (main clock input oscillation frequency) of the electric characteristics. However, when the user is using the RDY signal, the relevant bit in the chip select control register's bits 4 to 7 must be set to "0".

When the wait bit of the processor mode register 1 is "0", software waits can be set independently for each of the 4 areas selected using the chip select signal. Bits 4 to 7 of the chip select control register correspond to chip selects  $\overline{\text{CS0}}$  to  $\overline{\text{CS3}}$ . When one of these bits is set to "1", the bus cycle is executed in one BCLK cycle. When set to "0", the bus cycle is executed in two or three BCLK cycles. These bits default to "0" after the microcomputer has been reset.

The SFR area is always accessed in two BCLK cycles regardless of the setting of these control bits. Also, insert a software wait if using the multiplex bus to access the external memory area.

Table 1.11.7 shows the software wait and bus cycles. Figure 1.11.5 shows example bus timing when using software waits.

Note: Before attempting to change the contents of the processor mode register 1, set bit 1 of the protect register (address 000A<sub>16</sub>) to "1".

Table 1.11.7. Software waits and bus cycles

Area	Bus status	Wait bit	Bits 4 to 7 of chip select control register	Bus cycle
SFR		Invalid	Invalid	2 BCLK cycles
Internal		0	Invalid	1 BCLK cycle
ROM/RAM	1		Invalid	2 BCLK cycles
	Separate bus 0		1	1 BCLK cycle
External	Separate bus	0	0	2 BCLK cycles
memory area	Separate bus 1		0 (Note)	2 BCLK cycles
	Multiplex bus 0		0	3 BCLK cycles
	Multiplex bus	1	0 (Note)	3 BCLK cycles

Note: When using the RDY signal, always set to "0".



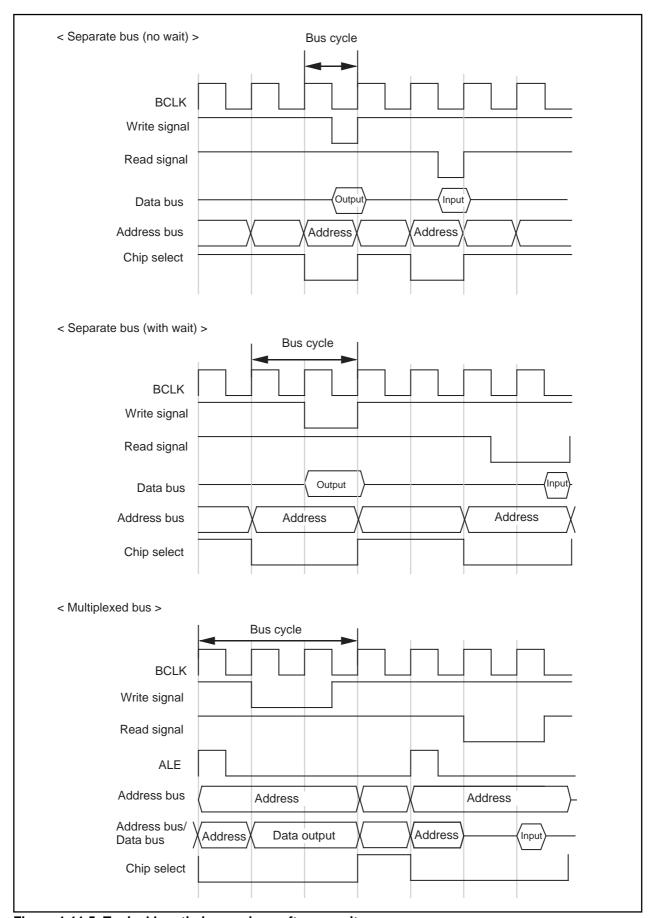


Figure 1.11.5. Typical bus timings using software wait



# **Clock Generating Circuit**

The clock generating circuit contains two oscillator circuits that supply the operating clock sources to the CPU and internal peripheral units.

Table 1.12.1. Main clock and sub-clock generating circuits

	Main clock generating circuit	Sub-clock generating circuit
Use of clock	CPU's operating clock source	CPU's operating clock source
	Internal peripheral units'	Timer A/B's count clock
	operating clock source	source
Usable oscillator	Ceramic or crystal oscillator	Crystal oscillator
Pins to connect oscillator	XIN, XOUT	XCIN, XCOUT
Oscillation stop/restart function	Available	Available
Oscillator status immediately after reset	Oscillating	Stopped
Other	Externally derived clock can be input	

# **Example of oscillator circuit**

Figure 1.12.1 shows some examples of the main clock circuit, one using an oscillator connected to the circuit, and the other one using an externally derived clock for input. Figure 1.12.2 shows some examples of sub-clock circuits, one using an oscillator connected to the circuit, and the other one using an externally derived clock for input. Circuit constants in Figures 1.12.1 and 1.12.2 vary with each oscillator used. Use the values recommended by the manufacturer of your oscillator.

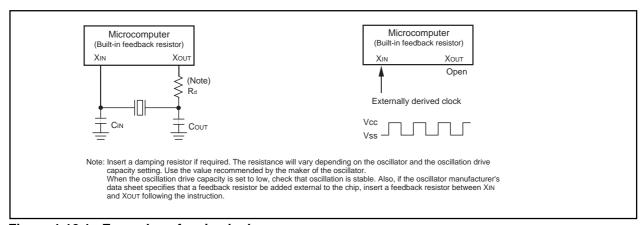


Figure 1.12.1. Examples of main clock

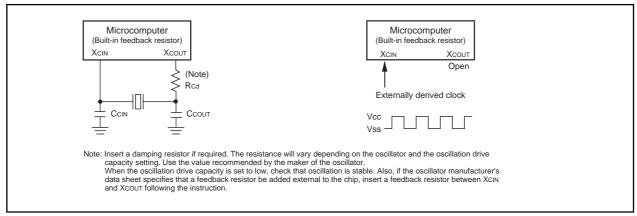


Figure 1.12.2. Examples of sub-clock



#### **Clock Control**

Figure 1.12.3 shows the block diagram of the clock generating circuit.

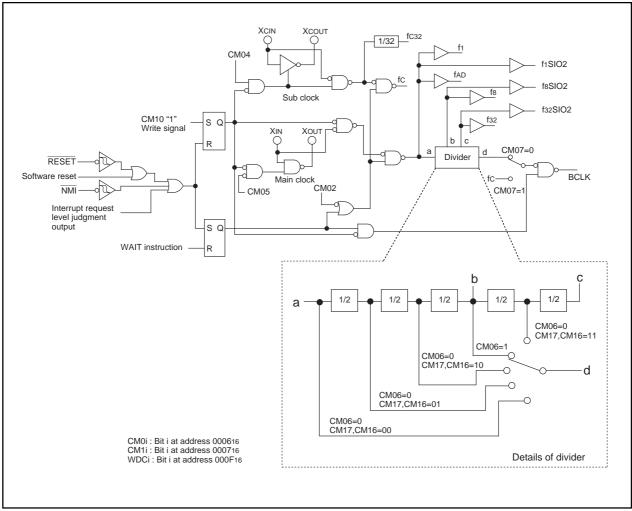


Figure 1.12.3. Clock generating circuit

The following paragraphs describes the clocks generated by the clock generating circuit.

#### (1) Main clock

The main clock is generated by the main clock oscillation circuit. After a reset, the clock is divided by 8 to the BCLK. The clock can be stopped using the main clock stop bit (bit 5 at address 000616). Stopping the clock, after switching the operating clock source of CPU to the sub-clock, reduces the power dissipation. After the oscillation of the main clock oscillation circuit has stabilized, the drive capacity of the main clock oscillation circuit can be reduced using the XIN-XOUT drive capacity select bit (bit 5 at address 000716). Reducing the drive capacity of the main clock oscillation circuit reduces the power dissipation. This bit changes to "1" when shifting from high-speed/medium-speed mode to stop mode and at a reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

# (2) Sub-clock

The sub-clock is generated by the sub-clock oscillation circuit. No sub-clock is generated after a reset. After oscillation is started using the port Xc select bit (bit 4 at address 000616), the sub-clock can be selected as the BCLK by using the system clock select bit (bit 7 at address 000616). However, be sure that the sub-clock oscillation has fully stabilized before switching.

After the oscillation of the sub-clock oscillation circuit has stabilized, the drive capacity of the sub-clock oscillation circuit can be reduced using the XCIN-XCOUT drive capacity select bit (bit 3 at address 000616). Reducing the drive capacity of the sub-clock oscillation circuit reduces the power dissipation. This bit changes to "1" when shifting to stop mode and at a reset.

### (3) **BCLK**

The BCLK is the clock that drives the CPU, and is fc or the clock is derived by dividing the main clock by 1, 2, 4, 8, or 16. The BCLK is derived by dividing the main clock by 8 after a reset. The BCLK signal can be output from BCLK pin by the BCLK output disable bit (bit 7 at address 000416) in the memory expansion and the microprocessor modes.

The main clock division select bit 0(bit 6 at address 000616) changes to "1" when shifting from high-speed/medium-speed to stop mode and at reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

#### (4) Peripheral function clock(f1, f8, f32, f1SIO2, f8SIO2, f32SIO2, fAD)

The clock for the peripheral devices is derived from the main clock or by dividing it by 1, 8, or 32. The peripheral function clock is stopped by stopping the main clock or by setting the WAIT peripheral function clock stop bit (bit 2 at 000616) to "1" and then executing a WAIT instruction.

# (5) fC32

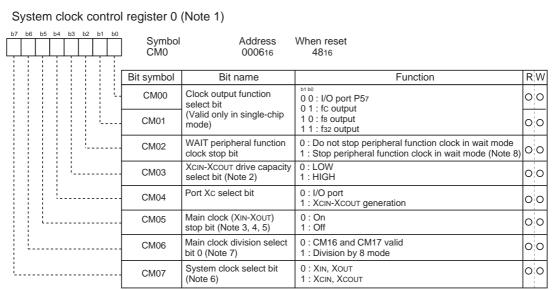
This clock is derived by dividing the sub-clock by 32. It is used for the timer A and timer B counts.

#### (6) fc

This clock has the same frequency as the sub-clock. It is used for the BCLK and for the watchdog timer.



Figure 1.12.4 shows the system clock control registers 0 and 1.

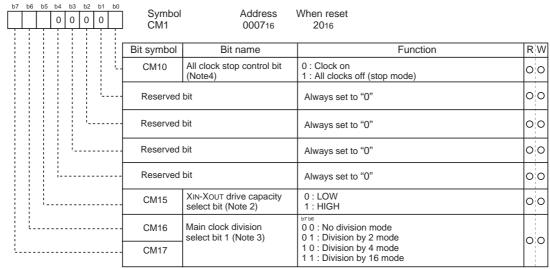


- Note 1: Set bit 0 of the protect register (address 000A16) to "1" before writing to this register. Note 2: Changes to "1" when shiffing to stop mode and at a reset.
- Note 3: When entering power saving mode, main clock stops using this bit. When returning from stop mode and operating with XIN, set this bit to "0". When main clock oscillation is operating by itself, set system clock select bit (CM07) to "1" before setting this bit to "1"
- Note 4: When inputting external clock, only clock oscillation buffer is stopped and clock input is acceptable.

  Note 5: If this bit is set to "1", Xou't turns "H". The built-in feedback resistor remains being connected, so Xin turns pulled up to XOUT ("H") via the feedback resistor.
- Note 6: Set port Xc select bit (CM04) to "1" and stabilize the sub-clock oscillating before setting to this bit from "0" to "1". Do not write to both bits at the same time. And also, set the main clock stop bit (CM05) to "0" and stabilize the main clock oscillating before setting this bit from "1" to "0".

  Note 7: This bit changes to "1" when shifting from high-speed/medium-speed mode to stop mode and at a reset. When
- shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.
- Note 8: fc32 is not included.

#### System clock control register 1 (Note 1)



- Note 1: Set bit 0 of the protect register (address 000A<sub>16</sub>) to "1" before writing to this register.
- Note 2: This bit changes to "1" when shifting from high-speed/medium-speed mode to stop mode and at a reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.
- Note 3: Can be selected when bit 6 of the system clock control register 0 (address 000616) is "0". If "1", division mode is fixed at 8.
- Note 4: If this bit is set to "1", XOUT turns "H", and the built-in feedback resistor is cut off. XCIN and XCOUT turn highimpedance state.

Figure 1.12.4. Clock control registers 0 and 1



#### **Clock Output**

In single-chip mode, the clock output function select bits (bits 0 and 1 at address 000616) enable f8, f32, or fC to be output from the P57/CLKOUT pin. When the WAIT peripheral function clock stop bit (bit 2 at address 000616) is set to "1", the output of f8 and f32 stops when a WAIT instruction is executed.

# **Stop Mode**

Writing "1" to the all-clock stop control bit (bit 0 at address 000716) stops all oscillation and the microcomputer enters stop mode. In stop mode, the content of the internal RAM is retained provided that Vcc remains above 2V.

Because the oscillation, BCLK, f1 to f32, f1SIO2 to f32SIO2, fC, fC32, and fAD stops in stop mode, peripheral functions such as the A-D converter and watchdog timer do not function. However, timer A and timer B operate provided that the event counter mode is set to an external pulse, and UARTi(i = 0 to 2) functions provided an external clock is selected. Table 1.12.2 shows the status of the ports in stop mode.

Stop mode is cancelled by a hardware reset or interrupt. If an interrupt is to be used to cancel stop mode, that interrupt must first have been enabled.

When shifting from high-speed/medium-speed mode to stop mode and at a reset, the main clock division select bit 0 (bit 6 at address 000616) is set to "1". When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

Table 1.12.2. Port status during stop mode

Pin		Memory expansion mode	Single-chip mode
		Microprocessor mode	
Address bus, data bus, $\overline{\text{CS0}}$ to $\overline{\text{CS3}}$		Retains status before stop mode	
RD, WR, BH	E, WRL, WRH	"H"	
HLDA, BCLK		"H"	
ALE		"H"	
Port		Retains status before stop mode	Retains status before stop mode
CLKout	When fc selected	Valid only in single-chip mode	"H"
	When f8, f32 selected	Valid only in single-chip mode	Retains status before stop mode



#### **Wait Mode**

When a WAIT instruction is executed, BCLK stops and the microcomputer enters the wait mode. In this mode, oscillation continues but BCLK and watchdog timer stop. Writing "1" to the WAIT peripheral function clock stop bit and executing a WAIT instruction stops the clock being supplied to the internal peripheral functions, allowing power dissipation to be reduced. Table 1.12.3 shows the status of the ports in wait mode.

Wait mode is cancelled by a hardware reset or an interrupt. If an interrupt is used to cancel wait mode, the microcomputer restarts from the interrupt routine using as BCLK, the clock that had been selected when the WAIT instruction was executed.

Table 1.12.3. Port status during wait mode

Pin		Memory expansion mode	Single-chip mode
		Microprocessor mode	
Address bus, dat	a bus, $\overline{\text{CS0}}$ to $\overline{\text{CS3}}$	Retains status before wait mode	
RD, WR, BHE, W	VRL, WRH	"H"	
HLDA,BCLK		"H"	
ALE		"H"	
Port		Retains status before wait mode	Retains status before wait mode
CLKout	When fc selected	Valid only in single-chip mode	Does not stop
	When f8, f32 selected	Valid only in single-chip mode	Does not stop when the WAIT
			peripheral function clock stop
			bit is "0".
			When the WAIT peripheral
			function clock stop bit is "1",
			the status immediately prior
			to entering wait mode is main-
			tained.



#### **Status Transition Of BCLK**

Power dissipation can be reduced and low-voltage operation achieved by changing the count source for BCLK. Table 1.13.4 shows the operating modes corresponding to the settings of system clock control registers 0 and 1.

When reset, the device starts in division by 8 mode. The main clock division select bit 0(bit 6 at address 000616) changes to "1" when shifting from high-speed/medium-speed to stop mode and at a reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained. The following shows the operational modes of BCLK.

# (1) Division by 2 mode

The main clock is divided by 2 to obtain the BCLK.

### (2) Division by 4 mode

The main clock is divided by 4 to obtain the BCLK.

# (3) Division by 8 mode

The main clock is divided by 8 to obtain the BCLK. When reset, the device starts operating from this mode. Before the user can go from this mode to no division mode, division by 2 mode, or division by 4 mode, the main clock must be oscillating stably. When going to low-speed or lower power consumption mode, make sure the sub-clock is oscillating stably.

### (4) Division by 16 mode

The main clock is divided by 16 to obtain the BCLK.

# (5) No-division mode

The main clock is divided by 1 to obtain the BCLK.

#### (6) Low-speed mode

fC is used as the BCLK. Note that oscillation of both the main and sub-clocks must have stabilized before transferring from this mode to another or vice versa. At least 2 to 3 seconds are required after the sub-clock starts. Therefore, the program must be written to wait until this clock has stabilized immediately after powering up and after stop mode is cancelled.

#### (7) Low power dissipation mode

fc is the BCLK and the main clock is stopped.

Note: Before the count source for BCLK can be changed from XIN to XCIN or vice versa, the clock to which the count source is going to be switched must be oscillating stably. Allow a wait time in software for the oscillation to stabilize before switching over the clock.

Table 1.12.4. Operating modes dictated by settings of system clock control registers 0 and 1

CM17	CM16	CM07	CM06	CM05	CM04	Operating mode of BCLK
0	1	0	0	0	Invalid	Division by 2 mode
1	0	0	0	0	Invalid	Division by 4 mode
Invalid	Invalid	0	1	0	Invalid	Division by 8 mode
1	1	0	0	0	Invalid	Division by 16 mode
0	0	0	0	0	Invalid	No-division mode
Invalid	Invalid	1	Invalid	0	1	Low-speed mode
Invalid	Invalid	1	Invalid	1	1	Low power dissipation mode



#### **Power control**

The following is a description of the three available power control modes:

#### Modes

Power control is available in three modes.

#### (a) Normal operation mode

#### • High-speed mode

Divide-by-1 frequency of the main clock becomes the BCLK. The CPU operates with the internal clock selected. Each peripheral function operates according to its assigned clock.

#### Medium-speed mode

Divide-by-2, divide-by-4, divide-by-8, or divide-by-16 frequency of the main clock becomes the BCLK. The CPU operates according to the internal clock selected. Each peripheral function operates according to its assigned clock.

### Low-speed mode

fc becomes the BCLK. The CPU operates according to the fc clock. The fc clock is supplied by the secondary clock. Each peripheral function operates according to its assigned clock.

### • Low power consumption mode

The main clock operating in low-speed mode is stopped. The CPU operates according to the fc clock. The fc clock is supplied by the secondary clock. The only peripheral functions that operate are those with the sub-clock selected as the count source.

#### (b) Wait mode

The CPU operation is stopped. The oscillators do not stop.

### (c) Stop mode

All oscillators stop. The CPU and all built-in peripheral functions stop. This mode, among the three modes listed here, is the most effective in decreasing power consumption.

Figure 1.12.5 is the state transition diagram of the above modes.



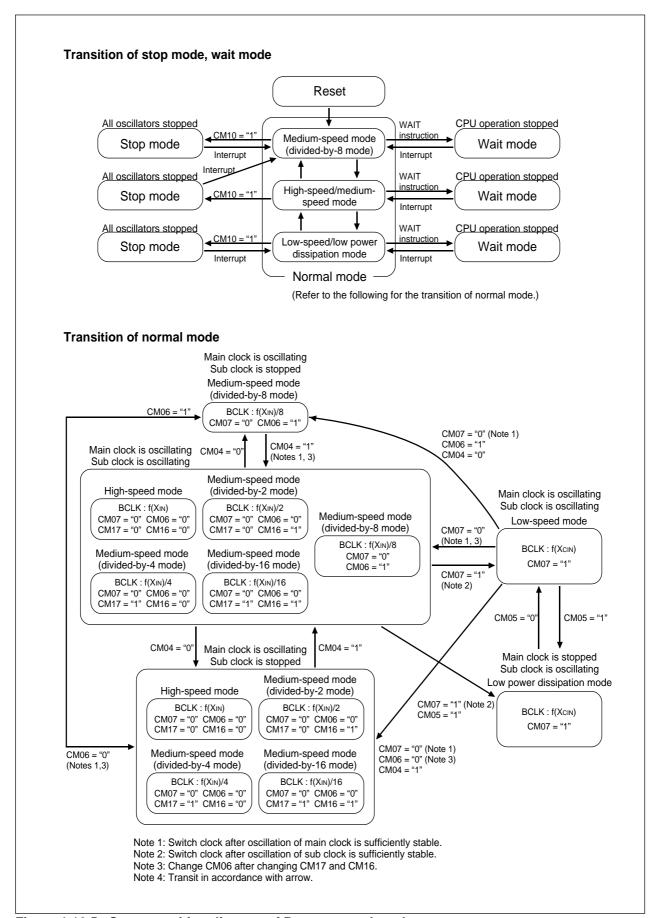


Figure 1.12.5. State transition diagram of Power control mode



#### **Protection**

The protection function is provided so that the values in important registers cannot be changed in the event that the program runs out of control. Figure 1.12.6 shows the protect register. The values in the processor mode register 0 (address 000416), processor mode register 1 (address 000516), system clock control register 0 (address 000616), system clock control register 1 (address 000716) and port P9 direction register (address 03F316) can only be changed when the respective bit in the protect register is set to "1". Therefore, important outputs can be allocated to port P9.

If, after "1" (write-enabled) has been written to the port P9 direction register write-enable bit (bit 2 at address 000A16), a value is written to any address, the bit automatically reverts to "0" (write-inhibited). However, the system clock control registers 0 and 1 write-enable bit (bit 0 at 000A16) and processor mode register 0 and 1 write-enable bit (bit 1 at 000A16) do not automatically return to "0" after a value has been written to an address. The program must therefore be written to return these bits to "0".

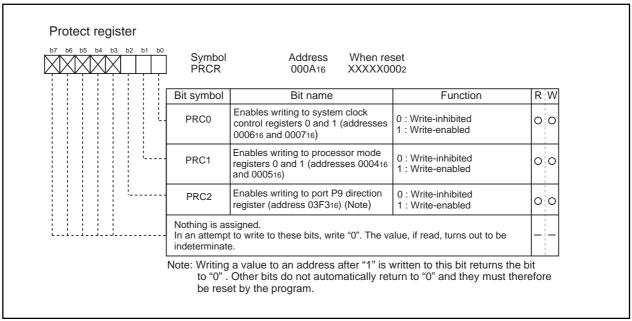


Figure 1.12.6. Protect register

## **Overview of Interrupt**

# Type of Interrupts

Figure 1.13.1 lists the types of interrupts.

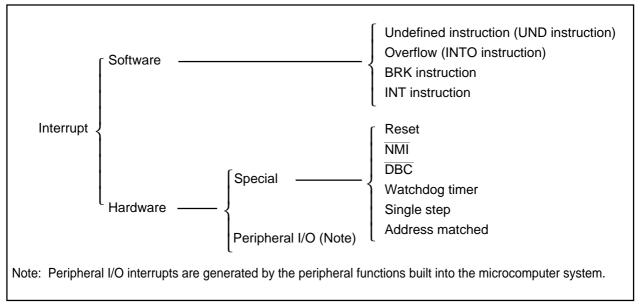


Figure 1.13.1. Classification of interrupts

• Maskable interrupt : An interrupt which can be enabled (disabled) by the interrupt enable flag

(I flag) or whose interrupt priority can be changed by priority level.

• Non-maskable interrupt: An interrupt which cannot be enabled (disabled) by the interrupt enable flag

(I flag) or whose interrupt priority **cannot be changed** by priority level.



## **Software Interrupts**

A software interrupt occurs when executing certain instructions. Software interrupts are non-maskable interrupts.

#### Undefined instruction interrupt

An undefined instruction interrupt occurs when executing the UND instruction.

#### Overflow interrupt

An overflow interrupt occurs when executing the INTO instruction with the overflow flag (O flag) set to "1". The following are instructions whose O flag changes by arithmetic:

ABS, ADC, ADCF, ADD, CMP, DIV, DIVU, DIVX, NEG, RMPA, SBB, SHA, SUB

#### BRK interrupt

A BRK interrupt occurs when executing the BRK instruction.

#### INT interrupt

An INT interrupt occurs when assiging one of software interrupt numbers 0 through 63 and executing the INT instruction. Software interrupt numbers 0 through 31 are assigned to peripheral I/O interrupts, so executing the INT instruction allows executing the same interrupt routine that a peripheral I/O interrupt does.

The stack pointer (SP) used for the INT interrupt is dependent on which software interrupt number is involved.

So far as software interrupt numbers 0 through 31 are concerned, the microcomputer saves the stack pointer assignment flag (U flag) when it accepts an interrupt request. If change the U flag to "0" and select the interrupt stack pointer (ISP), and then execute an interrupt sequence. When returning from the interrupt routine, the U flag is returned to the state it was before the acceptance of interrupt request. So far as software numbers 32 through 63 are concerned, the stack pointer does not make a shift.



### **Hardware Interrupts**

Hardware interrupts are classified into two types — special interrupts and peripheral I/O interrupts.

#### (1) Special interrupts

Special interrupts are non-maskable interrupts.

#### Reset

Reset occurs if an "L" is input to the RESET pin.

#### • NMI interrupt

An  $\overline{\text{NMI}}$  interrupt occurs if an "L" is input to the  $\overline{\text{NMI}}$  pin.

### • DBC interrupt

This interrupt is exclusively for the debugger, do not use it in other circumstances.

#### Watchdog timer interrupt

Generated by the watchdog timer.

#### Single-step interrupt

This interrupt is exclusively for the debugger, do not use it in other circumstances. With the debug flag (D flag) set to "1", a single-step interrupt occurs after one instruction is executed.

### Address match interrupt

An address match interrupt occurs immediately before the instruction held in the address indicated by the address match interrupt register is executed with the address match interrupt enable bit set to "1". If an address other than the first address of the instruction in the address match interrupt register is set, no address match interrupt occurs. For address match interrupt, see 2.11 Address match Interrupt.

#### (2) Peripheral I/O interrupts

A peripheral I/O interrupt is generated by one of built-in peripheral functions. Built-in peripheral functions are dependent on classes of products, so the interrupt factors too are dependent on classes of products. The interrupt vector table is the same as the one for software interrupt numbers 0 through 31 the INT instruction uses. Peripheral I/O interrupts are maskable interrupts.

#### Bus collision detection interrupt

This is an interrupt that the serial I/O bus collision detection generates.

#### DMA0 interrupt, DMA1 interrupt

These are interrupts that DMA generates.

#### Key-input interrupt

A key-input interrupt occurs if an "L" is input to the KI pin.

#### • A-D conversion interrupt

This is an interrupt that the A-D converter generates.

### UART0, UART1 and UART2 transmission interrupt

These are interrupts that the serial I/O transmission generates.

### • UART0, UART1 and UART2 reception interrupt

These are interrupts that the serial I/O reception generates.

### Timer A0 interrupt through timer A4 interrupt

These are interrupts that timer A generates

### Timer B0 interrupt through timer B2 interrupt

These are interrupts that timer B generates.

#### • INTO interrupt through INT2 interrupt

An INT interrupt occurs if either a rising edge or a falling edge is input to the INT pin.



## **Interrupts and Interrupt Vector Tables**

If an interrupt request is accepted, a program branches to the interrupt routine set in the interrupt vector table. Set the first address of the interrupt routine in each vector table. Figure 1.13.2 shows the format for specifying the address.

Two types of interrupt vector tables are available — fixed vector table in which addresses are fixed and variable vector table in which addresses can be varied by the setting.

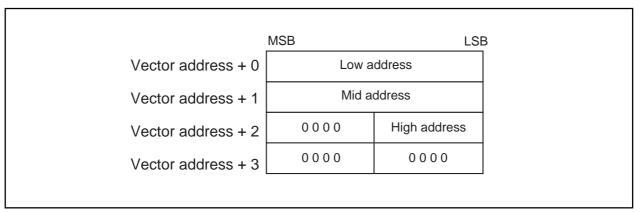


Figure 1.13.2. Format for specifying interrupt vector addresses

#### Fixed vector tables

The fixed vector table is a table in which addresses are fixed. The vector tables are located in an area extending from FFFDC16 to FFFFF16. One vector table comprises four bytes. Set the first address of interrupt routine in each vector table. Table 1.13.1 shows the interrupts assigned to the fixed vector tables and addresses of vector tables.

Table 1.13.1. Interrupts assigned to the fixed vector tables and addresses of vector tables

Interrupt source	Vector table addresses	Remarks
	Address (L) to address (H)	
Undefined instruction	FFFDC16 to FFFDF16	Interrupt on UND instruction
Overflow	FFFE016 to FFFE316	Interrupt on INTO instruction
BRK instruction	FFFE416 to FFFE716	If the vector contains FF16, program execution starts from
		the address shown by the vector in the variable vector table
Address match	FFFE816 to FFFEB16	There is an address-matching interrupt enable bit
Single step (Note)	FFFEC16 to FFFEF16	Do not use
Watchdog timer	FFFF016 to FFFF316	
DBC (Note)	FFFF416 to FFFF716	Do not use
NMI	FFFF816 to FFFFB16	External interrupt by input to NMI pin
Reset	FFFFC16 to FFFFF16	

Note: Interrupts used for debugging purposes only.



### Variable vector tables

The addresses in the variable vector table can be modified, according to the user's settings. Indicate the first address using the interrupt table register (INTB). The 256-byte area subsequent to the address the INTB indicates becomes the area for the variable vector tables. One vector table comprises four bytes. Set the first address of the interrupt routine in each vector table. Table 1.13.2 shows the interrupts assigned to the variable vector tables and addresses of vector tables.

Table 1.13.2. Interrupts assigned to the variable vector tables and addresses of vector tables

Software interrupt number	Vector table address Address (L) to address (H)	Interrupt source	Remarks	
Software interrupt number 0	+0 to +3 (Note)	BRK instruction	Cannot be masked I flag	
Software interrupt number 10	+40 to +43 (Note)	Bus collision detection		
Software interrupt number 11	+44 to +47 (Note)	DMA0		
Software interrupt number 12	+48 to +51 (Note)	DMA1		
Software interrupt number 13	+52 to +55 (Note)	Key input interrupt		
Software interrupt number 14	+56 to +59 (Note)	A-D		
Software interrupt number 15	+60 to +63 (Note)	UART2 transmit		
Software interrupt number 16	+64 to +67 (Note)	UART2 receive		
Software interrupt number 17	+68 to +71 (Note)	UART0 transmit		
Software interrupt number 18	+72 to +75 (Note)	UART0 receive		
Software interrupt number 19	+76 to +79 (Note)	UART1 transmit		
Software interrupt number 20	+80 to +83 (Note)	UART1 receive		
Software interrupt number 21	+84 to +87 (Note)	Timer A0		
Software interrupt number 22	+88 to +91 (Note)	Timer A1		
Software interrupt number 23	+92 to +95 (Note)	Timer A2		
Software interrupt number 24	+96 to +99 (Note)	Timer A3		
Software interrupt number 25	+100 to +103 (Note)	Timer A4		
Software interrupt number 26	+104 to +107 (Note)	Timer B0		
Software interrupt number 27	+108 to +111 (Note)	Timer B1		
Software interrupt number 28	+112 to +115 (Note)	Timer B2		
Software interrupt number 29	+116 to +119 (Note)	ĪNT0		
Software interrupt number 30	+120 to +123 (Note)	INT1		
Software interrupt number 31	+124 to +127 (Note)	ĪNT2		
Software interrupt number 32 to Software interrupt number 63	+128 to +131 (Note) to +252 to +255 (Note)	Software interrupt	Cannot be masked I flag	

Note: Address relative to address in interrupt table register (INTB)



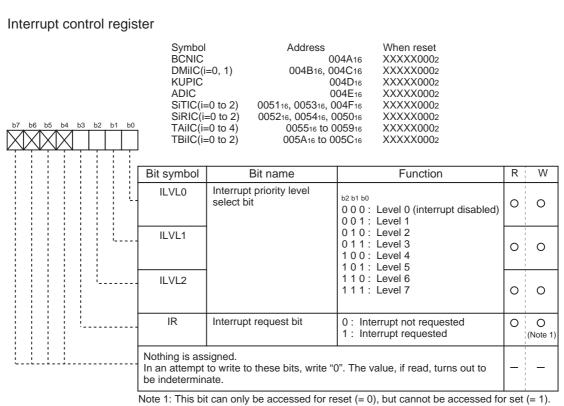
## **Interrupt Control**

Descriptions are given here regarding how to enable or disable maskable interrupts and how to set the priority to be accepted. What is described here does not apply to non-maskable interrupts.

Enable or disable a non-maskable interrupt using the interrupt enable flag (I flag), interrupt priority level selection bit, or processor interrupt priority level (IPL). Whether an interrupt request is present or absent is indicated by the interrupt request bit. The interrupt request bit and the interrupt priority level selection bit are located in the interrupt control register of each interrupt. Also, the interrupt enable flag (I flag) and the IPL are located in the flag register (FLG).

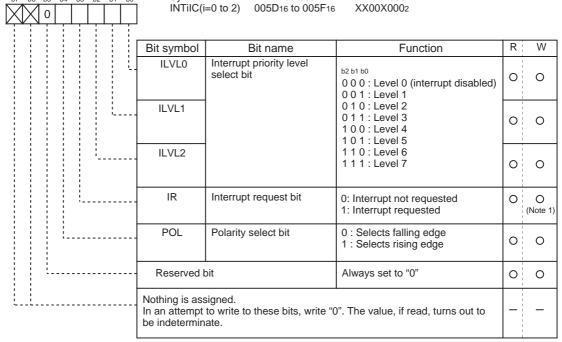
Figure 1.13.3 shows the memory map of the interrupt control registers.





Note 1: This bit can only be accessed for reset (= 0), but cannot be accessed for set (= 1). Note 2: To rewrite the interrupt control register, do so at a point that dose not generate the interrupt request for that register. For details, see the precautions for interrupts.

When reset



Address

Symbol

Note 1: This bit can only be accessed for reset (= 0), but cannot be accessed for set (= 1). Note 2: To rewrite the interrupt control register, do so at a point that dose not generate the interrupt request for that register. For details, see the precautions for interrupts.

Figure 1.13.3. Interrupt control registers



## Interrupt Enable Flag (I flag)

The interrupt enable flag (I flag) controls the enabling and disabling of maskable interrupts. Setting this flag to "1" enables all maskable interrupts; setting it to "0" disables all maskable interrupts. This flag is set to "0" after reset.

### **Interrupt Request Bit**

The interrupt request bit is set to "1" by hardware when an interrupt is requested. After the interrupt is accepted and jumps to the corresponding interrupt vector, the request bit is set to "0" by hardware. The interrupt request bit can also be set to "0" by software. (Do not set this bit to "1").

## Interrupt Priority Level Select Bit and Processor Interrupt Priority Level (IPL)

Set the interrupt priority level using the interrupt priority level select bit, which is one of the component bits of the interrupt control register. When an interrupt request occurs, the interrupt priority level is compared with the IPL. The interrupt is enabled only when the priority level of the interrupt is higher than the IPL. Therefore, setting the interrupt priority level to "0" disables the interrupt.

Table 1.13.3 shows the settings of interrupt priority levels and Table 1.13.4 shows the interrupt levels enabled, according to the consist of the IPL.

The following are conditions under which an interrupt is accepted:

- · interrupt enable flag (I flag) = 1
- · interrupt request bit = 1
- · interrupt priority level > IPL

The interrupt enable flag (I flag), the interrupt request bit, the interrupt priority select bit, and the IPL are independent, and they are not affected by one another.

Table 1.13.3. Settings of interrupt priority levels

Interrupt p		Interrupt priority level	Priority order
b2 b1	b0		
0 0	0	Level 0 (interrupt disabled)	
0 0	1	Level 1	Low
0 1	0	Level 2	
0 1	1	Level 3	
1 0	0	Level 4	
1 0	1	Level 5	
1 1	0	Level 6	
1 1	1	Level 7	High

Table 1.13.4. Interrupt levels enabled according to the contents of the IPL

IPL	Enabled interrupt priority levels
IPL2 IPL1 IPL0	
0 0 0	Interrupt levels 1 and above are enabled
0 0 1	Interrupt levels 2 and above are enabled
0 1 0	Interrupt levels 3 and above are enabled
0 1 1	Interrupt levels 4 and above are enabled
1 0 0	Interrupt levels 5 and above are enabled
1 0 1	Interrupt levels 6 and above are enabled
1 1 0	Interrupt levels 7 and above are enabled
1 1 1	All maskable interrupts are disabled



## Rewrite the interrupt control register

To rewrite the interrupt control register, do so at a point that does not generate the interrupt request for that register. If there is possibility of the interrupt request occur, rewrite the interrupt control register after the interrupt is disabled. The program examples are described as follow:

# Example 1:

INT\_SWITCH1:

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

NOP ; Four NOP instructions are required when using HOLD function.

NOP ; Enable interrupts.

Example 2:

INT\_SWITCH2:

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

MOV.W MEM, R0 ; Dummy read. FSET I ; Enable interrupts.

Example 3:

INT\_SWITCH3:

PUSHC FLG ; Push Flag register onto stack

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

POPC FLG ; Enable interrupts.

The reason why two NOP instructions (four when using the HOLD function) or dummy read are inserted before FSET I in Examples 1 and 2 is to prevent the interrupt enable flag I from being set before the interrupt control register is rewritten due to effects of the instruction queue.

When a instruction to rewrite the interrupt control register is executed but the interrupt is disabled, the interrupt request bit is not set sometimes even if the interrupt request for that register has been generated. This will depend on the instruction. If this creates problems, use the below instructions to change the register.

Instructions: AND, OR, BCLR, BSET



### Interrupt Sequence

An interrupt sequence — what are performed over a period from the instant an interrupt is accepted to the instant the interrupt routine is executed — is described here.

If an interrupt occurs during execution of an instruction, the processor determines its priority when the execution of the instruction is completed, and transfers control to the interrupt sequence from the next cycle. If an interrupt occurs during execution of either the SMOVB, SMOVF, SSTR or RMPA instruction, the processor temporarily suspends the instruction being executed, and transfers control to the interrupt sequence.

In the interrupt sequence, the processor carries out the following in sequence given:

- (1) CPU gets the interrupt information (the interrupt number and interrupt request level) by reading address 0000016.
- (2) Saves the content of the flag register (FLG) as it was immediately before the start of interrupt sequence in the temporary register (Note) within the CPU.
- (3) Sets the interrupt enable flag (I flag), the debug flag (D flag), and the stack pointer select flag (U flag) to "0" (the U flag, however does not change if the INT instruction, in software interrupt numbers 32 through 63, is executed)
- (4) Saves the content of the temporary register (Note 1) within the CPU in the stack area.
- (5) Saves the content of the program counter (PC) in the stack area.
- (6) Sets the interrupt priority level of the accepted instruction in the IPL.

After the interrupt sequence is completed, the processor resumes executing instructions from the first address of the interrupt routine.

Note: This register cannot be utilized by the user.

#### **Interrupt Response Time**

'Interrupt response time' is the period between the instant an interrupt occurs and the instant the first instruction within the interrupt routine has been executed. This time comprises the period from the occurrence of an interrupt to the completion of the instruction under execution at that moment (a) and the time required for executing the interrupt sequence (b). Figure 1.13.4 shows the interrupt response time.

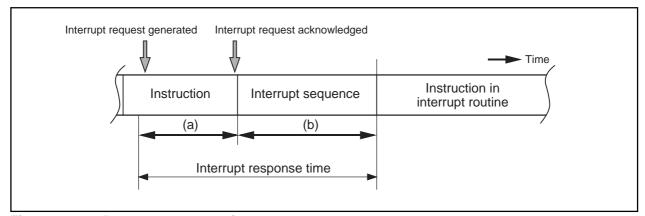


Figure 1.13.4. Interrupt response time



Time (a) is dependent on the instruction under execution. Thirty cycles is the maximum required for the DIVX instruction (without wait).

Time (b) is as shown in Table 1.13.5.

Table 1.13.5. Time required for executing the interrupt sequence

Interrupt vector address	Stack pointer (SP) value	16-Bit bus, without wait	8-Bit bus, without wait	
Even	Even	18 cycles (Note 1)	20 cycles (Note 1)	
Even Odd		19 cycles (Note 1)	20 cycles (Note 1)	
Odd (Note 2)	Even	19 cycles (Note 1)	20 cycles (Note 1)	
Odd (Note 2)	Odd	20 cycles (Note 1)	20 cycles (Note 1)	

Note 1: Add 2 cycles in the case of a DBC interrupt; add 1 cycle in the case either of an address coincidence interrupt or of a single-step interrupt.

Note 2: Locate an interrupt vector address in an even address, if possible.

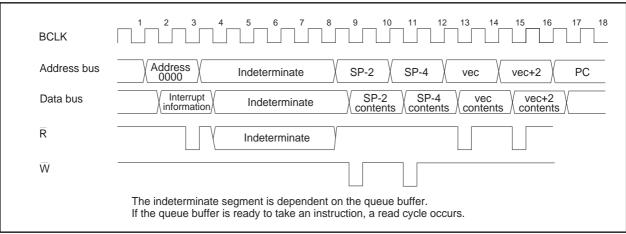


Figure 1.13.5. Time required for executing the interrupt sequence

### Variation of IPL when Interrupt Request is Accepted

If an interrupt request is accepted, the interrupt priority level of the accepted interrupt is set in the IPL. If an interrupt request, that does not have an interrupt priority level, is accepted, one of the values shown in Table 1.13.6 is set in the IPL.

Table 1.13.6. Relationship between interrupts without interrupt priority levels and IPL

Interrupt sources without priority levels	Value set in the IPL	
Watchdog timer, NMI	7	
Reset	0	
Other	Not changed	



## **Saving Registers**

In the interrupt sequence, only the contents of the flag register (FLG) and that of the program counter (PC) are saved in the stack area.

First, the processor saves the four higher-order bits of the program counter, and 4 upper-order bits and 8 lower-order bits of the FLG register, 16 bits in total, in the stack area, then saves 16 lower-order bits of the program counter. Figure 1.13.6 shows the state of the stack as it was before the acceptance of the interrupt request, and the state the stack after the acceptance of the interrupt request.

Save other necessary registers at the beginning of the interrupt routine using software. Using the PUSHM instruction alone can save all the registers except the stack pointer (SP).

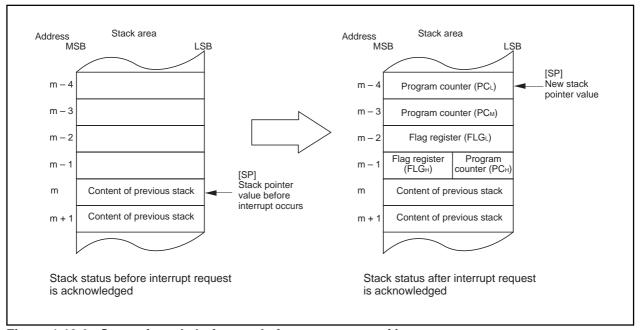


Figure 1.13.6. State of stack before and after acceptance of interrupt request



The operation of saving registers carried out in the interrupt sequence is dependent on whether the content of the stack pointer, at the time of acceptance of an interrupt request, is even or odd. If the content of the stack pointer (Note) is even, the content of the flag register (FLG) and the content of the program counter (PC) are saved, 16 bits at a time. If odd, their contents are saved in two steps, 8 bits at a time. Figure 1.13.7 shows the operation of the saving registers.

Note: Stack pointer indicated by U flag.

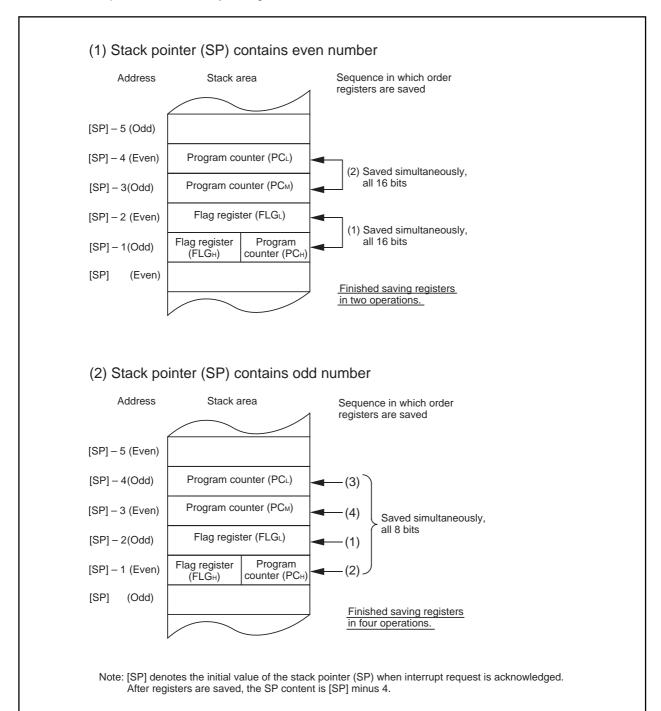


Figure 1.13.7. Operation of saving registers



## **Returning from an Interrupt Routine**

Executing the REIT instruction at the end of an interrupt routine returns the contents of the flag register (FLG) as it was immediately before the start of interrupt sequence and the contents of the program counter (PC), both of which have been saved in the stack area. Then control returns to the program that was being executed before the acceptance of the interrupt request, so that the suspended process resumes.

Return the other registers saved by software within the interrupt routine using the POPM or similar instruction before executing the REIT instruction.

### **Interrupt Priority**

If there are two or more interrupt requests occurring at a point in time within a single sampling (checking whether interrupt requests are made), the interrupt assigned a higher priority is accepted.

Assign an arbitrary priority to maskable interrupts (peripheral I/O interrupts) using the interrupt priority level select bit. If the same interrupt priority level is assigned, however, the interrupt assigned a higher hardware priority is accepted.

Priorities of the special interrupts, such as Reset (dealt with as an interrupt assigned the highest priority), watchdog timer interrupt, etc. are regulated by hardware.

Figure 1.13.8 shows the priorities of hardware interrupts.

Software interrupts are not affected by the interrupt priority. If an instruction is executed, control branches invariably to the interrupt routine.

Reset > NMI > DBC > Watchdog timer > Peripheral I/O > Single step > Address match

Figure 1.13.8. Hardware interrupts priorities

### Interrupt resolution circuit

When two or more interrupts are generated simultaneously, this circuit selects the interrupt with the highest priority level. Figure 1.13.9 shows the circuit that judges the interrupt priority level.



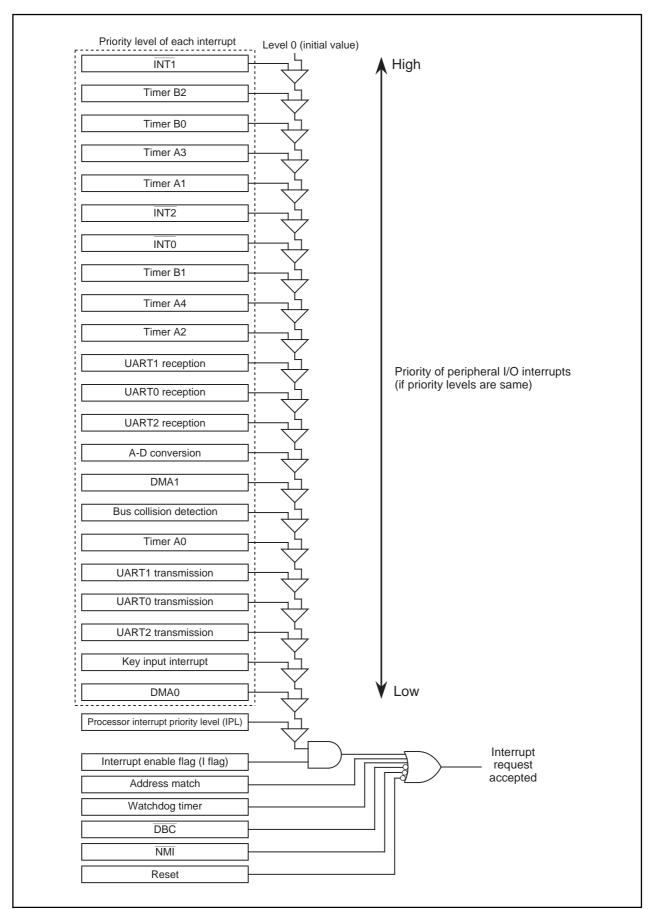


Figure 1.13.9. Maskable interrupts priorities (peripheral I/O interrupts)



## **INT** Interrupt

INTO to INT2 are triggered by the edges of external inputs. The edge polarity is selected using the polarity select bit.

## **NMI** Interrupt

An  $\overline{\text{NMI}}$  interrupt is generated when the input to the P85/ $\overline{\text{NMI}}$  pin changes from "H" to "L". The  $\overline{\text{NMI}}$  interrupt is a non-maskable external interrupt. The pin level can be checked in the port P85 register (bit 5 at address 03F016).

This pin cannot be used as a normal port input.

## **Key Input Interrupt**

If the direction register of any of P104 to P107 is set for input and a falling edge is input to that port, a key input interrupt is generated. A key input interrupt can also be used as a key-on wakeup function for cancelling the wait mode or stop mode. However, if you intend to use the key input interrupt, do not use P104 to P107 as A-D input ports. Figure 1.13.10 shows the block diagram of the key input interrupt. Note that if an "L" level is input to any pin that has not been disabled for input, inputs to the other pins are not detected as an interrupt.

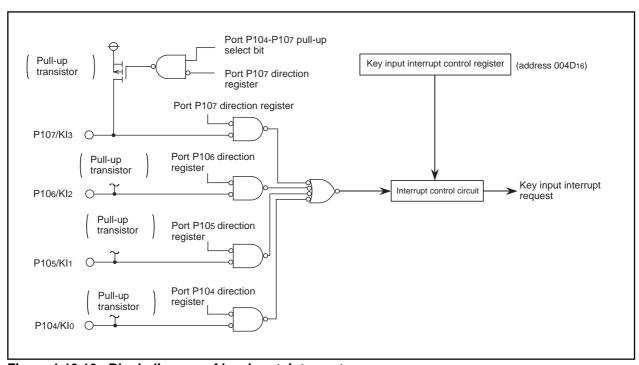


Figure 1.13.10. Block diagram of key input interrupt

## **Address Match Interrupt**

An address match interrupt is generated when the address match interrupt address register contents match the program counter value. Two address match interrupts can be set, each of which can be enabled and disabled by an address match interrupt enable bit. Address match interrupts are not affected by the interrupt enable flag (I flag) and processor interrupt priority level (IPL). The value of the program counter (PC) for an address match interrupt varies depending on the instruction being executed.

Figure 1.13.11 shows the address match interrupt-related registers.

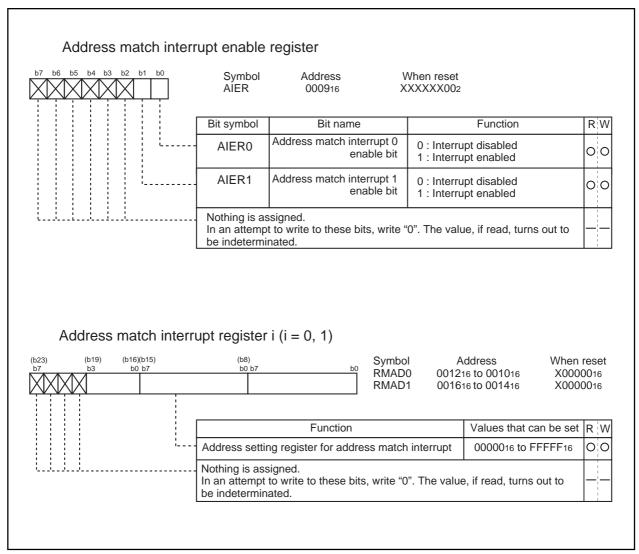


Figure 1.13.11. Address match interrupt-related registers



## **Precautions for Interrupts**

# (1) Reading address 0000016

• When maskable interrupt is occurred, CPU read the interrupt information (the interrupt number and interrupt request level) in the interrupt sequence.

The interrupt request bit of the certain interrupt written in address 0000016 will then be set to "0".

Reading address 0000016 by software sets enabled highest priority interrupt source request bit to "0".

Though the interrupt is generated, the interrupt routine may not be executed.

Do not read address 0000016 by software.

### (2) Setting the stack pointer

• The value of the stack pointer immediately after reset is initialized to 000016. Accepting an interrupt before setting a value in the stack pointer may become a factor of runaway. Be sure to set a value in the stack pointer before accepting an interrupt. When using the NMI interrupt, initialize the stack point at the beginning of a program. Concerning the first instruction immediately after reset, generating any interrupts including the NMI interrupt is prohibited.

### (3) The NMI interrupt

- As for the NMI interrupt pin, an interrupt cannot be disabled. Connect it to the VCC pin via a resistor (pull-up) if unused. Be sure to work on it.
- The NMI pin also serves as P85, which is exclusively input. Reading the contents of the P8 register allows reading the pin value. Use the reading of this pin only for establishing the pin level at the time when the NMI interrupt is input.
- Do not reset the CPU with the input to the NMI pin being in the "L" state.
- Do not attempt to go into stop mode with the input to the \overline{NMI} pin being in the "L" state. With the input to the \overline{NMI} being in the "L" state, the CM10 is fixed to "0", so attempting to go into stop mode is turned down.
- Do not attempt to go into wait mode with the input to the  $\overline{\text{NMI}}$  pin being in the "L" state. With the input to the  $\overline{\text{NMI}}$  pin being in the "L" state, the CPU stops but the oscillation does not stop, so no power is saved. In this instance, the CPU is returned to the normal state by a later interrupt.
- Signals input to the NMI pin require an "L" level of 1 clock or more, from the operation clock of the CPU.

### (4) External interrupt

- Either an "L" level or an "H" level of at least 250 ns width is necessary for the signal input to pins INTo through INT2 regardless of the CPU operation clock.
- When the polarity of the INTo to INTo pins is changed, the interrupt request bit is sometimes set to "1".
   After changing the polarity, set the interrupt request bit to "0". Figure 1.13.12 shows the procedure for changing the INT interrupt generate factor.



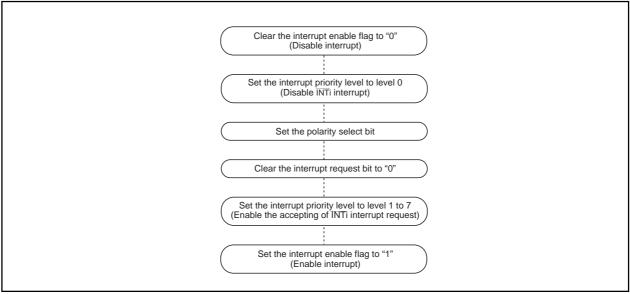


Figure 1.13.12. Switching condition of INT interrupt request

### (5) Rewrite the interrupt control register

• To rewrite the interrupt control register, do so at a point that does not generate the interrupt request for that register. If there is possibility of the interrupt request occur, rewrite the interrupt control register after the interrupt is disabled. The program examples are described as follow:

```
Example 1:
   INT_SWITCH1:
       FCLR
                              ; Disable interrupts.
       AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.
       NOP
                              ; Four NOP instructions are required when using HOLD function.
       NOP
       FSET
                              ; Enable interrupts.
Example 2:
   INT_SWITCH2:
       FCLR
                              ; Disable interrupts.
       AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.
       MOV.W MEM, R0
                              ; Dummy read.
       FSET
                              ; Enable interrupts.
Example 3:
   INT_SWITCH3:
       PUSHC FLG
                              ; Push Flag register onto stack
       FCI R
                              ; Disable interrupts.
       AND.B
                #00h, 0055h
                             ; Clear TAOIC int. priority level and int. request bit.
                              ; Enable interrupts.
       POPC
                FLG
```

The reason why two NOP instructions (four when using the HOLD function) or dummy read are inserted before FSET I in Examples 1 and 2 is to prevent the interrupt enable flag I from being set before the interrupt control register is rewritten due to effects of the instruction queue.

• When a instruction to rewrite the interrupt control register is executed but the interrupt is disabled, the interrupt request bit is not set sometimes even if the interrupt request for that register has been generated. This will depend on the instruction. If this creates problems, use the below instructions to change the register.

Instructions: AND, OR, BCLR, BSET



## Watchdog Timer

The watchdog timer has the function of detecting when the program is out of control. The watchdog timer is a 15-bit counter which down-counts the clock derived by dividing the BCLK using the prescaler. A watchdog timer interrupt is generated when an underflow occurs in the watchdog timer. When XIN is selected for the BCLK, bit 7 of the watchdog timer control register (address 000F16) selects the prescaler division ratio (by 16 or by 128). When XCIN is selected as the BCLK, the prescaler is set for division by 2 regardless of bit 7 of the watchdog timer control register (address 000F16). Thus the watchdog timer's period can be calculated as given below. The watchdog timer's period is, however, subject to an error due to the pre-scaler.

With	XIN	cnosen	tor	BCLK

Watchdog timer period = 

pre-scaler dividing ratio (16 or 128) X watchdog timer count (32768)

BCLK

With XCIN chosen for BCLK

Watchdog timer period = 

pre-scaler dividing ratio (2) X watchdog timer count (32768)

BCLK

For example, suppose that BCLK runs at 10 MHz and that 16 has been chosen for the dividing ratio of the pre-scaler, then the watchdog timer's period becomes approximately 52.4 ms.

The watchdog timer is initialized by writing to the watchdog timer start register (address 000E<sub>16</sub>) and when a watchdog timer interrupt request is generated. The prescaler is initialized only when the microcomputer is reset. After a reset is cancelled, the watchdog timer and prescaler are both stopped. The count is started by writing to the watchdog timer start register (address 000E<sub>16</sub>).

Figure 1.14.1 shows the block diagram of the watchdog timer. Figure 1.14.2 shows the watchdog timer-related registers.

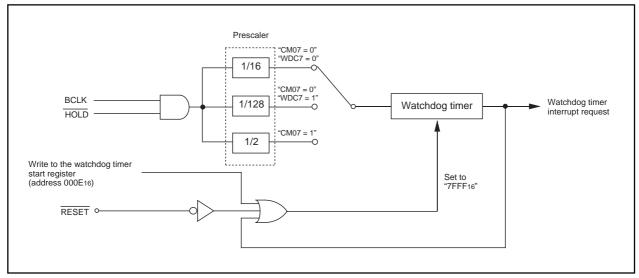


Figure 1.14.1. Block diagram of watchdog timer



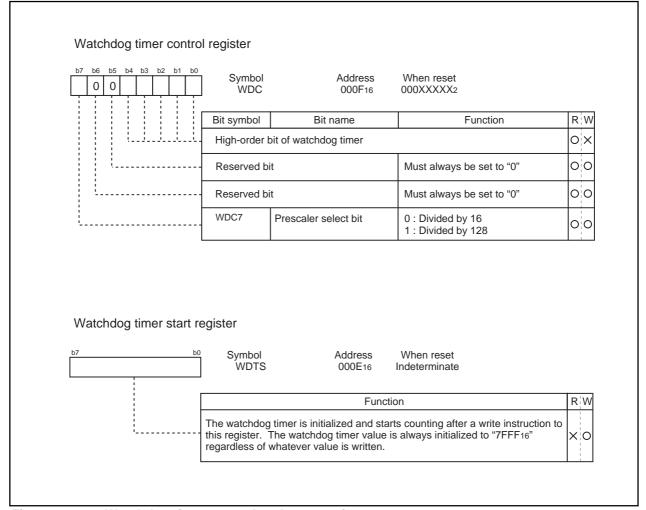


Figure 1.14.2. Watchdog timer control and start registers

#### **DMAC**

This microcomputer has two DMAC (direct memory access controller) channels that allow data to be sent to memory without using the CPU. DMAC shares the same data bus with the CPU. The DMAC is given a higher right of using the bus than the CPU, which leads to working the cycle stealing method. On this account, the operation from the occurrence of DMA transfer request signal to the completion of 1-word (16-bit) or 1-byte (8-bit) data transfer can be performed at high speed. Figure 1.15.1 shows the block diagram of the DMAC. Table 1.15.1 shows the DMAC specifications. Figure 1.15.2 to Figure 1.15.3 show the registers used by the DMAC.

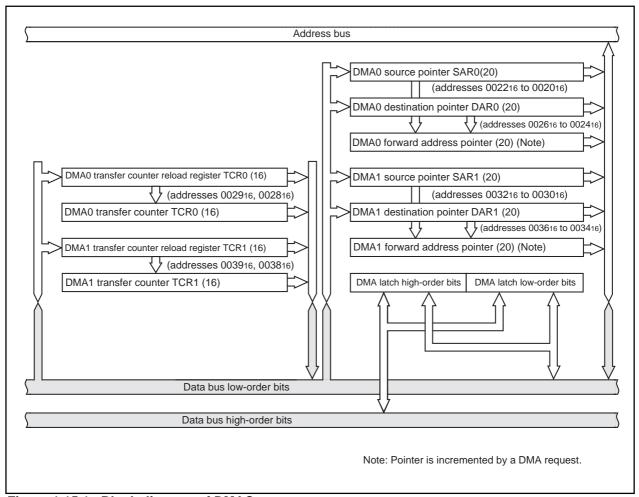


Figure 1.15.1. Block diagram of DMAC

Either a write signal to the software DMA request bit or an interrupt request signal is used as a DMA transfer request signal. But the DMA transfer is affected neither by the interrupt enable flag (I flag) nor by the interrupt priority level. The DMA transfer doesn't affect any interrupts either.

If the DMAC is active (the DMA enable bit is set to 1), data transfer starts every time a DMA transfer request signal occurs. If the cycle of the occurrences of DMA transfer request signals is higher than the DMA transfer cycle, there can be instances in which the number of transfer requests doesn't agree with the number of transfers. For details, see the description of the DMA request bit.



Table 1.15.1. DMAC specifications

Item	Specification
No. of channels	2 (cycle steal method)
Transfer memory space	• From any address in the 1M bytes space to a fixed address
	<ul> <li>From a fixed address to any address in the 1M bytes space</li> </ul>
	• From a fixed address to a fixed address
	(Note that DMA-related registers [002016 to 003F16] cannot be accessed)
Maximum No. of bytes transferred	128K bytes (with 16-bit transfers) or 64K bytes (with 8-bit transfers)
DMA request factors (Note)	Falling edge of INT0 or INT1 (INT0 can be selected by DMA0, INT1 by DMA1)
	Timer A0 to timer A4 interrupt requests
	Timer B0 to timer B2 interrupt requests
	UART0 transmission and reception interrupt requests
	UART1 transmission and reception interrupt requests (UART1 trans-
	mission can be selected by DMA0, UART1 reception by DMA1)
	UART2 transmission and reception interrupt requests
	A-D conversion interrupt requests
	Software triggers
Channel priority	DMA0 takes precedence if DMA0 and DMA1 requests are generated simultaneously
Transfer unit	8 bits or 16 bits
Transfer address direction	forward/fixed (forward direction cannot be specified for both source and
Transcription additional announces.	destination simultaneously)
Transfer mode	Single transfer mode
	After the transfer counter underflows, the DMA enable bit turns to
	"0", and the DMAC turns inactive
	Repeat transfer mode
	After the transfer counter underflows, the value of the transfer counter
	reload register is reloaded to the transfer counter.
	The DMAC remains active unless a "0" is written to the DMA enable bit.
DMA interrupt request generation timing	When an underflow occurs in the transfer counter
Active	When the DMA enable bit is set to "1", the DMAC is active.
	When the DMAC is active, data transfer starts every time a DMA
	transfer request signal occurs.
Inactive	When the DMA enable bit is set to "0", the DMAC is inactive.
	After the transfer counter underflows in single transfer mode
Forward address pointer and	At the time of starting data transfer immediately after turning the DMAC active, re
load timing for transfer	the value of one of source pointer and destination pointer - the one specified for the
counter	forward direction - is reloaded to the forward direction address pointer, and the value
	of the transfer counter reload register is reloaded to the transfer counter.
Writing to register	Registers specified for forward direction transfer are always write enabled.
	Registers specified for fixed address transfer are write-enabled when
	the DMA enable bit is "0".
Reading the register	Can be read at any time.
Trading the regions	However, when the DMA enable bit is "1", reading the register set up as the
	forward register is the same as reading the value of the forward address pointer.
	porward register is the same as reading the value of the forward address pointer.

Note: DMA transfer is not effective to any interrupt. DMA transfer is affected neither by the interrupt enable flag (I flag) nor by the interrupt priority level.



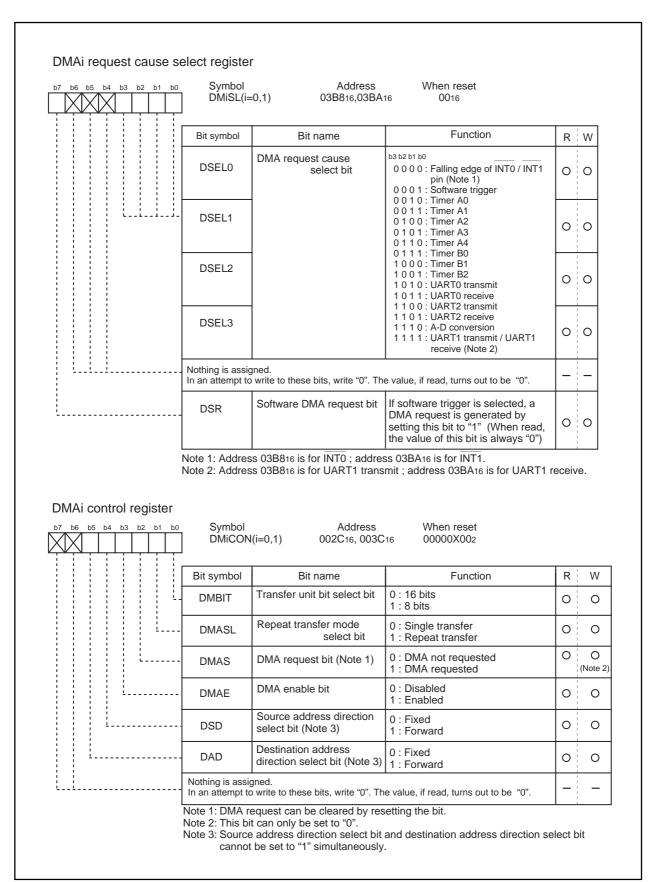


Figure 1.15.2. DMAC register (1)

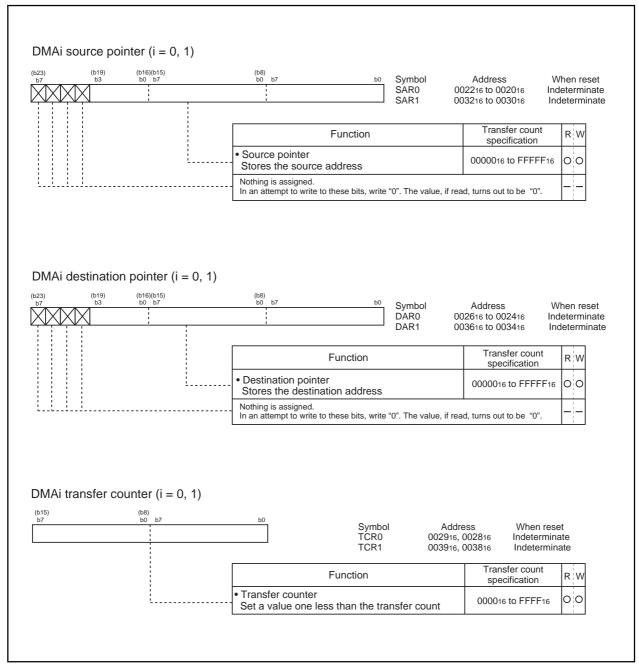


Figure 1.15.3. DMAC register (2)

## (1) Transfer cycle

The transfer cycle consists of the bus cycle in which data is read from memory or from the SFR area (source read) and the bus cycle in which the data is written to memory or to the SFR area (destination write). The number of read and write bus cycles depends on the source and destination addresses. In memory expansion mode and microprocessor mode, the number of read and write bus cycles also depends on the level of the BYTE pin. Also, the bus cycle itself is longer when software waits are inserted.

### (a) Effect of source and destination addresses

When 16-bit data is transferred on a 16-bit data bus, and the source and destination both start at odd addresses, there are one more source read cycle and destination write cycle than when the source and destination both start at even addresses.

#### (b) Effect of BYTE pin level

When transferring 16-bit data over an 8-bit data bus (BYTE pin = "H") in memory expansion mode and microprocessor mode, the 16 bits of data are sent in two 8-bit blocks. Therefore, two bus cycles are required for reading the data and two are required for writing the data. Also, in contrast to when the CPU accesses internal memory, when the DMAC accesses internal memory (internal ROM, internal RAM, and SFR), these areas are accessed using the data size selected by the BYTE pin.

### (c) Effect of software wait

When the SFR area or a memory area with a software wait is accessed, the number of cycles is increased for the wait by 1 bus cycle. The length of the cycle is determined by BCLK.

Figure 1.15.4 shows the example of the transfer cycles for a source read. For convenience, the destination write cycle is shown as one cycle and the source read cycles for the different conditions are shown. In reality, the destination write cycle is subject to the same conditions as the source read cycle, with the transfer cycle changing accordingly. When calculating the transfer cycle, remember to apply the respective conditions to both the destination write cycle and the source read cycle. For example (2) in Figure 36, if data is being transferred in 16-bit units on an 8-bit bus, two bus cycles are required for both the source read cycle and the destination write cycle.



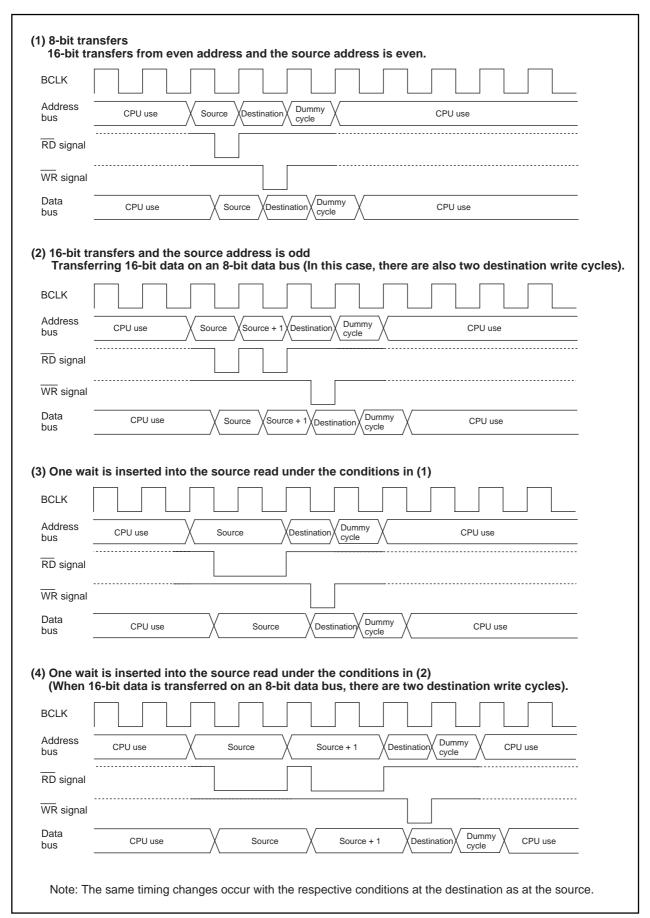


Figure 1.15.4. Example of the transfer cycles for a source read



# (2) DMAC transfer cycles

Any combination of even or odd transfer read and write addresses is possible. Table 1.15.2 shows the number of DMAC transfer cycles.

The number of DMAC transfer cycles can be calculated as follows:

No. of transfer cycles per transfer unit = No. of read cycles x j + No. of write cycles x k

Table 1.15.2. No. of DMAC transfer cycles

		Single-chip mode Memory expansion mode		Single-chip mode		ansion mode
Transfer unit	Bus width	Access address			Microprocessor mode	
			No. of read	No. of write	No. of read	No. of write
			cycles	cycles	cycles	cycles
	16-bit	Even	1	1	1	1
8-bit transfers	(BYTE= "L")	Odd	1	1	1	1
(DMBIT= "1")	8-bit	Even	_	_	1	1
	(BYTE = "H")	Odd	_	_	1	1
	16-bit	Even	1	1	1	1
16-bit transfers	(BYTE = "L")	Odd	2	2	2	2
(DMBIT= "0")	8-bit	Even	_	_	2	2
	(BYTE = "H")	Odd	_	_	2	2

### Coefficient j, k

Internal memory			External memory		
Internal ROM/RAM Internal ROM/RAM SFR area			Separate bus	Separate bus	Multiplex
No wait	With wait		No wait	With wait	bus
1 2 2		1	2	3	



#### DMA enable bit

Setting the DMA enable bit to 1 makes the DMAC active. The DMAC carries out the following operations at the time data transfer starts immediately after DMAC is turned active.

- (1) Reloads the value of one of the source pointer and the destination pointer the one specified for the forward direction to the forward direction address pointer.
- (2) Reloads the value of the transfer counter reload register to the transfer counter.

Thus overwriting 1 to the DMA enable bit with the DMAC being active carries out the operations given above, so the DMAC operates again from the initial state at the instant 1 is overwritten to the DMA enable bit.

## **DMA** request bit

The DMAC can generate a DMA transfer request signal triggered by a factor chosen in advance out of DMA request factors for each channel.

DMA request factors include the following.

- \* Factors effected by using the interrupt request signals from the built-in peripheral functions and software DMA factors (internal factors) effected by a program.
- \* External factors effected by utilizing the input from external interrupt signals.

For the selection of DMA request factors, see the descriptions of the DMAi factor selection register.

The DMA request bit turns to 1 if the DMA transfer request signal occurs regardless of the DMAC's state (regardless of whether the DMA enable bit is set 1 or to 0). It turns to 0 immediately before data transfer starts.

In addition, it can be set to 0 by use of a program, but cannot be set to 1.

There can be instances in which a change in DMA request factor selection bit causes the DMA request bit to turn to 1. So be sure to set the DMA request bit to 0 after the DMA request factor selection bit is changed. The DMA request bit turns to 1 if a DMA transfer request signal occurs, and turns to 0 immediately before data transfer starts. If the DMAC is active, data transfer starts immediately, so the value of the DMA request bit, if read by use of a program, turns out to be 0 in most cases. To examine whether the DMAC is active, read the DMA enable bit.

Here follows the timing of changes in the DMA request bit.

### (1) Internal factors

Except the DMA request factors triggered by software, the timing for the DMA request bit to turn to 1 due to an internal factor is the same as the timing for the interrupt request bit of the interrupt control register to turn to 1 due to several factors.

Turning the DMA request bit to 1 due to an internal factor is timed to be effected immediately before the transfer starts.

### (2) External factors

An external factor is a factor caused to occur by the leading edge of input from the INTi pin (i depends on which DMAC channel is used).

Selecting the INTi pins as external factors using the DMA request factor selection bit causes input from these pins to become the DMA transfer request signals.

The timing for the DMA request bit to turn to 1 when an external factor is selected synchronizes with the signal's edge applicable to the function specified by the DMA request factor selection bit (synchronizes with the trailing edge of the input signal to each INTi pin, for example).

With an external factor selected, the DMA request bit is timed to turn to 0 immediately before data transfer starts similarly to the state in which an internal factor is selected.



## (3) The priorities of channels and DMA transfer timing

If a DMA transfer request signal falls on a single sampling cycle (a sampling cycle means one period from the leading edge to the trailing edge of BCLK), the DMA request bits of applicable channels concurrently turn to 1. If the channels are active at that moment, DMA0 is given a high priority to start data transfer. When DMA0 finishes data transfer, it gives the bus right to the CPU. When the CPU finishes single bus access, then DMA1 starts data transfer and gives the bus right to the CPU.

An example in which DMA transfer is carried out in minimum cycles at the time when DMA transfer request signals due to external factors concurrently occur.

Figure 1.15.5 An example of DMA transfer effected by external factors.

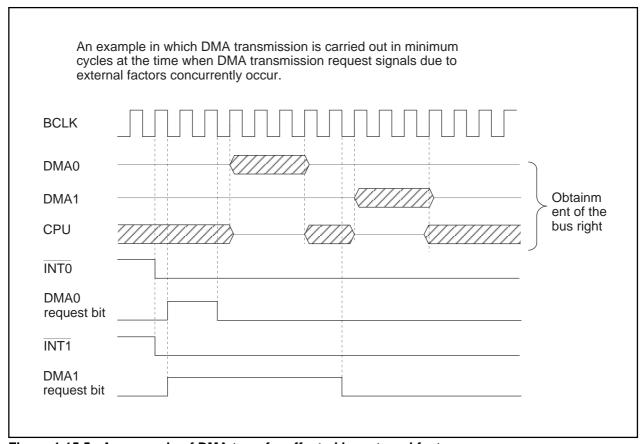


Figure 1.15.5. An example of DMA transfer effected by external factors

#### **Timer**

There are eight 16-bit timers. These timers can be classified by function into timers A (five) and timers B (three). All these timers function independently. Figure 1.16.1 shows the block diagram of timers.

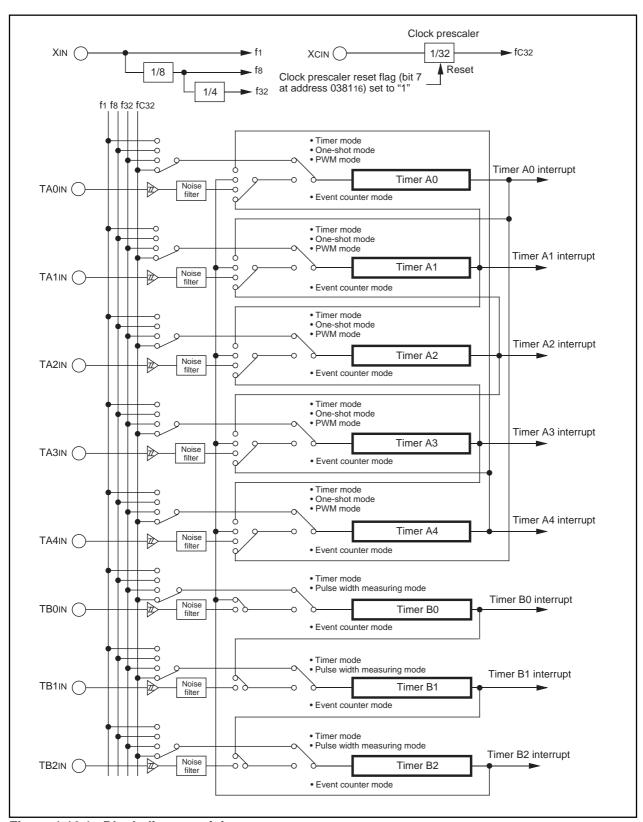


Figure 1.16.1. Block diagram of timer



#### Timer A

Figure 1.16.2 shows the block diagram of timer A. Figures 1.16.3 to 1.16.5 show the timer A-related registers.

Except in event counter mode, timers A0 through A4 all have the same function. Use the timer Ai mode register (i = 0 to 4) bits 0 and 1 to choose the desired mode.

Timer A has the four operation modes listed as follows:

- Timer mode: The timer counts an internal count source.
- Event counter mode: The timer counts pulses from an external source or a timer over flow.
- One-shot timer mode: The timer stops counting when the count reaches "000016".
- Pulse width modulation (PWM) mode: The timer outputs pulses of a given width.

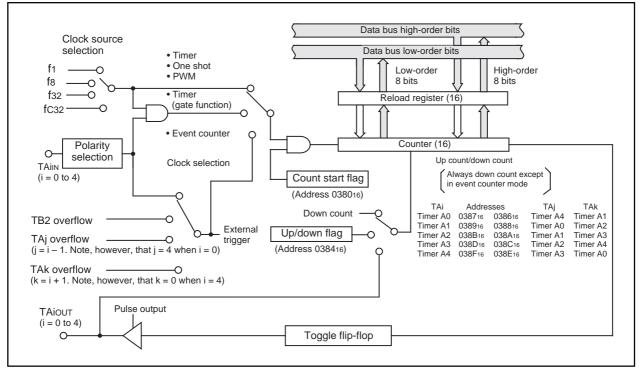


Figure 1.16.2. Block diagram of timer A

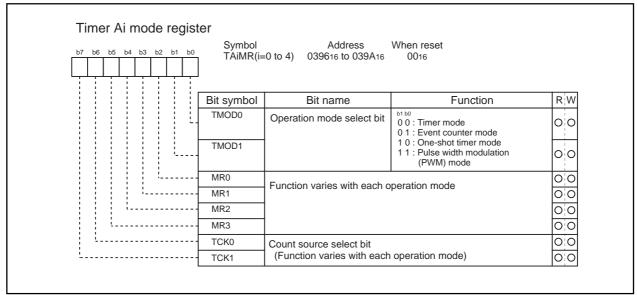


Figure 1.16.3. Timer A-related registers (1)



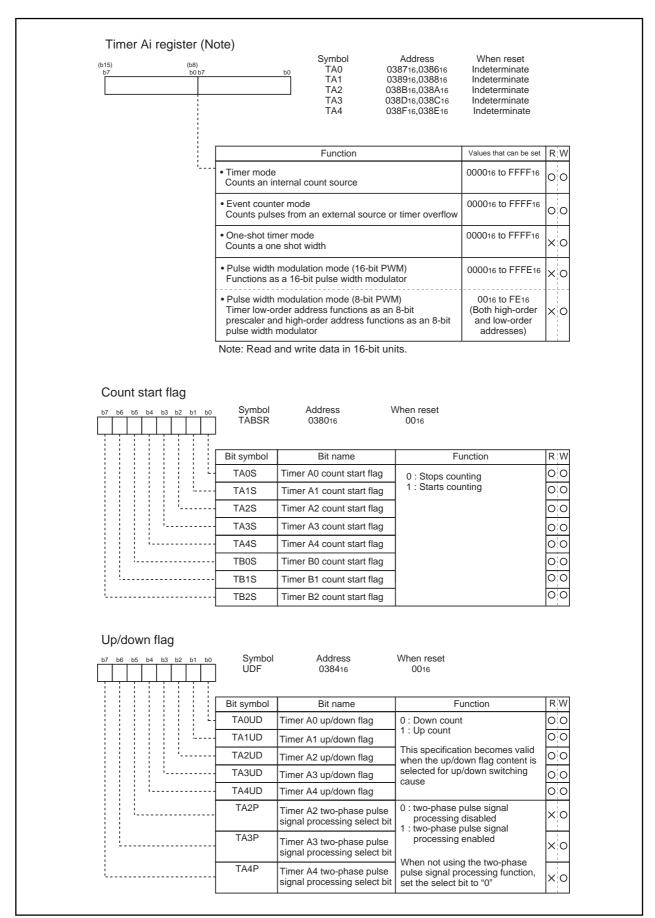


Figure 1.16.4. Timer A-related registers (2)



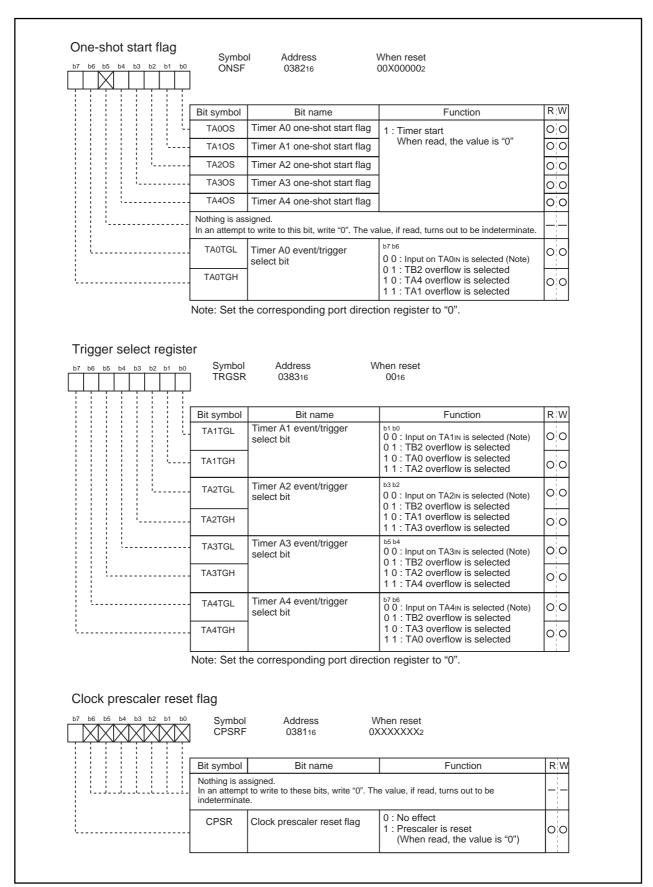


Figure 1.16.5. Timer A-related registers (3)



# (1) Timer mode

In this mode, the timer counts an internally generated count source. (See Table 1.16.1.) Figure 1.16.6 shows the timer Ai mode register in timer mode.

Table 1.16.1. Specifications of timer mode

Item	Specification		
Count source	f1, f8, f32, fC32		
Count operation	Down count		
	When the timer underflows, it reloads the reload register contents before continuing counting		
Divide ratio	1/(n+1) n : Set value		
Count start condition	Count start flag is set (= 1)		
Count stop condition	Count start flag is reset (= 0)		
Interrupt request generation timing	When the timer underflows		
TAilN pin function	Programmable I/O port or gate input		
TAiout pin function	Programmable I/O port or pulse output		
Read from timer	Count value can be read out by reading timer Ai register		
Write to timer	When counting stopped		
	When a value is written to timer Ai register, it is written to both reload register and counter		
	When counting in progress		
	When a value is written to timer Ai register, it is written to only reload register		
	(Transferred to counter at next reload time)		
Select function	Gate function		
	Counting can be started and stopped by the TAilN pin's input signal		
	Pulse output function		
	Each time the timer underflows, the TAio∪T pin's polarity is reversed		

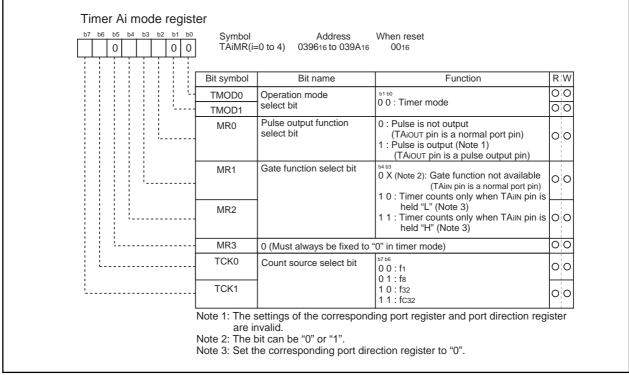


Figure 1.16.6. Timer Ai mode register in timer mode



# (2) Event counter mode

In this mode, the timer counts an external signal or an internal timer's overflow. Timers A0 and A1 can count a single-phase external signal. Timers A2, A3, and A4 can count a single-phase and a two-phase external signal. Table 1.16.2 lists timer specifications when counting a single-phase external signal. Figure 1.16.7 shows the timer Ai mode register in event counter mode.

Table 1.16.3 lists timer specifications when counting a two-phase external signal. Figure 1.16.8 shows the timer Ai mode register in event counter mode.

Table 1.16.2. Timer specifications in event counter mode (when not processing two-phase pulse signal)

Item	Specification				
Count source	External signals input to TAilN pin (effective edge can be selected by software)				
	TB2 overflow, TAj overflow				
Count operation	Up count or down count can be selected by external signal or software				
	• When the timer overflows or underflows, it reloads the reload register con				
	tents before continuing counting (Note)				
Divide ratio	1/ (FFFF <sub>16</sub> - n + 1) for up count				
	1/ (n + 1) for down count n : Set value				
Count start condition	Count start flag is set (= 1)				
Count stop condition	Count start flag is reset (= 0)				
Interrupt request generation timing	The timer overflows or underflows				
TAilN pin function	Programmable I/O port or count source input				
TAiout pin function	Programmable I/O port, pulse output, or up/down count select input				
Read from timer	Count value can be read out by reading timer Ai register				
Write to timer	When counting stopped				
	When a value is written to timer Ai register, it is written to both reload register and counter				
	When counting in progress				
	When a value is written to timer Ai register, it is written to only reload register				
	(Transferred to counter at next reload time)				
Select function	Free-run count function				
	Even when the timer overflows or underflows, the reload register content is not reloaded to it				
	Pulse output function				
	Each time the timer overflows or underflows, the TAiOUT pin's polarity is reversed				

Note: This does not apply when the free-run function is selected.

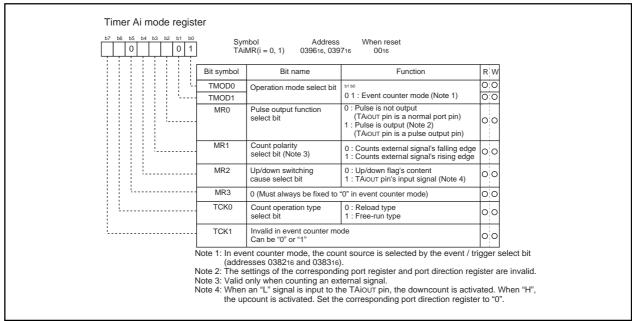


Figure 1.16.7. Timer Ai mode register in event counter mode

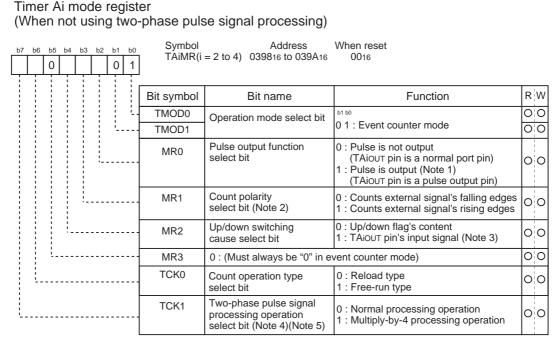


Table 1.16.3. Timer specifications in event counter mode (when processing two-phase pulse signal with timers A2, A3, and A4)

	timers A2, A3, and A4)				
Item	Specification				
Count source	Two-phase pulse signals input to TAilN or TAiOUT pin				
Count operation	Up count or down count can be selected by two-phase pulse signal				
	When the timer overflows or underflows, the reload register content is				
	reloaded and the timer starts over again (Note)				
Divide ratio	1/ (FFFF16 - n + 1) for up count				
	1/ (n + 1) for down count n : Set value				
Count start condition	Count start flag is set (= 1)				
Count stop condition	Count start flag is reset (= 0)				
Interrupt request generation timing	Timer overflows or underflows				
TAilN pin function	Two-phase pulse input				
TAiout pin function	Two-phase pulse input				
Read from timer	Count value can be read out by reading timer A2, A3, or A4 register				
Write to timer	When counting stopped				
	When a value is written to timer A2, A3, or A4 register, it is written to both				
	reload register and counter				
	When counting in progress				
	When a value is written to timer A2, A3, or A4 register, it is written to only				
	reload register. (Transferred to counter at next reload time.)				
Select function	Normal processing operation				
	The timer counts up rising edges or counts down falling edges on the TAilN				
	pin when input signal on the TAio∪⊤ pin is "H"				
	TAIOUT				
	TAiIN  (i=2,3) Up Up Down Down Down count count count count count count				
	Multiply-by-4 processing operation  If the phase relationship is such that the TAilN pin goes "H" when the input				
	signal on the TAiout pin is "H", the timer counts up rising and falling edges				
	on the TAio∪T pin is H , the timer counts up hising and railing edges on the TAio∪T and TAiiN pins. If the phase relationship is such that the				
	TAilN pin goes "L" when the input signal on the TAiout pin is "H", the timer				
	counts down rising and falling edges on the TAIOUT and TAIN pins.				
	Counts down hising and faming edges on the TAIOUT and TAIIN pins.				
	TAIOUT				
	Count up all edges Count down all edges				
	TAIIN (i=3,4)				
	Count up all edges  Count down all edges				
1	Count up all edges Count down all edges				

Note: This does not apply when the free-run function is selected.





Note 1: The settings of the corresponding port register and port direction register are invalid.

Note 2: This bit is valid when only counting an external signal.

Note 3: Set the corresponding port direction register to "0".

Note 4: This bit is valid for the timer A3 mode register.

For timer A2 and A4 mode registers, this bit can be "0 "or "1".

Note 5: When performing two-phase pulse signal processing, make sure the two-phase pulse signal processing operation select bit (address 038416) is set to "1". Also, always be sure to set the event/trigger select bit (addresses 038216 and 038316) to "00".

# Timer Ai mode register (When using two-phase pulse signal processing)

b7 b6 b5 b4 b3 b2 b1 b0 0 1 0 0 1	Symbol Address When reset TAiMR(i = 2 to 4) 039816 to 039A16 0016			
	Bit symbol	Bit name	Function	RW
	TMOD0	Operation mode select bit	0 1 : Event counter mode	00
-	TMOD1		o i : Evolit coulitor illodo	0,0
	MR0	0 (Must always be "0" when processing)	using two-phase pulse signal	00
	MR1	0 (Must always be "0" when processing)	using two-phase pulse signal	00
	MR2	1 (Must always be "1" when processing)	using two-phase pulse signal	00
	MR3	0 (Must always be "0" when processing)	using two-phase pulse signal	00
	TCK0	Count operation type select bit	0 : Reload type 1 : Free-run type	00
	TCK1	Two-phase pulse processing operation select bit (Note 1)(Note 2)	0 : Normal processing operation 1 : Multiply-by-4 processing operation	00

Note 1: This bit is valid for timer A3 mode register.

For timer A2 and A4 mode registers, this bit can be "0" or "1".

Note 2: When performing two-phase pulse signal processing, make sure the two-phase pulse signal processing operation select bit (address 038416) is set to "1". Also, always be sure to set the event/trigger select bit (addresses 038216 and 038316) to "00".

Figure 1.16.8. Timer Ai mode register in event counter mode



# (3) One-shot timer mode

In this mode, the timer operates only once. (See Table 1.16.4.) When a trigger occurs, the timer starts up and continues operating for a given period. Figure 1.16.9 shows the timer Ai mode register in one-shot timer mode.

Table 1.16.4. Timer specifications in one-shot timer mode

Item	Specification			
Count source	f1, f8, f32, fC32			
Count operation	The timer counts down			
	When the count reaches 000016, the timer stops counting after reloading a new count			
	If a trigger occurs when counting, the timer reloads a new count and restarts counting			
Divide ratio	1/n n : Set value			
Count start condition	An external trigger is input			
	The timer overflows			
	The one-shot start flag is set (= 1)			
Count stop condition	A new count is reloaded after the count has reached 000016			
	• The count start flag is reset (= 0)			
Interrupt request generation timing	The count reaches 000016			
TAilN pin function	Programmable I/O port or trigger input			
TAiout pin function	Programmable I/O port or pulse output			
Read from timer	When timer Ai register is read, it indicates an indeterminate value			
Write to timer	When counting stopped			
	When a value is written to timer Ai register, it is written to both reload			
	register and counter			
	When counting in progress			
	When a value is written to timer Ai register, it is written to only reload register			
	(Transferred to counter at next reload time)			

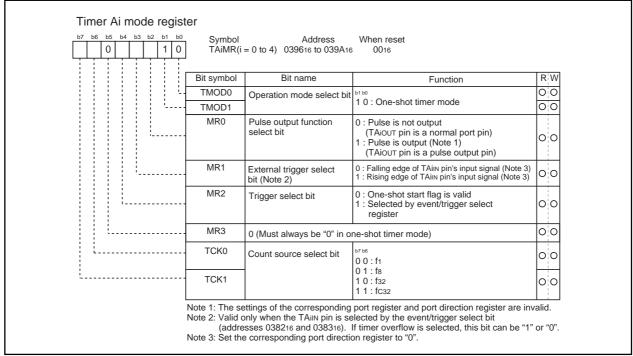


Figure 1.16.9. Timer Ai mode register in one-shot timer mode



# (4) Pulse width modulation (PWM) mode

In this mode, the timer outputs pulses of a given width in succession. (See Table 1.16.5.) In this mode, the counter functions as either a 16-bit pulse width modulator or an 8-bit pulse width modulator. Figure 1.16.10 shows the configuration of the timer Ai mode register in pulse width modulation mode. Figure 1.16.11 shows an example of how a 16-bit pulse width modulator operates. Figure 1.16.12 shows an example of how an 8-bit pulse width modulator operates.

Table 1.16.5. Timer specifications in pulse width modulation mode

Item	Specification			
Count source	f1, f8, f32, fC32			
Count operation	The timer counts down (operating as an 8-bit or a 16-bit pulse width modulator)			
	The timer reloads a new count at a rising edge of PWM pulse and continues counting			
	The timer is not affected by a trigger that occurs when counting			
16-bit PWM	High level width    n / fi    n : Set value			
	• Cycle time (2 <sup>16</sup> - 1) / fi fixed			
8-bit PWM	High level width n X (m+1) / fi n: values set to timer Ai register's high-order address			
	Cycle time (28 - 1) X (m +1) / fi m : values set to timer Ai register's low-order address			
Count start condition	External trigger is input			
	The timer overflows			
	The count start flag is set (= 1)			
Count stop condition	The count start flag is reset (= 0)			
Interrupt request generation timing	PWM pulse goes "L"			
TAilN pin function	Programmable I/O port or trigger input			
TAiout pin function	Pulse output			
Read from timer	When timer Ai register is read, it indicates an indeterminate value			
Write to timer	When counting stopped			
	When a value is written to timer Ai register, it is written to both reload			
	register and counter			
	When counting in progress			
	When a value is written to timer Ai register, it is written to only reload register			
	(Transferred to counter at next reload time)			

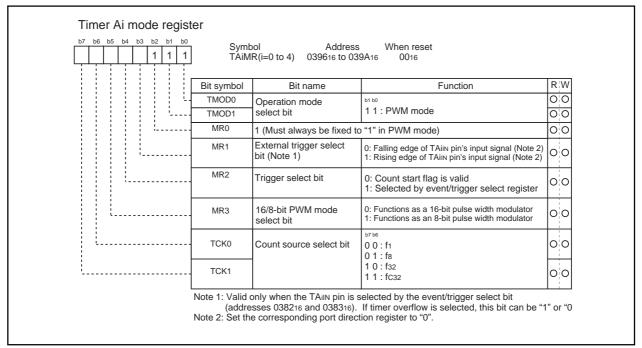


Figure 1.16.10. Configuration of timer Ai mode register in pulse width modulation mode



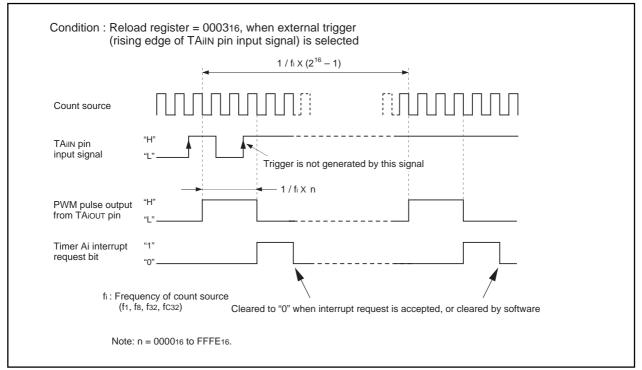


Figure 1.16.11. Example of how a 16-bit pulse width modulator operates

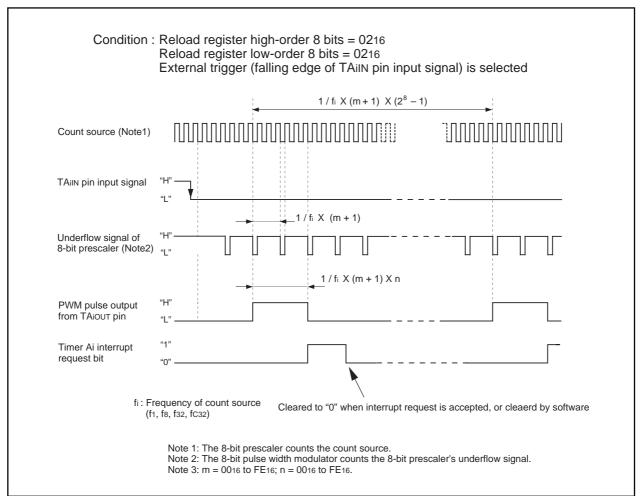


Figure 1.16.12. Example of how an 8-bit pulse width modulator operates



#### Timer B

Figure 1.16.13 shows the block diagram of timer B. Figures 1.16.14 and 1.16.15 show the timer B-related registers.

Use the timer Bi mode register (i = 0 to 2) bits 0 and 1 to choose the desired mode.

Timer B has three operation modes listed as follows:

- Timer mode: The timer counts an internal count source.
- Event counter mode: The timer counts pulses from an external source or a timer overflow.
- Pulse period/pulse width measuring mode: The timer measures an external signal's pulse period or pulse width.

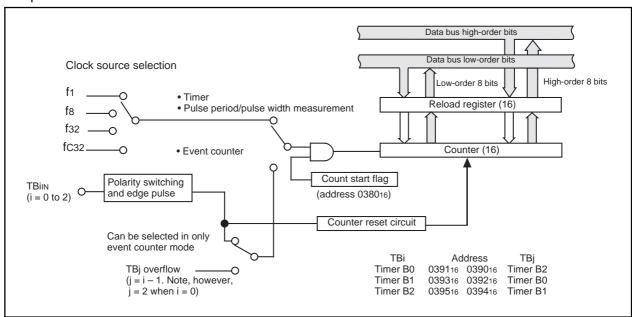


Figure 1.16.13. Block diagram of timer B

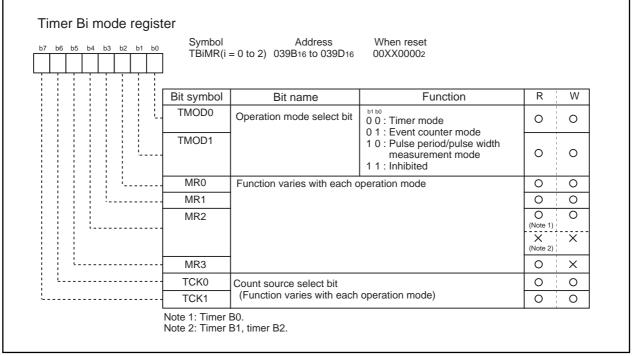


Figure 1.16.14. Timer B-related registers (1)



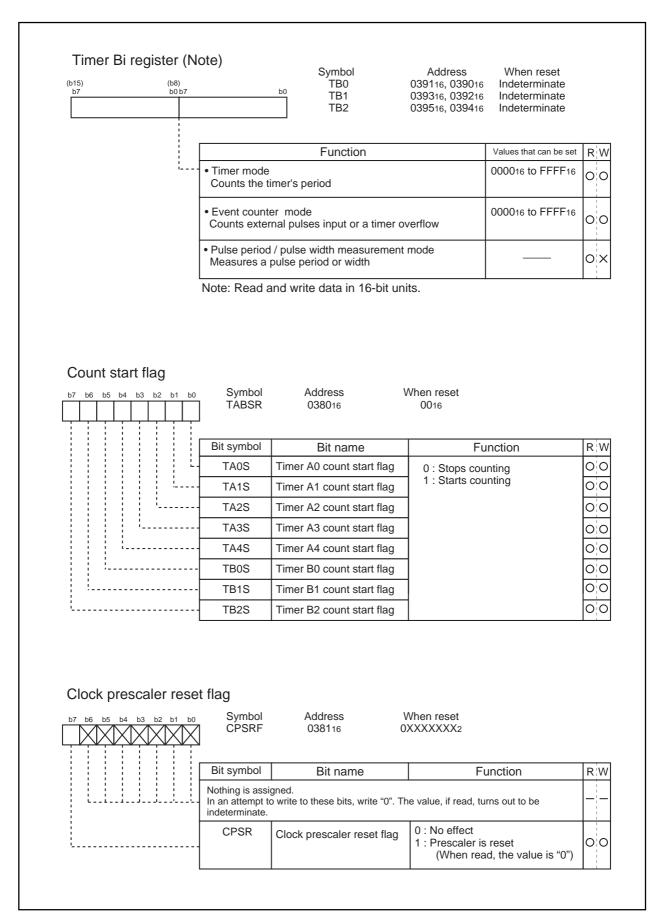


Figure 1.16.15. Timer B-related registers (2)



# (1) Timer mode

In this mode, the timer counts an internally generated count source. (See Table 1.16.6.) Figure 1.16.16 shows the timer Bi mode register in timer mode.

Table 1.16.6. Timer specifications in timer mode

Item	Specification
Count source	f1, f8, f32, fC32
Count operation	Counts down
	When the timer underflows, it reloads the reload register contents before
	continuing counting
Divide ratio	1/(n+1) n : Set value
Count start condition	Count start flag is set (= 1)
Count stop condition	Count start flag is reset (= 0)
Interrupt request generation timing	The timer underflows
TBilN pin function	Programmable I/O port
Read from timer	Count value is read out by reading timer Bi register
Write to timer	When counting stopped
	When a value is written to timer Bi register, it is written to both reload register and counter
	When counting in progress
	When a value is written to timer Bi register, it is written to only reload register
	(Transferred to counter at next reload time)

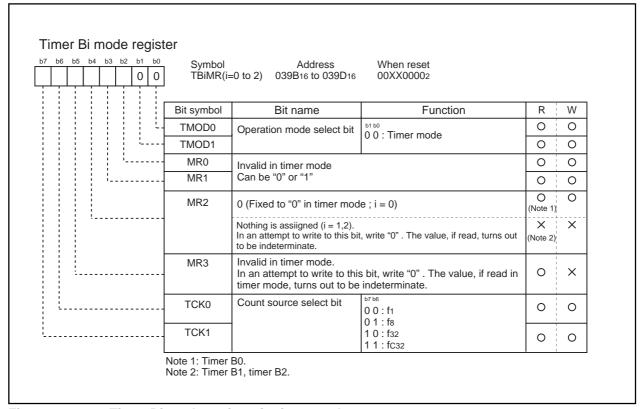


Figure 1.16.16. Timer Bi mode register in timer mode



## (2) Event counter mode

In this mode, the timer counts an external signal or an internal timer's overflow. (See Table 1.16.7.) Figure 1.16.17 shows the timer Bi mode register in event counter mode.

Table 1.16.7. Timer specifications in event counter mode

Item	Specification				
Count source	• External signals input to TBilN pin				
	• Effective edge of count source can be a rising edge, a falling edge, or falling				
	and rising edges as selected by software				
Count operation	Counts down				
	When the timer underflows, it reloads the reload register contents before				
	continuing counting				
Divide ratio	1/(n+1) n : Set value				
Count start condition	Count start flag is set (= 1)				
Count stop condition	Count start flag is reset (= 0)				
Interrupt request generation timing	The timer underflows				
TBilN pin function	Count source input				
Read from timer	Count value can be read out by reading timer Bi register				
Write to timer	When counting stopped				
	When a value is written to timer Bi register, it is written to both reload register and counter				
	When counting in progress				
	When a value is written to timer Bi register, it is written to only reload register				
	(Transferred to counter at next reload time)				

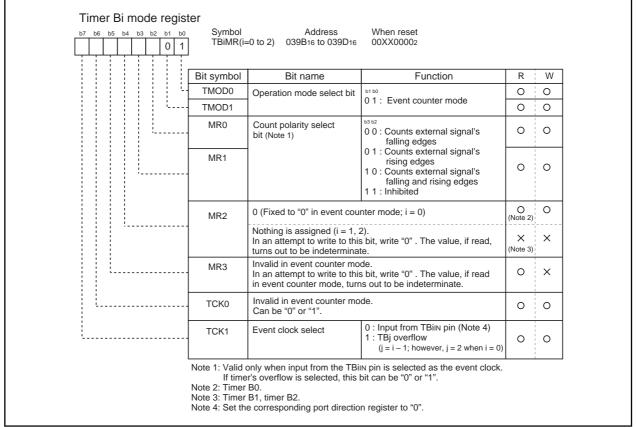


Figure 1.16.17. Timer Bi mode register in event counter mode



# (3) Pulse period/pulse width measurement mode

In this mode, the timer measures the pulse period or pulse width of an external signal. (See Table 1.16.8.) Figure 1.16.18 shows the timer Bi mode register in pulse period/pulse width measurement mode. Figure 1.16.19 shows the operation timing when measuring a pulse period. Figure 1.16.20 shows the operation timing when measuring a pulse width.

Table 1.16.8. Timer specifications in pulse period/pulse width measurement mode

Item	Specification			
Count source	f1, f8, f32, fC32			
Count operation	• Up count			
	Counter value "000016" is transferred to reload register at measurement			
	pulse's effective edge and the timer continues counting			
Count start condition	Count start flag is set (= 1)			
Count stop condition	Count start flag is reset (= 0)			
Interrupt request generation timing	When measurement pulse's effective edge is input (Note 1)			
	When an overflow occurs. (Simultaneously, the timer Bi overflow flag			
	changes to "1". The timer Bi overflow flag changes to "0" when the count			
	start flag is "1" and a value is written to the timer Bi mode register.)			
TBiin pin function	Measurement pulse input			
Read from timer	When timer Bi register is read, it indicates the reload register's content			
	(measurement result) (Note 2)			
Write to timer	Cannot be written to			

Note 1: An interrupt request is not generated when the first effective edge is input after the timer has started counting. Note 2: The value read out from the timer Bi register is indeterminate until the second effective edge is input after the timer.

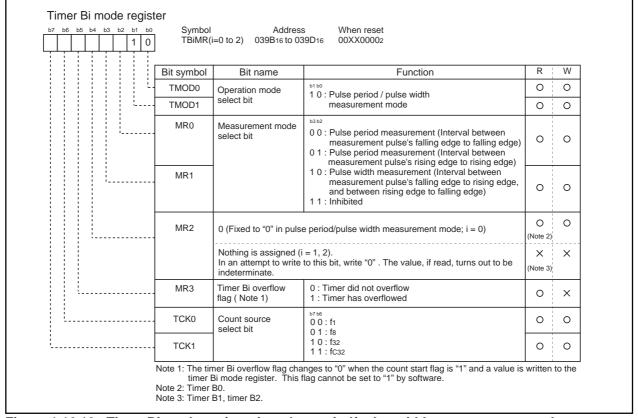


Figure 1.16.18. Timer Bi mode register in pulse period/pulse width measurement mode



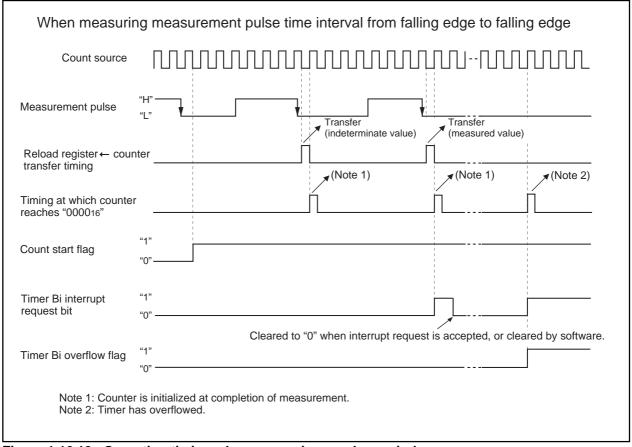


Figure 1.16.19. Operation timing when measuring a pulse period

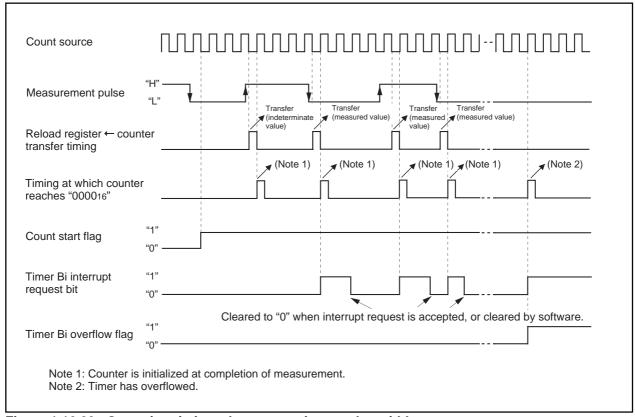


Figure 1.16.20. Operation timing when measuring a pulse width



#### Serial I/O

Serial I/O is configured as three channels: UART0, UART1 and UART2. UART0, UART1 and UART2 each have an exclusive timer to generate a transfer clock, so they operate independently of each other.

Figure 1.17.1 shows the block diagram of UART0, UART1 and UART2. Figure 1.17.2 and figure 1.17.3 show the block diagram of the transmit/receive unit.

UARTi (i = 0 to 2) has two operation modes: a clock synchronous serial I/O mode and a clock asynchronous serial I/O mode (UART mode). The contents of the serial I/O mode select bits (bits 0 to 2 at addresses 03A016, 03A816 and 037816) determine whether UARTi is used as a clock synchronous serial I/O or as a UART.

UART0 through UART2 are almost equal in their functions with minor exceptions. UART2, in particular, is compliant with the SIM interface with some extra settings added in clock-asynchronous serial I/O mode (Note). It also has the bus collision detection function that generates an interrupt request if the TxD pin and the RxD pin are different in level.

Note: SIM: Subscriber Identity Module

Table 1.17.1 shows the comparison of functions of UART0 through UART2, and Figures 1.17.4 through 1.17.8 show the registers related to UARTi.

Table 1.17.1. Comparison of functions of UART0 through UART2

Function	UART0		UART1		UART2	
CLK polarity selection	CLK polarity selection Possible (Note		Possible	(Note 1)	Possible	(Note 1)
LSB first / MSB first selection	Possible (I	Note 1)	Possible	(Note 1)	Possible	(Note 2)
Continuous receive mode selection	Possible (I	Note 1)	Possible	(Note 1)	Possible	(Note 1)
Transfer clock output from multiple pins selection	Impossible		Possible	(Note 1)	Impossible	:
Separate CTS/RTS pins	Possible		Impossible	e	Impossible	
Serial data logic switch	Impossible		Impossible	e	Possible	(Note 4)
Sleep mode selection	Possible (1	Note 3)	Possible	(Note 3)	Impossible	
TxD, RxD I/O polarity switch	Impossible		Impossible	e	Possible	
TxD, RxD port output format	CMOS output		CMOS ou	tput	N-channel output	open-drain
Parity error signal output	Impossible		Impossible	e	Possible	(Note 4)
Bus collision detection	Impossible		Impossible	e	Possible	

Note 1: Only when clock synchronous serial I/O mode.

Note 2: Only when clock synchronous serial I/O mode and 8-bit UART mode.

Note 3: Only when UART mode.

Note 4: Using for SIM interface.



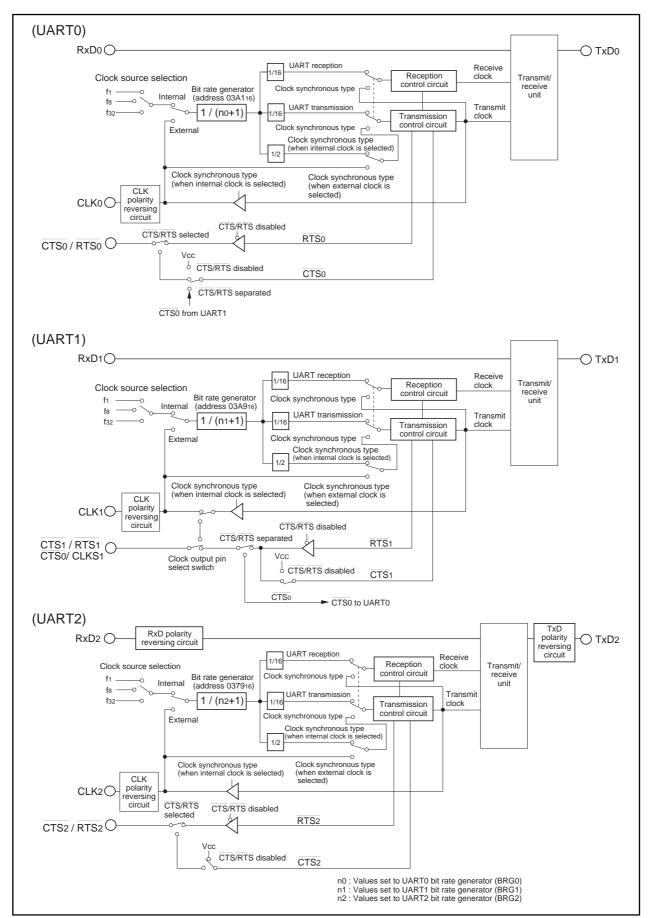


Figure 1.17.1. Block diagram of UARTi (i = 0 to 2)



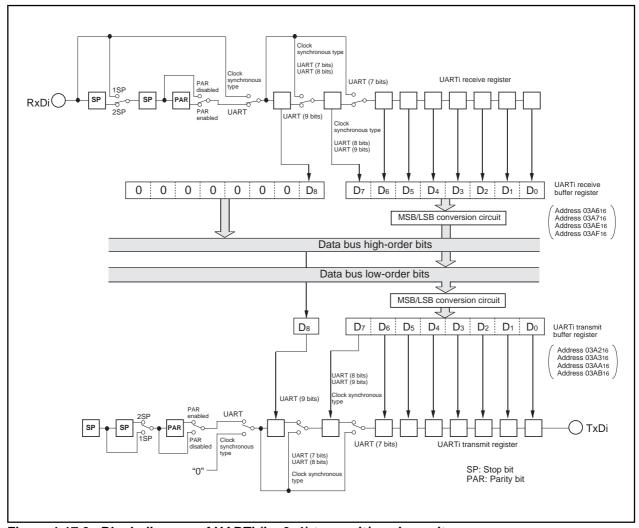


Figure 1.17.2. Block diagram of UARTi (i = 0, 1) transmit/receive unit

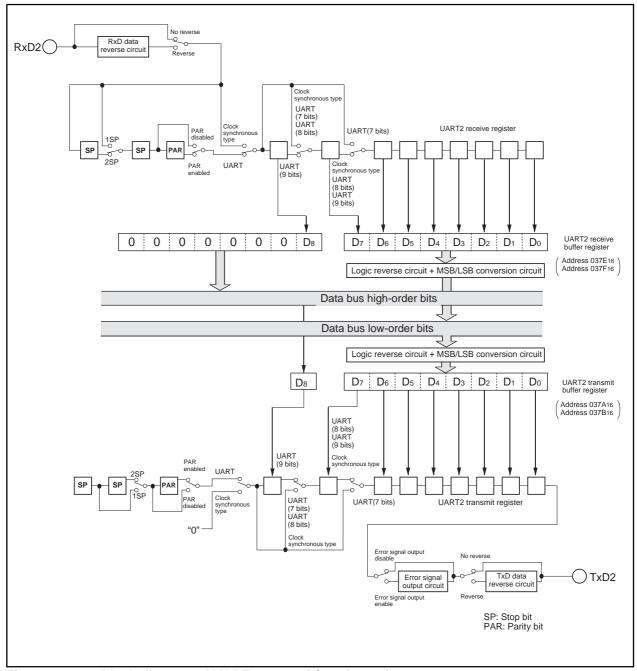


Figure 1.17.3. Block diagram of UART2 transmit/receive unit

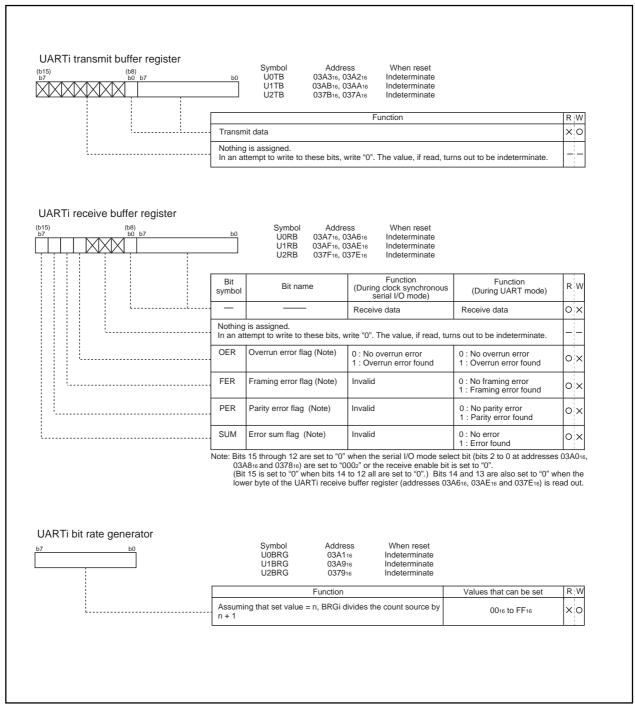


Figure 1.17.4. Serial I/O-related registers (1)

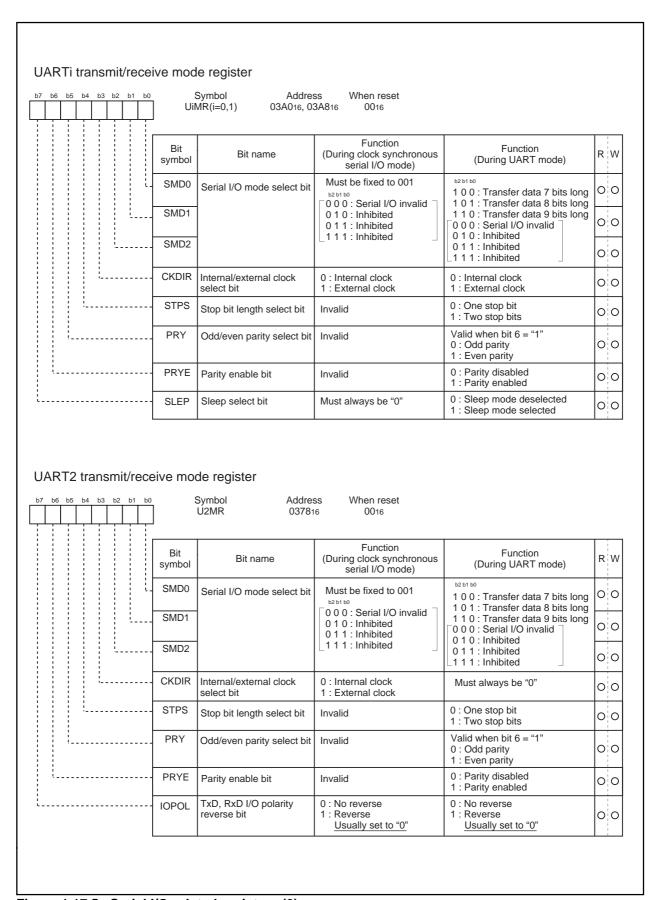


Figure 1.17.5. Serial I/O-related registers (2)



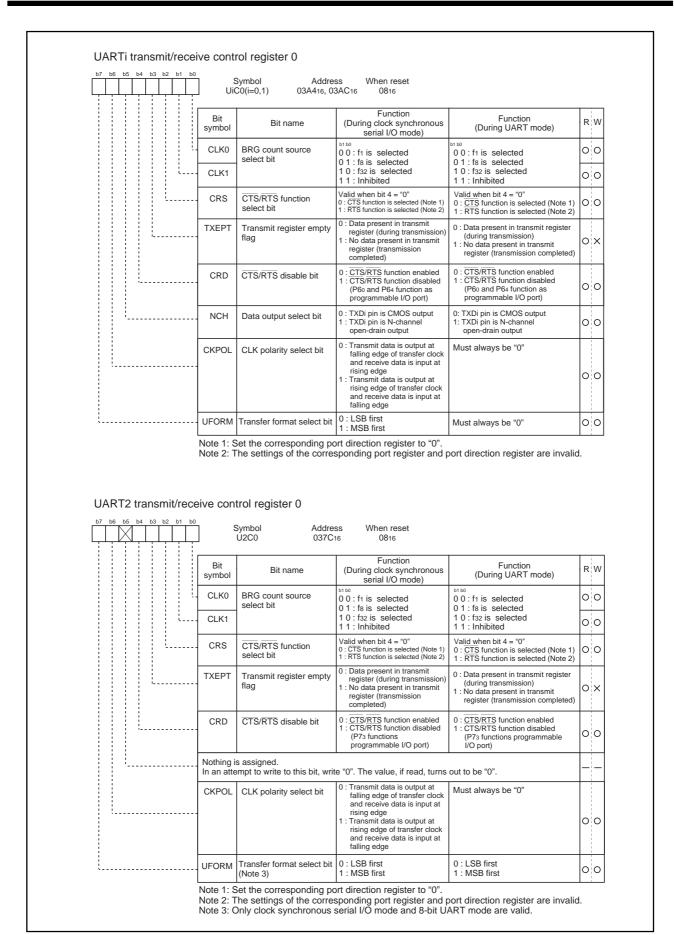


Figure 1.17.6. Serial I/O-related registers (3)



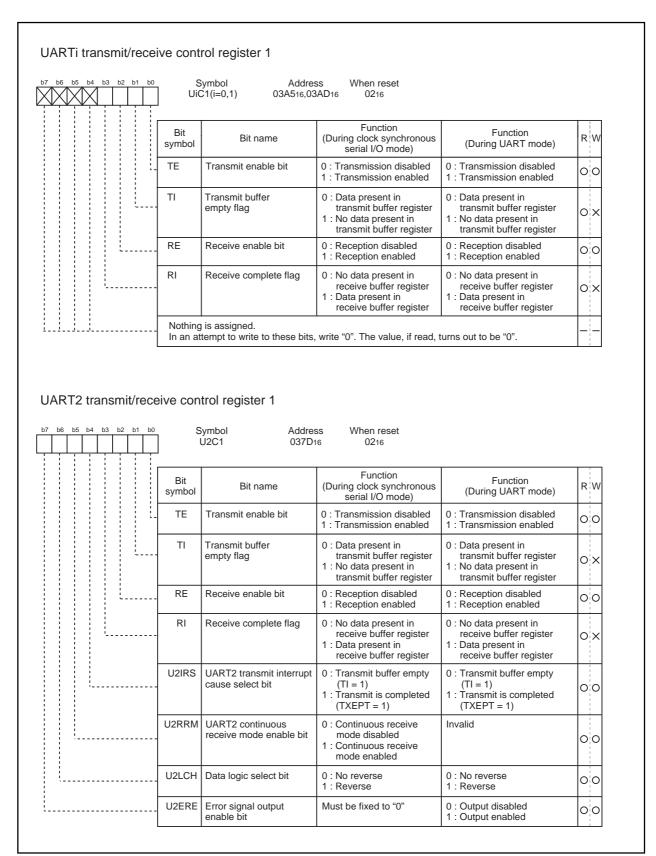


Figure 1.17.7. Serial I/O-related registers (4)



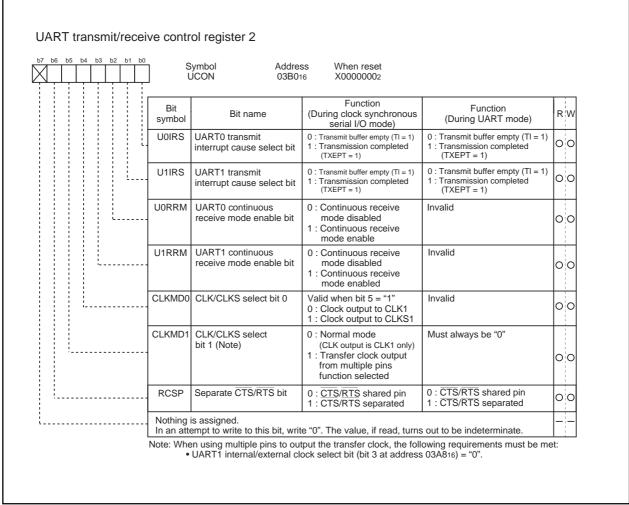


Figure 1.17.8. Serial I/O-related registers (5)

# (1) Clock synchronous serial I/O mode

The clock synchronous serial I/O mode uses a transfer clock to transmit and receive data. Table 1.17.2 and table 1.17.3 list the specifications of the clock synchronous serial I/O mode. Figure 1.17.9 shows the UARTi transmit/receive mode register.

Table 1.17.2. Specifications of clock synchronous serial I/O mode (1)

Item	Specification			
Transfer data format	Transfer data length: 8 bits			
Transfer clock	When internal clock is selected (bit 3 at addresses 03A016, 03A816, 037816)			
	= "0") : fi/ 2(n+1) (Note 1) fi = f1, f8, f32			
	• When external clock is selected (bit 3 at addresses 03A016, 03A816, 037816			
	= "1") : Input from CLKi pin			
Transmission/reception control	TTS function/RTS function/CTS, RTS function chosen to be invalid			
Transmission start condition	To start transmission, the following requirements must be met:			
	- Transmit enable bit (bit 0 at addresses 03A516, 03AD16, 037D16) = "1"			
	- Transmit buffer empty flag (bit 1 at addresses 03A516, 03AD16, 037D16) = "0"			
	- When CTS function selected, CTS input level = "L"			
	• Furthermore, if external clock is selected, the following requirements must also be met:			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "0":			
	CLKi input level = "H"			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "1":			
	CLKi input level = "L"			
Reception start condition	To start reception, the following requirements must be met:			
	- Receive enable bit (bit 2 at addresses 03A516, 03AD16, 037D16) = "1"			
	- Transmit enable bit (bit 0 at addresses 03A516, 03AD16, 037D16) = "1"			
	- Transmit buffer empty flag (bit 1 at addresses 03A516, 03AD16, 037D16) = "0"			
	Furthermore, if external clock is selected, the following requirements must			
	also be met:			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "0":			
	CLKi input level = "H"			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "1":			
	CLKi input level = "L"			
Interrupt request	When transmitting			
generation timing	- Transmit interrupt cause select bit (bits 0, 1 at address 03B016, bit 4 at			
	address 037D16) = "0": Interrupts requested when data transfer from UARTi			
	transfer buffer register to UARTi transmit register is completed			
	- Transmit interrupt cause select bit (bits 0, 1 at address 03B016, bit 4 at			
	address 037D16) = "1": Interrupts requested when data transmission from			
	UARTi transfer register is completed			
	When receiving			
	- Interrupts requested when data transfer from UARTi receive register to			
	UARTi receive buffer register is completed			
Error detection	Overrun error (Note 2)			
	This error occurs when the next data is ready before contents of UARTi			
	receive buffer register are read out			

Note 1: "n" denotes the value 0016 to FF16 that is set to the UART bit rate generator.

Note 2: If an overrun error occurs, the UARTi receive buffer will have the next data written in. Note also that the UARTi receive interrupt request bit is not set to "1".



Table 1.17.3. Specifications of clock synchronous serial I/O mode (2)

Item	Specification
Select function	CLK polarity selection
	Whether transmit data is output/input at the rising edge or falling edge of the
	transfer clock can be selected
	LSB first/MSB first selection
	Whether transmission/reception begins with bit 0 or bit 7 can be selected
	Continuous receive mode selection
	Reception is enabled simultaneously by a read from the receive buffer register
	Transfer clock output from multiple pins selection (UART1) (Note)
	UART1 transfer clock can be chosen by software to be output from one of
	the two pins set
	Separate CTS/RTS pins (UART0) (Note)
	UART0 CTS and RTS pins each can be assigned to separate pins
	Switching serial data logic (UART2)
	Whether to reverse data in writing to the transmission buffer register or
	reading the reception buffer register can be selected.
	TxD, RxD I/O polarity reverse (UART2)
	This function is reversing TxD port output and RxD port input. All I/O data
	level is reversed.

Note: The transfer clock output from multiple pins and the separate  $\overline{\text{CTS}/\text{RTS}}$  pins functions cannot be selected simultaneously.



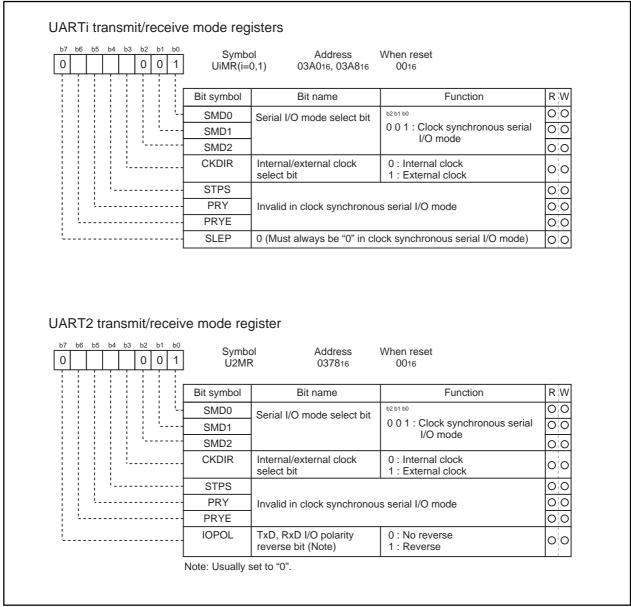


Figure 1.17.9. UARTi transmit/receive mode register in clock synchronous serial I/O mode

Table 1.17.4 lists the functions of the input/output pins during clock synchronous serial I/O mode. This table shows the pin functions when the transfer clock output from multiple pins and the separate  $\overline{\text{CTS}}/\overline{\text{RTS}}$  pins functions are not selected. Note that for a period from when the UARTi operation mode is selected to when transfer starts, the TxDi pin outputs a "H". (If the N-channel open-drain is selected, this pin is in floating state.)

Table 1.17.4. Input/output pin functions in clock synchronous serial I/O mode

Pin name	Function	Method of selection
TxDi (P63, P67, P70)	Serial data output	(Outputs dummy data when performing reception only)
RxDi (P62, P66, P71)	Serial data input	Port P62, P66 and P71 direction register (bits 2 and 6 at address 03EE16, bit 1 at address 03EF16)= "0" (Can be used as an input port when performing transmission only)
CLKi (P61, P65, P72)	Transfer clock output	Internal/external clock select bit (bit 3 at address 03A016, 03A816, 037816) = "0"
	Transfer clock input	Internal/external clock select bit (bit 3 at address 03A016, 03A816, 037816) = "1" Port P61, P65 and P72 direction register (bits 1 and 5 at address 03EE16, bit 2 at address 03EF16) = "0"
CTSi/RTSi (P60, P64, P73)	CTS input	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) ="0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "0" Port P60, P64 and P73 direction register (bits 0 and 4 at address 03EE16, bit 3 at address 03EF16) = "0"
	RTS output	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "1"
	Programmable I/O port	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "1"

(when transfer clock output from multiple pins and separate CTS/RTS pins functions are not selected)



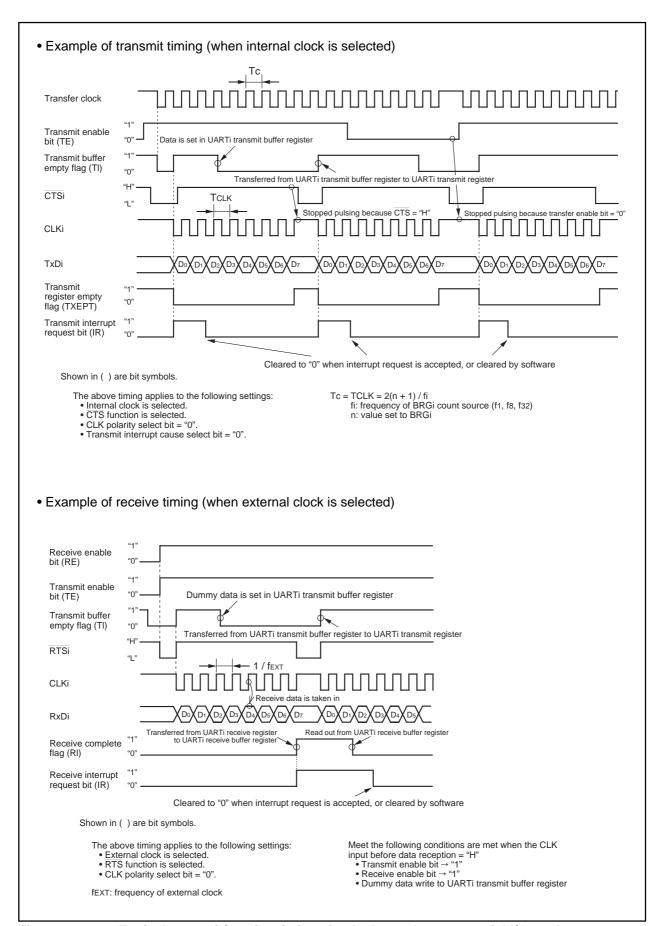


Figure 1.17.10. Typical transmit/receive timings in clock synchronous serial I/O mode



## (a) Polarity select function

As shown in Figure 1.17.11, the CLK polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) allows selection of the polarity of the transfer clock.

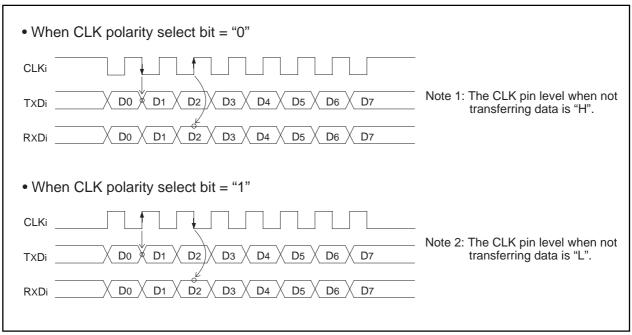


Figure 1.17.11. Polarity of transfer clock

### (b) LSB first/MSB first select function

As shown in Figure 1.17.12, when the transfer format select bit (bit 7 at addresses 03A416, 03AC16, 037C16) = "0", the transfer format is "LSB first"; when the bit = "1", the transfer format is "MSB first".

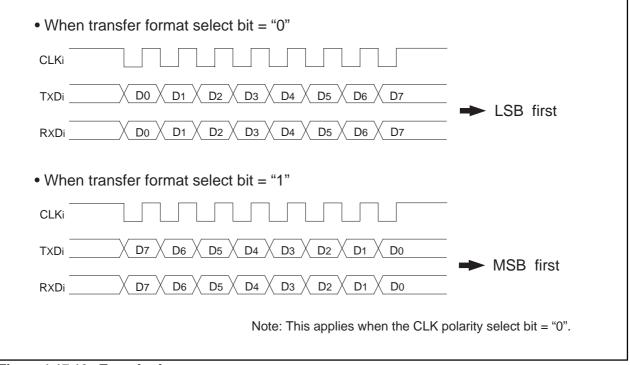


Figure 1.17.12. Transfer format



### (c) Transfer clock output from multiple pins function (UART1)

This function allows the setting two transfer clock output pins and choosing one of the two to output a clock by using the CLK and CLKS select bit (bits 4 and 5 at address 03B016). (See Figure 1.17.13.) The multiple pins function is valid only when the internal clock is selected for UART1. Note that when this function is selected, UART1 CTS/RTS function cannot be used.

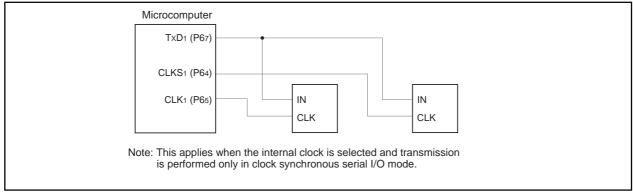


Figure 1.17.13. The transfer clock output from the multiple pins function usage

#### (d) Continuous receive mode

If the continuous receive mode enable bit (bits 2 and 3 at address 03B016, bit 5 at address 037D16) is set to "1", the unit is placed in continuous receive mode. In this mode, when the receive buffer register is read out, the unit simultaneously goes to a receive enable state without having to set dummy data to the transmit buffer register back again.

### (e) Separate CTS/RTS pins function (UART0)

This function works the same way as in the clock asynchronous serial I/O (UART) mode. The method of setting and the input/output pin functions are both the same, so refer to select function in the next section, "(2) Clock asynchronous serial I/O (UART) mode." Note that this function is <u>invalid</u> if the transfer clock output from the multiple pins function is selected.

#### (f) Serial data logic switch function (UART2)

When the data logic select bit (bit6 at address 037D16) = "1", and writing to transmit buffer register or reading from receive buffer register, data is reversed. Figure 1.17.14 shows the example of serial data logic switch timing.

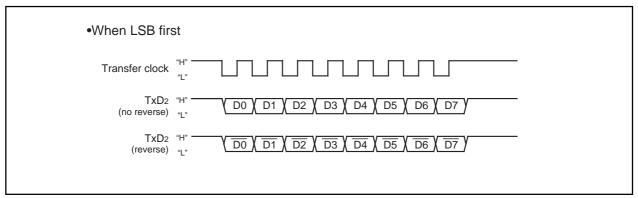


Figure 1.17.14. Serial data logic switch timing



# (2) Clock asynchronous serial I/O (UART) mode

The UART mode allows transmitting and receiving data after setting the desired transfer rate and transfer data format. Table 1.17.5 and table 1.17.6 list the specifications of the UART mode. Figure 1.17.15 shows the UARTi transmit/receive mode register.

Table 1.17.5. Specifications of UART Mode (1)

Item	Specification
Transfer data format	Character bit (transfer data): 7 bits, 8 bits, or 9 bits as selected
	Start bit: 1 bit
	Parity bit: Odd, even, or nothing as selected
	Stop bit: 1 bit or 2 bits as selected
Transfer clock	• When internal clock is selected (bit 3 at addresses 03A016, 03A816, 037816 = "0"):
	fi/16(n+1) (Note 1) $fi = f1, f8, f32$
	• When external clock is selected (bit 3 at addresses 03A016, 03A816 ="1"):
	fEXT/16(n+1) (Note 1) (Note 2) (Do not set external clock for UART2)
Transmission/reception control	• CTS function/RTS function/CTS, RTS function chosen to be invalid
Transmission start condition	To start transmission, the following requirements must be met:
	- Transmit enable bit (bit 0 at addresses 03A516, 03AD16, 037D16) = "1"
	- Transmit buffer empty flag (bit 1 at addresses 03A516, 03AD16, 037D16) = "0"
	- When $\overline{\text{CTS}}$ function selected, $\overline{\text{CTS}}$ input level = "L"
Reception start condition	To start reception, the following requirements must be met:
	- Receive enable bit (bit 2 at addresses 03A516, 03AD16, 037D16) = "1"
	- Start bit detection
Interrupt request	When transmitting
generation timing	- Transmit interrupt cause select bits (bits 0,1 at address 03B016, bit4 at
	address 037D16) = "0": Interrupts requested when data transfer from UARTi
	transfer buffer register to UARTi transmit register is completed
	- Transmit interrupt cause select bits (bits 0, 1 at address 03B016, bit4 at
	address 037D16) = "1": Interrupts requested when data transmission from
	UARTi transfer register is completed
	When receiving
	- Interrupts requested when data transfer from UARTi receive register to
	UARTi receive buffer register is completed
Error detection	Overrun error (Note 3)
	This error occurs when the next data is ready before contents of UARTi
	receive buffer register are read out
	Framing error
	This error occurs when the number of stop bits set is not detected
	• Parity error
	This error occurs when if parity is enabled, the number of 1's in parity and
	character bits does not match the number of 1's set
	• Error sum flag
	This flag is set (= 1) when any of the overrun, framing, and parity errors is
	encountered

Note 1: 'n' denotes the value 0016 to FF16 that is set to the UARTi bit rate generator.

Note 2: fext is input from the CLKi pin.

Note 3: If an overrun error occurs, the UARTi receive buffer will have the next data written in. Note also that the UARTi receive interrupt request bit is not set to "1".



Table 1.17.6. Specifications of UART Mode (2)

Item	Specification
Select function	Separate CTS/RTS pins (UART0)
	UART0 CTS and RTS pins each can be assigned to separate pins
	Sleep mode selection (UART0, UART1)
	This mode is used to transfer data to and from one of multiple slave micro-
	computers
	Serial data logic switch (UART2)
	This function is reversing logic value of transferring data. Start bit, parity bit
	and stop bit are not reversed.
	• TxD, RxD I/O polarity switch
	This function is reversing TxD port output and RxD port input. All I/O data
	level is reversed.



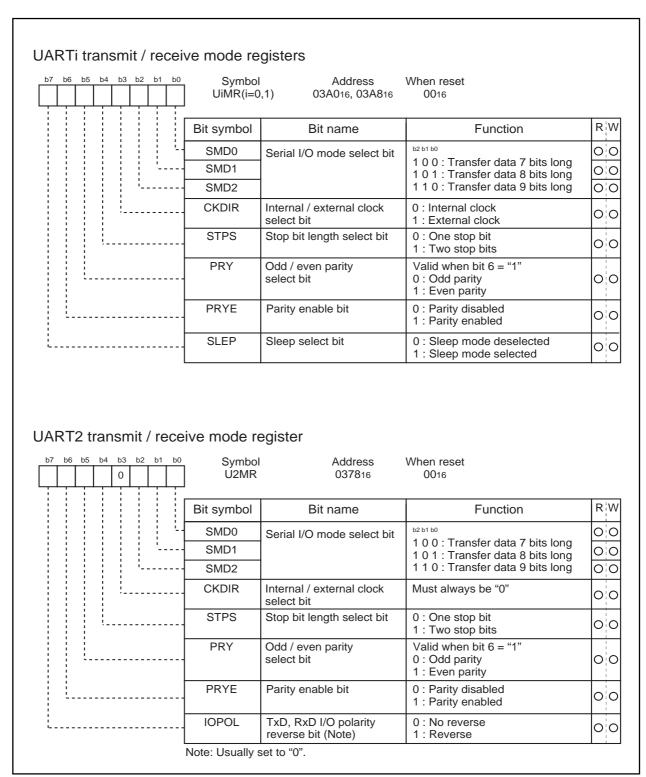


Figure 1.17.15. UARTi transmit/receive mode register in UART mode

Table 1.17.7 lists the functions of the input/output pins during UART mode. This table shows the pin functions when the separate  $\overline{\text{CTS}/\text{RTS}}$  pins function is <u>not selected</u>. Note that for a period from when the UARTi operation mode is selected to when transfer starts, the TxDi pin outputs a "H". (If the N-channel open-drain is selected, this pin is in floating state.)

Table 1.17.7. Input/output pin functions in UART mode

Pin name	Function	Method of selection
TxDi (P63, P67, P70)	Serial data output	
RxDi (P62, P66, P71)	Serial data input	Port P62, P66 and P71 direction register (bits 2 and 6 at address 03EE16, bit 1 at address 03EF16)= "0" (Can be used as an input port when performing transmission only)
CLKi (P61, P65, P72)	Programmable I/O port	Internal/external clock select bit (bit 3 at address 03A016, 03A816, 037816) = "0"
	Transfer clock input	Internal/external clock select bit (bit 3 at address 03A016, 03A816) = "1" Port P61, P65 direction register (bits 1 and 5 at address 03EE16) = "0" (Do not set external clock for UART2)
CTSi/RTSi (P60, P64, P73)	CTS input	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) ="0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "0" Port P60, P64 and P73 direction register (bits 0 and 4 at address 03EE16, bit 3 at address 03EF16) = "0"
	RTS output	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "1"
	Programmable I/O port	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "1"

(when separate CTS/RTS pins function is not selected)



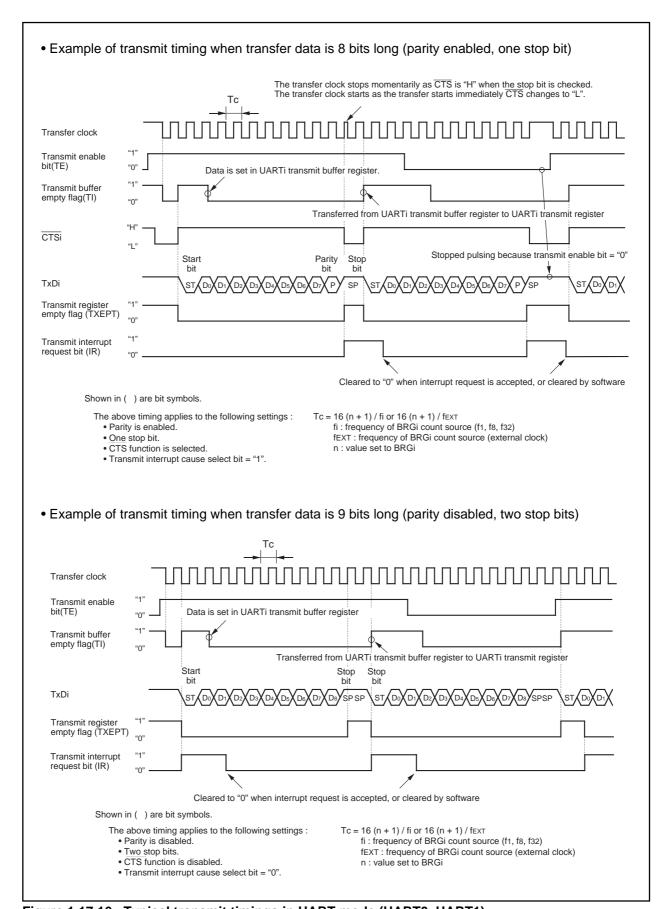


Figure 1.17.16. Typical transmit timings in UART mode (UART0, UART1)

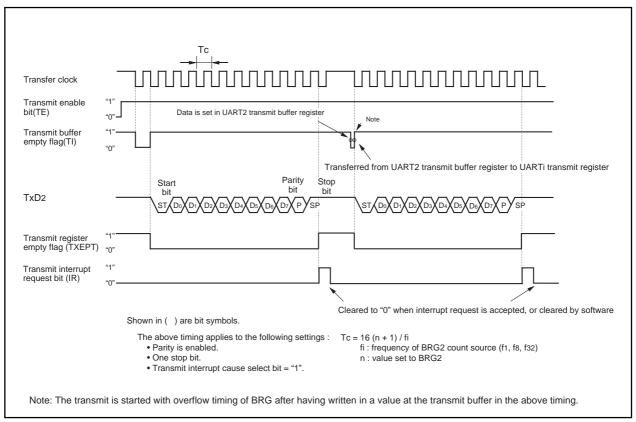


Figure 1.17.17. Typical transmit timings in UART mode (UART2)

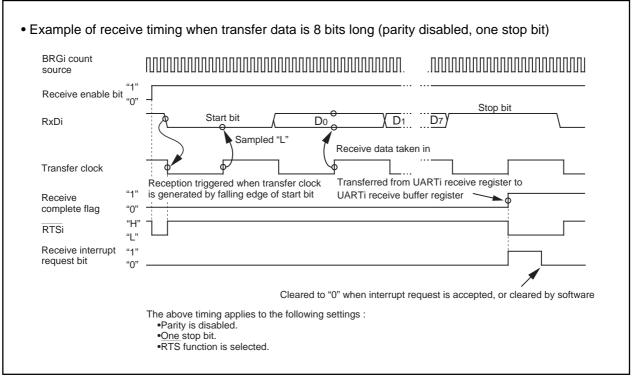


Figure 1.17.18. Typical receive timing in UART mode

### (a) Separate CTS/RTS pins function (UART0)

Setting the CTS/RTS separate bit (bit 6 of address 03B016) to "1" inputs/outputs the CTS signal and RTS signal from different pins. Choose which to use, CTS or RTS, by use of the CTS/RTS function select bit (bit 2 of address 03A416). This function is effective in UART0 only. With this function chosen, the user cannot use the CTS/RTS function. Set "0" both to the CTS/RTS function select bit (bit 2 of address 03AC16) and to the CTS/RTS disable bit (bit 4 of address 03AC16).

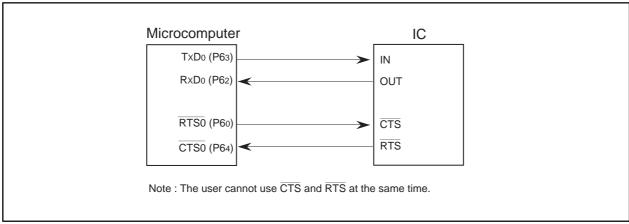


Figure 1.17.19. The separate CTS/RTS pins function usage

#### (b) Sleep mode (UART0, UART1)

This mode is used to transfer data between specific microcomputers among multiple microcomputers connected using UARTi. The sleep mode is selected when the sleep select bit (bit 7 at addresses 03A016, 03A816) is set to "1" during reception. In this mode, the unit performs receive operation when the MSB of the received data = "1" and does not perform receive operation when the MSB = "0".



#### (c) Function for switching serial data logic (UART2)

When the data logic select bit (bit 6 of address 037D16) is assigned 1, data is inverted in writing to the transmission buffer register or reading the reception buffer register. Figure 1.17.20 shows the example of timing for switching serial data logic.

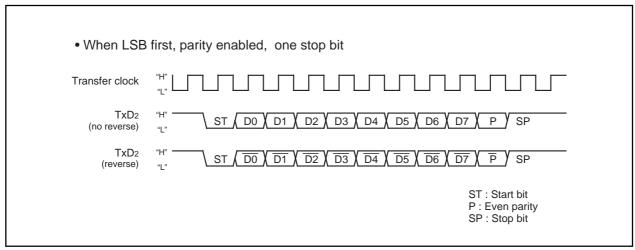


Figure 1.17.20. Timing for switching serial data logic

### (d) TxD, RxD I/O polarity reverse function (UART2)

This function is to reverse TxD pin output and RxD pin input. The level of any data to be input or output (including the start bit, stop bit(s), and parity bit) is reversed. Set this function to "0" (not to reverse) for usual use.

# (e) Bus collision detection function (UART2)

This function is to sample the output level of the TxD pin and the input level of the RxD pin at the rising edge of the transfer clock; if their values are different, then an interrupt request occurs. Figure 1.17.21 shows the example of detection timing of a buss collision (in UART mode).

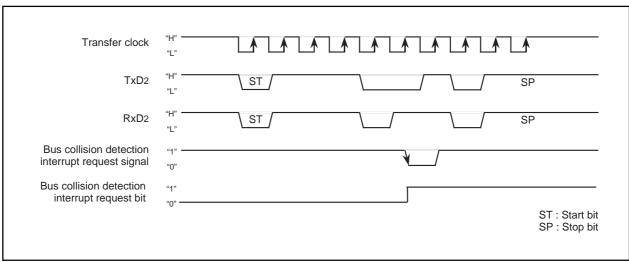


Figure 1.17.21. Detection timing of a bus collision (in UART mode)



## (3) Clock-asynchronous serial I/O mode (compliant with the SIM interface)

The SIM interface is used for connecting the microcomputer with a memory card or the like; adding some extra settings in UART2 clock-asynchronous serial I/O mode allows the user to effect this function. Table 1.17.8 shows the specifications of clock-asynchronous serial I/O mode (compliant with the SIM interface).

Table 1.17.8. Specifications of clock-asynchronous serial I/O mode (compliant with the SIM interface)

Item	Specification					
Transfer data format	• Transfer data 8-bit UART mode (bit 2 through bit 0 of address 037816 = "1012")					
	• One stop bit (bit 4 of address 037816 = "0")					
	With the direct format chosen					
	Set parity to "even" (bit 5 and bit 6 of address 037816 = "1" and "1" respectively)					
	Set data logic to "direct" (bit 6 of address 037D16 = "0").					
	Set transfer format to LSB (bit 7 of address 037C16 = "0").					
	With the inverse format chosen					
	Set parity to "odd" (bit 5 and bit 6 of address 037816 = "0" and "1" respectively)					
	Set data logic to "inverse" (bit 6 of address 037D16 = "1")					
	Set transfer format to MSB (bit 7 of address 037C16 = "1")					
Transfer clock	• With the internal clock chosen (bit 3 of address 037816 = "0"): fi / 16 (n + 1) (Note 1): fi=f1, f8, f32					
	(Do not set external clock)					
Transmission / reception control	• Disable the CTS and RTS function (bit 4 of address 037C16 = "1")					
Other settings	The sleep mode select function is not available for UART2					
	• Set transmission interrupt factor to "transmission completed" (bit 4 of address 037D16 = "1")					
Transmission start condition	To start transmission, the following requirements must be met:					
	- Transmit enable bit (bit 0 of address 037D16) = "1"					
	- Transmit buffer empty flag (bit 1 of address 037D16) = "0"					
Reception start condition	To start reception, the following requirements must be met:					
	- Reception enable bit (bit 2 of address 037D16) = "1"					
	- Detection of a start bit					
Interrupt request	When transmitting					
generation timing	When data transmission from the UART2 transfer register is completed					
	(bit 4 of address 037D16 = "1")					
	When receiving					
	When data transfer from the UART2 receive register to the UART2 receive					
	buffer register is completed					
Error detection	• Overrun error (see the specifications of clock-asynchronous serial I/O) (Note 3)					
	• Framing error (see the specifications of clock-asynchronous serial I/O)					
	<ul> <li>Parity error (see the specifications of clock-asynchronous serial I/O)</li> </ul>					
	- On the reception side, an "L" level is output from the TxD2 pin by use of the parity error					
	signal output function (bit 7 of address 037D16 = "1") when a parity error is detected					
	- On the transmission side, a parity error is detected by the level of input to					
	the RxD2 pin when a transmission interrupt occurs					
	• The error sum flag (see the specifications of clock-asynchronous serial I/O)					

Note 1: 'n' denotes the value 0016 to FF16 that is set to the UARTi bit rate generator.

Note 2: fext is input from the CLK2 pin.

Note 3: If an overrun error occurs, the UART2 receive buffer will have the next data written in. Note also that the UARTi receive interrupt request bit is not set to "1".



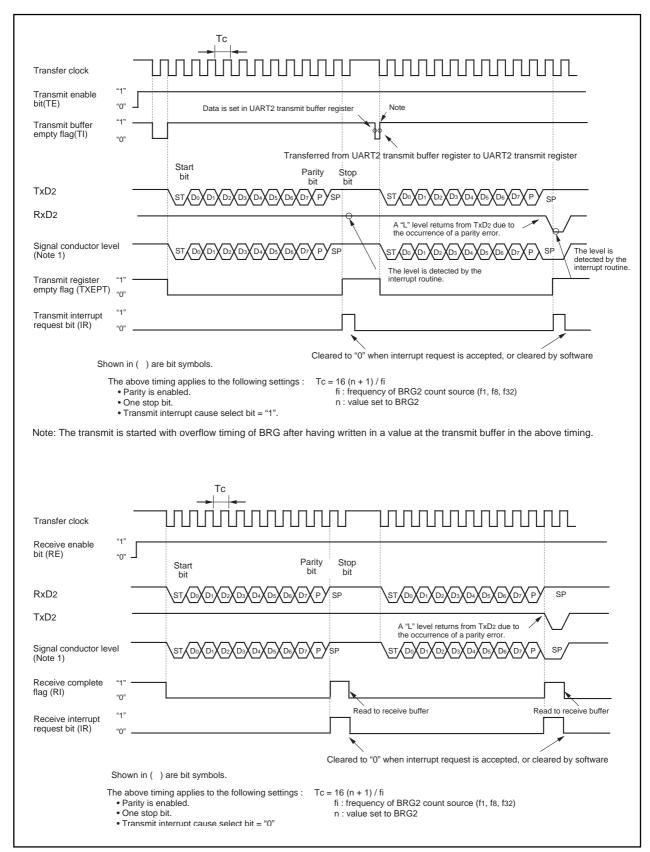


Figure 1.17.22. Typical transmit/receive timing in UART mode (compliant with the SIM interface)



### (a) Function for outputting a parity error signal

With the error signal output enable bit (bit 7 of address 037D16) assigned "1", you can output an "L" level from the TxD2 pin when a parity error is detected. In step with this function, the generation timing of a transmission completion interrupt changes to the detection timing of a parity error signal. Figure 1.17.23 shows the output timing of the parity error signal.

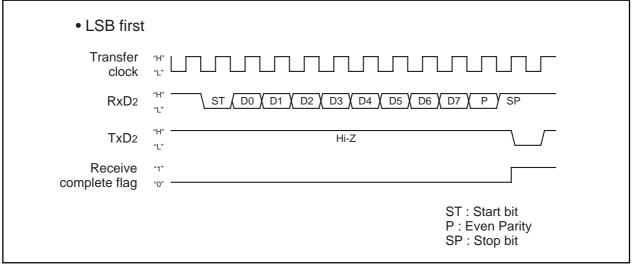


Figure 1.17.23. Output timing of the parity error signal

### (b) Direct format/inverse format

Connecting the SIM card allows you to switch between direct format and inverse format. If you choose the direct format, D<sub>0</sub> data is output from TxD<sub>2</sub>. If you choose the inverse format, D<sub>7</sub> data is inverted and output from TxD<sub>2</sub>.

Figure 1.17.24 shows the SIM interface format.

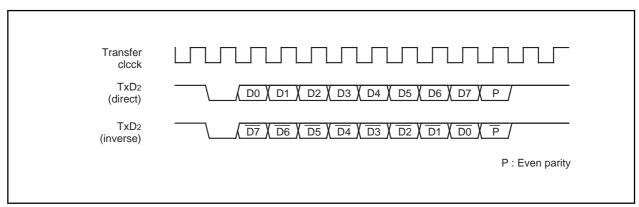


Figure 1.17.24. SIM interface format

Figure 1.17.25 shows the example of connecting the SIM interface. Connect TxD2 and RxD2 and apply pull-up.

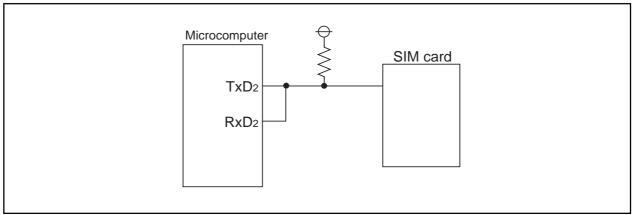


Figure 1.17.25. Connecting the SIM interface

#### **A-D Converter**

The A-D converter consists of one 10-bit successive approximation A-D converter circuit with a capacitive coupling amplifier. Pins P100 to P107, P95, and P96 also function as the analog signal input pins. The direction registers of these pins for A-D conversion must therefore be set to input. The Vref connect bit (bit 5 at address 03D716) can be used to isolate the resistance ladder of the A-D converter from the reference voltage input pin (VREF) when the A-D converter is not used. Doing so stops any current flowing into the resistance ladder from VREF, reducing the power dissipation. When using the A-D converter, start A-D conversion only after setting bit 5 of 03D716 to connect VREF. The result of A-D conversion is stored in the A-D registers of the selected pins. When set to 10-bit precision, the low 8 bits are stored in the even addresses and the high 2 bits in the odd addresses. When set to 8-bit precision, the low 8 bits are stored in the even addresses.

Table 1.18.1 shows the performance of the A-D converter. Figure 1.18.1 shows the block diagram of the A-D converter, and Figures 1.18.2 and 1.18.3 show the A-D converter-related registers.

Table 1.18.1. Performance of A-D converter

Item	Performance						
Method of A-D conversion	uccessive approximation (capacitive coupling amplifier)						
Analog input voltage (Note 1)	0V to AVcc (Vcc)						
Operating clock	VCC = 5V fAD/divide-by-2 of fAD/divide-by-4 of fAD, fAD=f(XIN)						
	VCC = 3V divide-by-2 of fAD/divide-by-4 of fAD, fAD=f(XIN)						
Resolution	bit or 10-bit (selectable)						
Absolute precision	Vcc = 5V • Without sample and hold function						
	±3LSB						
	<ul> <li>With sample and hold function (8-bit resolution)</li> </ul>						
	±2LSB						
	<ul> <li>With sample and hold function (10-bit resolution)</li> </ul>						
	ANo to AN7 input: ±3LSB						
	ANEX0 and ANEX1 input (including mode in which external						
	operation amp is connected): ±7LSB						
	VCC = 3V • Without sample and hold function (8-bit resolution)						
	±2LSB						
Operating modes	One-shot mode, repeat mode, single sweep mode, repeat sweep mode 0,						
	and repeat sweep mode 1						
Analog input pins	8pins (ANo to AN7) + 2pins (ANEX0 and ANEX1)						
A-D conversion start condition	Software trigger						
	A-D conversion starts when the A-D conversion start flag changes to "1"						
	• External trigger (can be retriggered)						
	A-D conversion starts when the A-D conversion start flag is "1" and the						
	ADTRG/P97 input changes from "H" to "L"						
Conversion speed per pin	Without sample and hold function						
	8-bit resolution: 49 φAD cycles, 10-bit resolution: 59 φAD cycles						
	With sample and hold function						
	8-bit resolution: 28 φAD cycles, 10-bit resolution: 33 φAD cycles						

Note 1: Does not depend on use of sample and hold function.

Note 2: Without sample and hold function, set the φAD frequency to 250kHz min. With the sample and hold function, set the φAD frequency to 1MHz min.



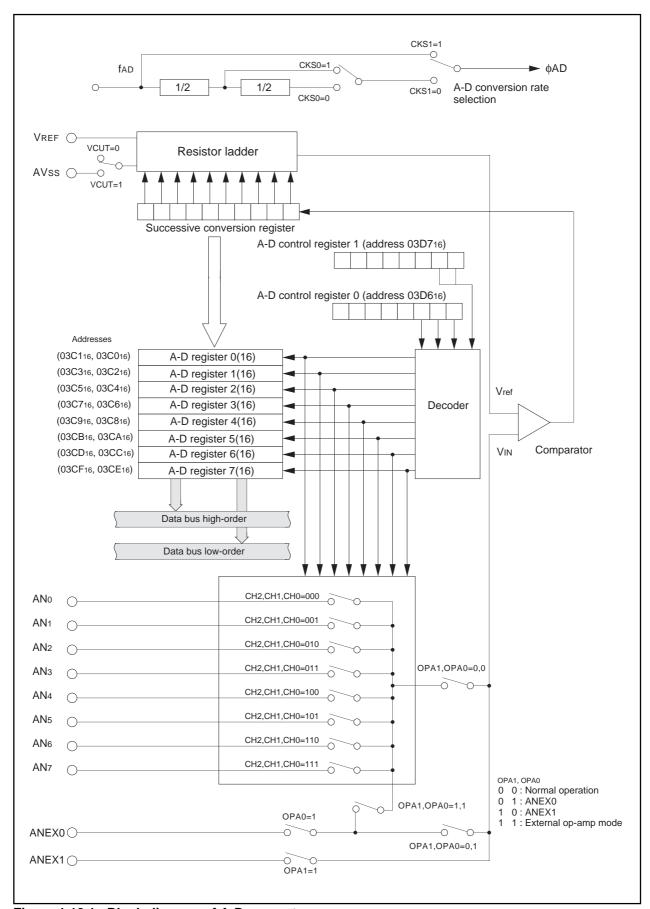


Figure 1.18.1. Block diagram of A-D converter



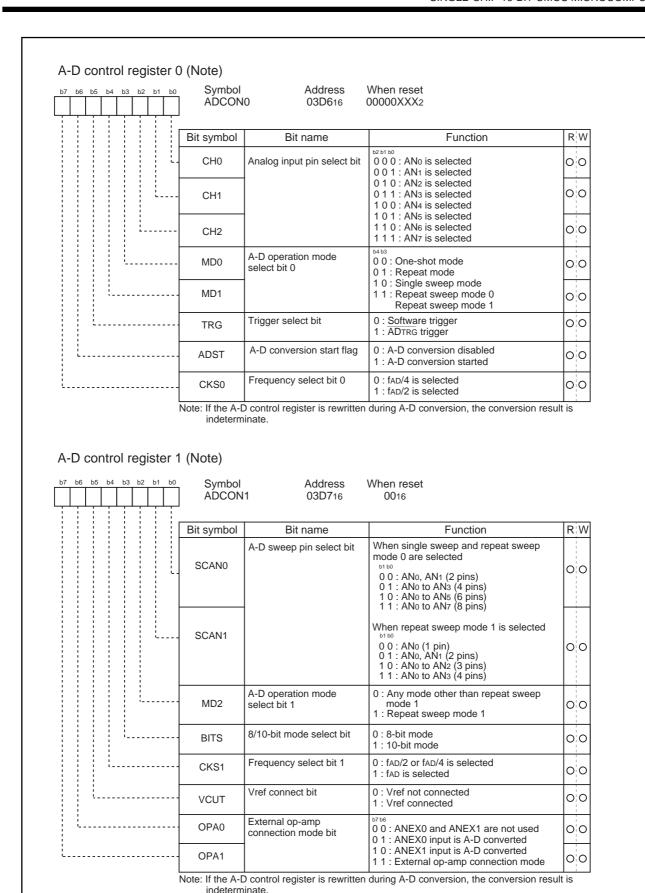


Figure 1.18.2. A-D converter-related registers (1)



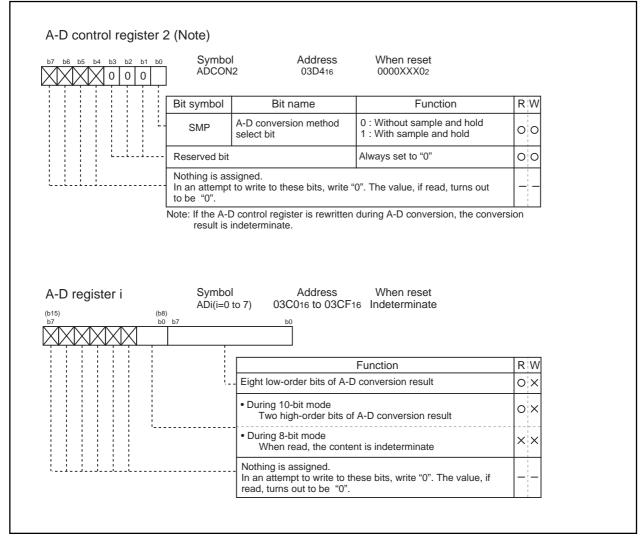


Figure 1.18.3. A-D converter-related registers (2)

### (1) One-shot mode

In one-shot mode, the pin selected using the analog input pin select bit is used for one-shot A-D conversion. Table 1.18.2 shows the specifications of one-shot mode. Figure 1.18.4 shows the A-D control register in one-shot mode.

Table 1.18.2. One-shot mode specifications

Item	Specification					
Function	ne pin selected by the analog input pin select bit is used for one A-D conversion					
Start condition	riting "1" to A-D conversion start flag					
Stop condition	• End of A-D conversion (A-D conversion start flag changes to "0", except					
	when external trigger is selected)					
	Writing "0" to A-D conversion start flag					
Interrupt request generation timing	End of A-D conversion					
Input pin	One of ANo to AN7, as selected					
Reading of result of A-D converter	Read A-D register corresponding to selected pin					

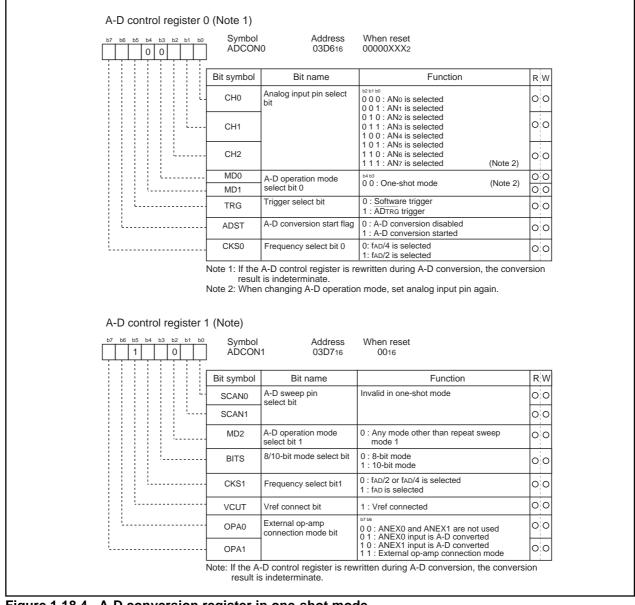


Figure 1.18.4. A-D conversion register in one-shot mode



### (2) Repeat mode

In repeat mode, the pin selected using the analog input pin select bit is used for repeated A-D conversion. Table 1.18.3 shows the specifications of repeat mode. Figure 1.18.5 shows the A-D control register in repeat mode.

Table 1.18.3. Repeat mode specifications

Item	Specification			
Function	The pin selected by the analog input pin select bit is used for repeated A-D conversion			
Star condition	Writing "1" to A-D conversion start flag			
Stop condition	Writing "0" to A-D conversion start flag			
Interrupt request generation timing	None generated			
Input pin	One of ANo to AN7, as selected			
Reading of result of A-D converter	Read A-D register corresponding to selected pin			

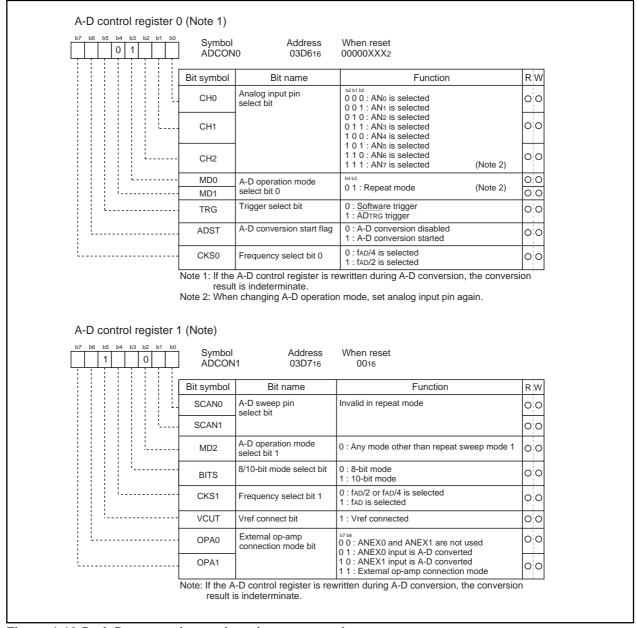


Figure 1.18.5. A-D conversion register in repeat mode



## (3) Single sweep mode

In single sweep mode, the pins selected using the A-D sweep pin select bit are used for one-by-one A-D conversion. Table 1.18.4 shows the specifications of single sweep mode. Figure 1.18.6 shows the A-D control register in single sweep mode.

Table 1.18.4. Single sweep mode specifications

Item	Specification					
Function	ne pins selected by the A-D sweep pin select bit are used for one-by-one A-D conversion					
Start condition	riting "1" to A-D converter start flag					
Stop condition	• End of A-D conversion (A-D conversion start flag changes to "0", except					
	when external trigger is selected)					
	Writing "0" to A-D conversion start flag					
Interrupt request generation timing	End of A-D conversion					
Input pin	ANo and AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins), or ANo to AN7 (8 pins)					
Reading of result of A-D converter	Read A-D register corresponding to selected pin					

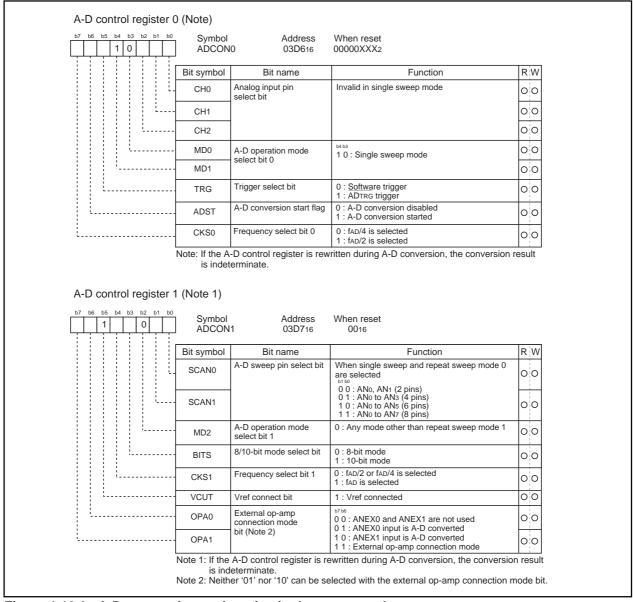


Figure 1.18.6. A-D conversion register in single sweep mode



### (4) Repeat sweep mode 0

In repeat sweep mode 0, the pins selected using the A-D sweep pin select bit are used for repeat sweep A-D conversion. Table 1.18.5 shows the specifications of repeat sweep mode 0. Figure 1.18.7 shows the A-D control register in repeat sweep mode 0.

Table 1.18.5. Repeat sweep mode 0 specifications

Item	Specification
Function	The pins selected by the A-D sweep pin select bit are used for repeat sweep A-D conversion
Start condition	Writing "1" to A-D conversion start flag
Stop condition	Writing "0" to A-D conversion start flag
Interrupt request generation timing	None generated
Input pin	ANo and AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins), or ANo to AN7 (8 pins)
Reading of result of A-D converter	Read A-D register corresponding to selected pin (at any time)

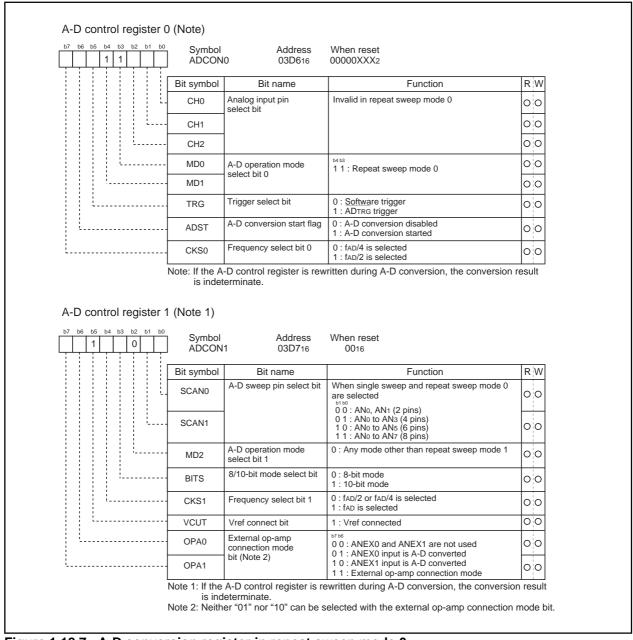


Figure 1.18.7. A-D conversion register in repeat sweep mode 0



## (5) Repeat sweep mode 1

In repeat sweep mode 1, all pins are used for A-D conversion with emphasis on the pin or pins selected using the A-D sweep pin select bit. Table 1.18.6 shows the specifications of repeat sweep mode 1. Figure 1.18.8 shows the A-D control register in repeat sweep mode 1.

Table 1.18.6. Repeat sweep mode 1 specifications

Item	Specification						
Function	All pins perform repeat sweep A-D conversion, with emphasis on the pin or						
	s selected by the A-D sweep pin select bit						
	xample : ANo selected ANo → AN1 → ANo → AN2 → ANo → AN3, etc						
Start condition	Writing "1" to A-D conversion start flag						
Stop condition	Writing "0" to A-D conversion start flag						
Interrupt request generation timing	None generated						
Input pin	ANo (1 pin), ANo and AN1 (2 pins), ANo to AN2 (3 pins), ANo to AN3 (4 pins)						
Reading of result of A-D converter	Read A-D register corresponding to selected pin (at any time)						

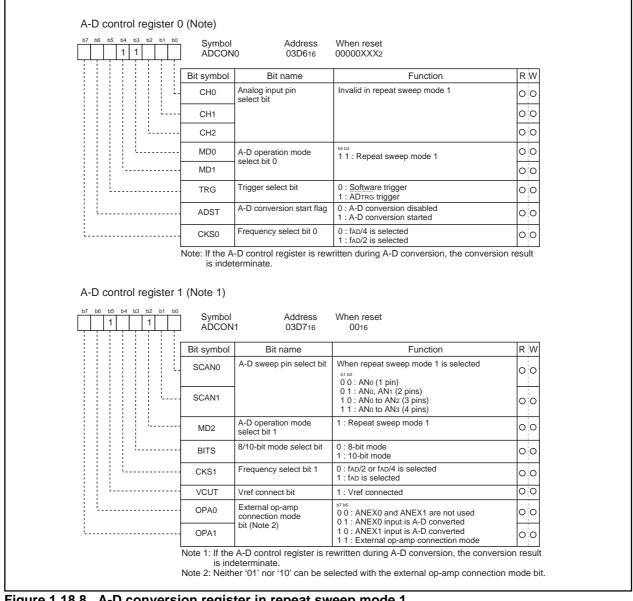


Figure 1.18.8. A-D conversion register in repeat sweep mode 1



#### (a) Sample and hold

Sample and hold is selected by setting bit 0 of the A-D control register 2 (address 03D416) to "1". When sample and hold is selected, the rate of conversion of each pin increases. As a result, a 28 \$\phiAD\$ cycle is achieved with 8-bit resolution and 33 \$\phiAD\$ with 10-bit resolution. Sample and hold can be selected in all modes. However, in all modes, be sure to specify before starting A-D conversion whether sample and hold is to be used.

# (b) Extended analog input pins

In one-shot mode and repeat mode, the input via the extended analog input pins ANEX0 and ANEX1 can also be converted from analog to digital.

When bit 6 of the A-D control register 1 (address 03D716) is "1" and bit 7 is "0", input via ANEX0 is converted from analog to digital. The result of conversion is stored in A-D register 0.

When bit 6 of the A-D control register 1 (address 03D716) is "0" and bit 7 is "1", input via ANEX1 is converted from analog to digital. The result of conversion is stored in A-D register 1.

## (c) External operation amp connection mode

In this mode, multiple external analog inputs via the extended analog input pins, ANEX0 and ANEX1, can be amplified together by just one operation amp and used as the input for A-D conversion.

When bit 6 of the A-D control register 1 (address 03D716) is "1" and bit 7 is "1", input via ANo to AN7 is output from ANEX0. The input from ANEX1 is converted from analog to digital and the result stored in the corresponding A-D register. The speed of A-D conversion depends on the response of the external operation amp. Do not connect the ANEX0 and ANEX1 pins directly. Figure 1.18.9 is an example of how to connect the pins in external operation amp mode.

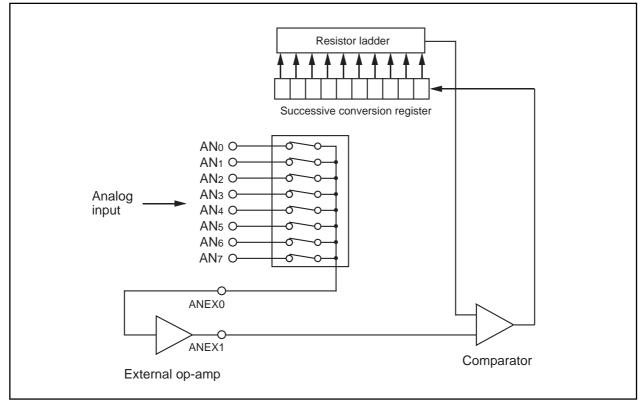


Figure 1.18.9. Example of external op-amp connection mode



#### **D-A Converter**

This is an 8-bit, R-2R type D-A converter. The microcomputer contains two independent D-A converters of this type.

D-A conversion is performed when a value is written to the corresponding D-A register. Bits 0 and 1 (D-A output enable bits) of the D-A control register decide if the result of conversion is to be output. Do not set the target port to output mode if D-A conversion is to be performed.

Output analog voltage (V) is determined by a set value (n : decimal) in the D-A register.

V = VREF X n / 256 (n = 0 to 255)

VREF: reference voltage

Table 1.19.1 lists the performance of the D-A converter. Figure 1.19.1 shows the block diagram of the D-A converter. Figure 1.19.2 shows the D-A converter equivalent circuit.

Table 1.19.1. Performance of D-A converter

Item	Performance		
Conversion method	R-2R method		
Resolution	8 bits		
Analog output pin	2 channels		

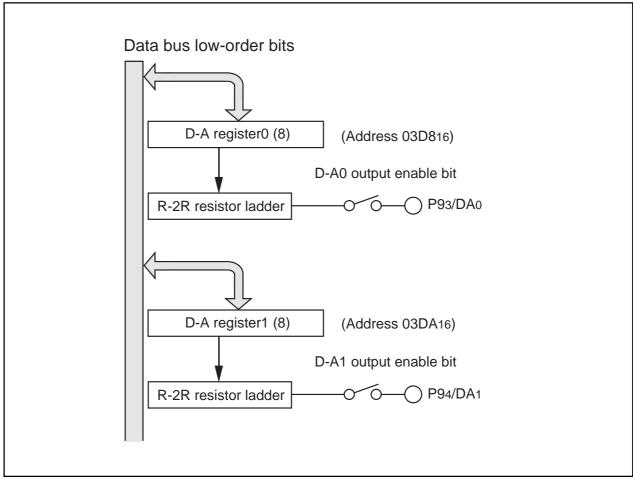


Figure 1.19.1. Block diagram of D-A converter

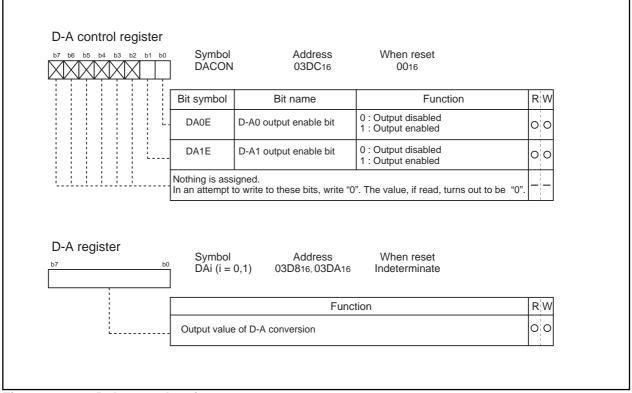


Figure 1.19.2. D-A control register

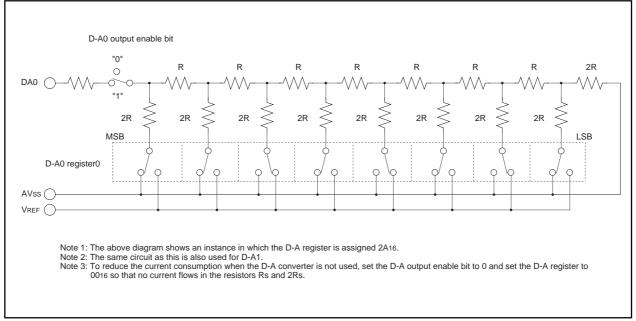


Figure 1.19.3. D-A converter equivalent circuit

#### **CRC Calculation Circuit**

The Cyclic Redundancy Check (CRC) calculation circuit detects an error in data blocks. The microcomputer uses a generator polynomial of CRC\_CCITT ( $X^{16} + X^{12} + X^5 + 1$ ) to generate CRC code.

The CRC code is a 16-bit code generated for a block of a given data length in multiples of 8 bits. The CRC code is set in a CRC data register each time one byte of data is transferred to a CRC input register after writing an initial value into the CRC data register. Generation of CRC code for one byte of data is completed in two machine cycles.

Figure 1.20.1 shows the block diagram of the CRC circuit. Figure 1.20.2 shows the CRC-related registers. Figure 1.20.3 shows the calculation example using the CRC calculation circuit

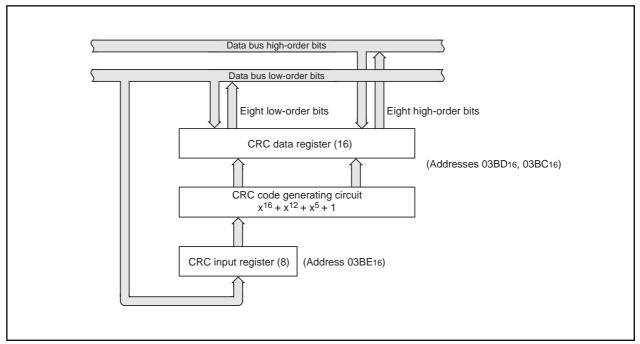


Figure 1.20.1. Block diagram of CRC circuit

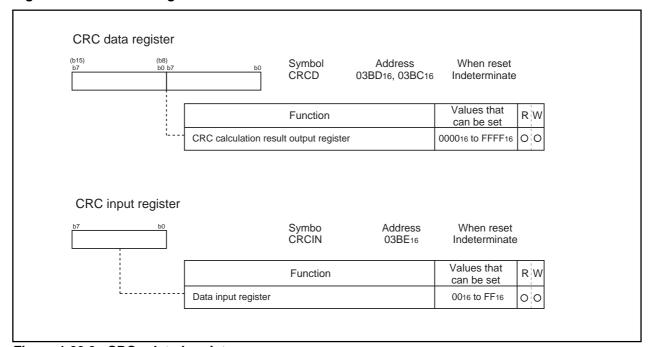


Figure 1.20.2. CRC-related registers



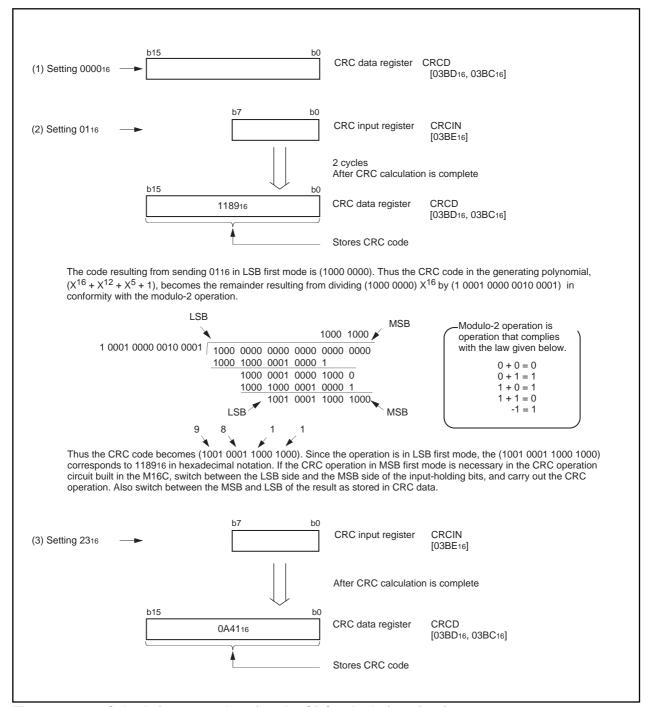


Figure 1.20.3. Calculation example using the CRC calculation circuit

## Programmable I/O Ports

There are 87 programmable I/O ports: P0 to P10 (excluding P85). Each port can be set independently for input or output using the direction register. A pull-up resistance for each block of 4 ports can be set. P85 is an input-only port and has no built-in pull-up resistance.

Figures 1.21.1 to 1.21.4 show the programmable I/O ports. Figure 1.21.5 shows the I/O pins.

Each pin functions as a programmable I/O port and as the I/O for the built-in peripheral devices.

To use the pins as the inputs for the built-in peripheral devices, set the direction register of each pin to input mode. When the pins are used as the outputs for the built-in peripheral devices (other than the D-A converter), they function as outputs regardless of the contents of the direction registers. When pins are to be used as the outputs for the D-A converter, do not set the direction registers to output mode. See the descriptions of the respective functions for how to set up the built-in peripheral devices.

## (1) Direction registers

Figure 1.21.6 shows the direction registers.

These registers are used to choose the direction of the programmable I/O ports. Each bit in these registers corresponds one for one to each I/O pin.

Note: There is no direction register bit for P85.

## (2) Port registers

Figure 1.21.7 shows the port registers.

These registers are used to write and read data for input and output to and from an external device. A port register consists of a port latch to hold output data and a circuit to read the status of a pin. Each bit in port registers corresponds one for one to each I/O pin.

### (3) Pull-up control registers

Figure 1.21.8 shows the pull-up control registers.

The pull-up control register can be set to apply a pull-up resistance to each block of 4 ports. When ports are set to have a pull-up resistance, the pull-up resistance is connected only when the direction register is set for input.

However, in memory expansion mode and microprocessor mode, the pull-up control register of P0 to P5 is invalid.



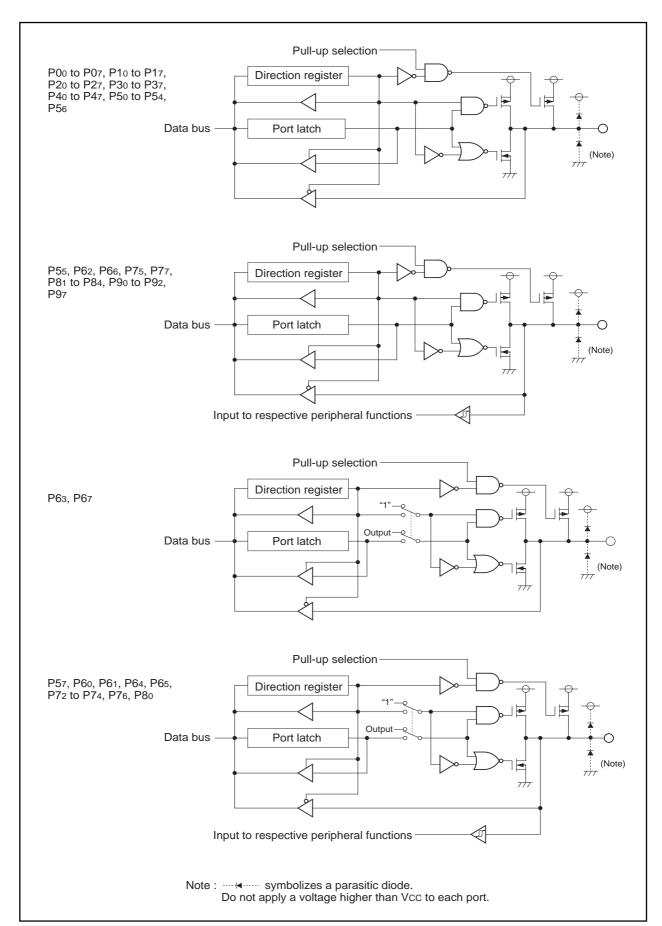


Figure 1.21.1. Programmable I/O ports (1)



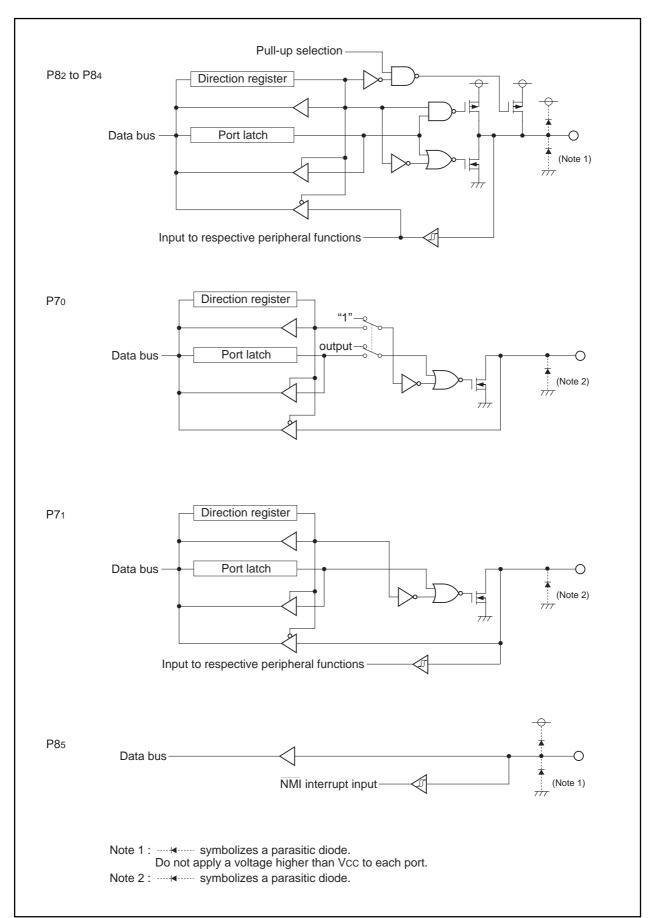


Figure 1.21.2. Programmable I/O ports (2)



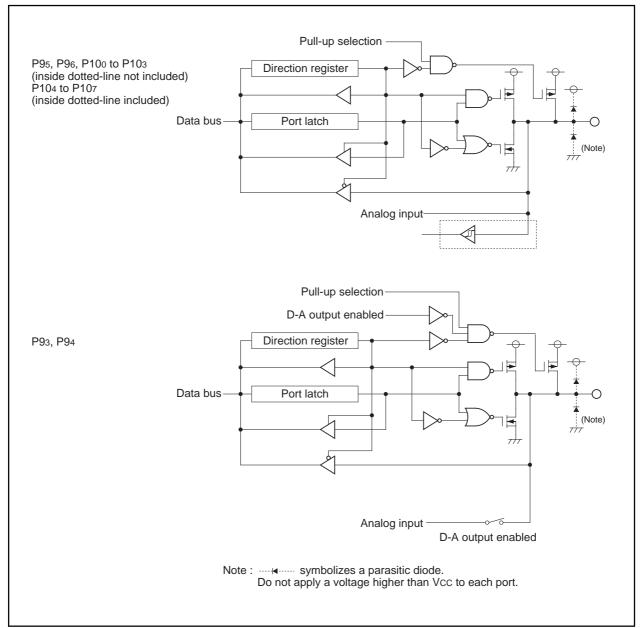


Figure 1.21.3. Programmable I/O ports (3)

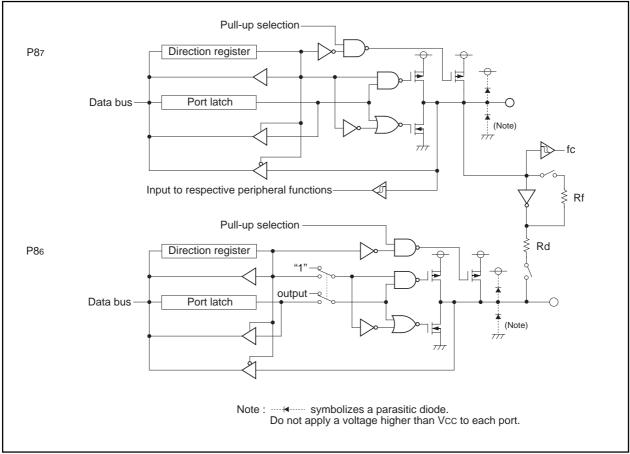


Figure 1.21.4. Programmable I/O ports (4)

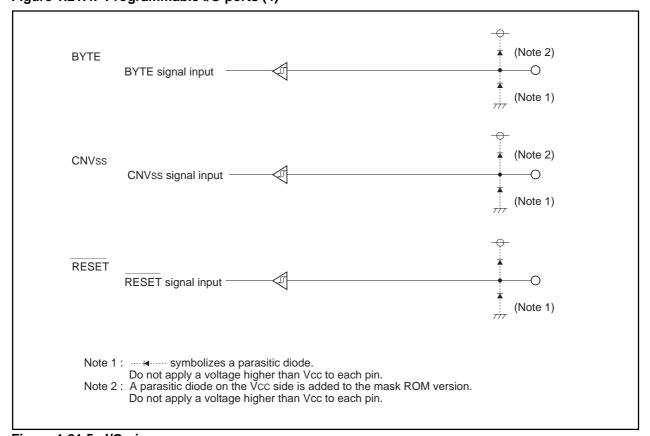


Figure 1.21.5. I/O pins

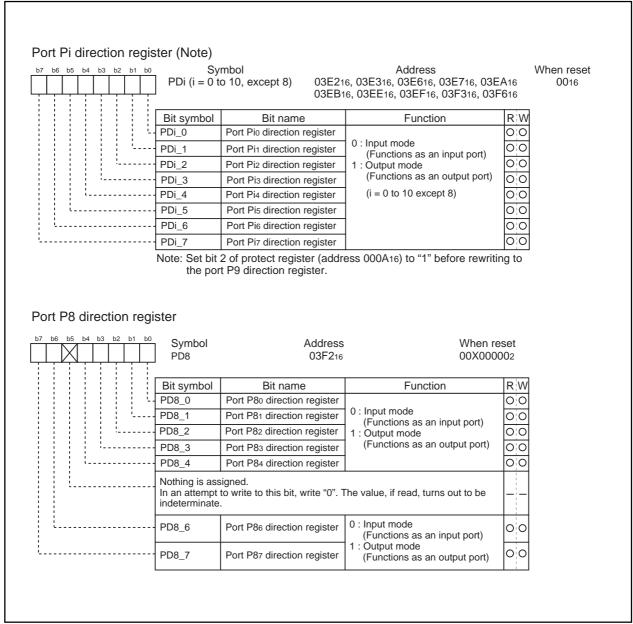


Figure 1.21.6. Direction register

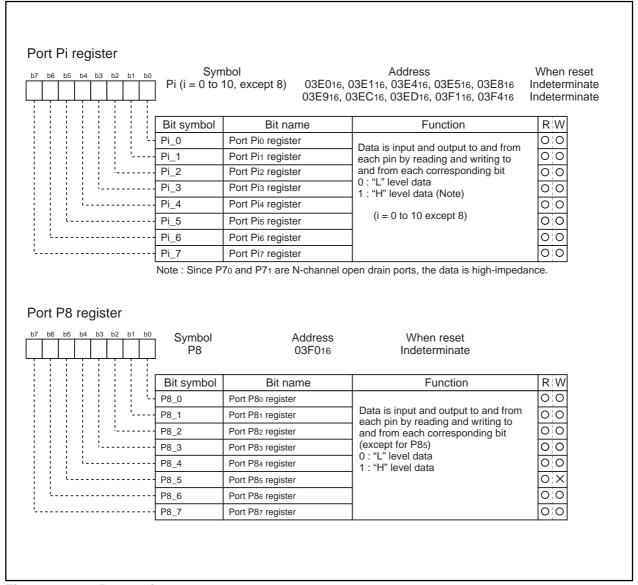


Figure 1.21.7. Port register

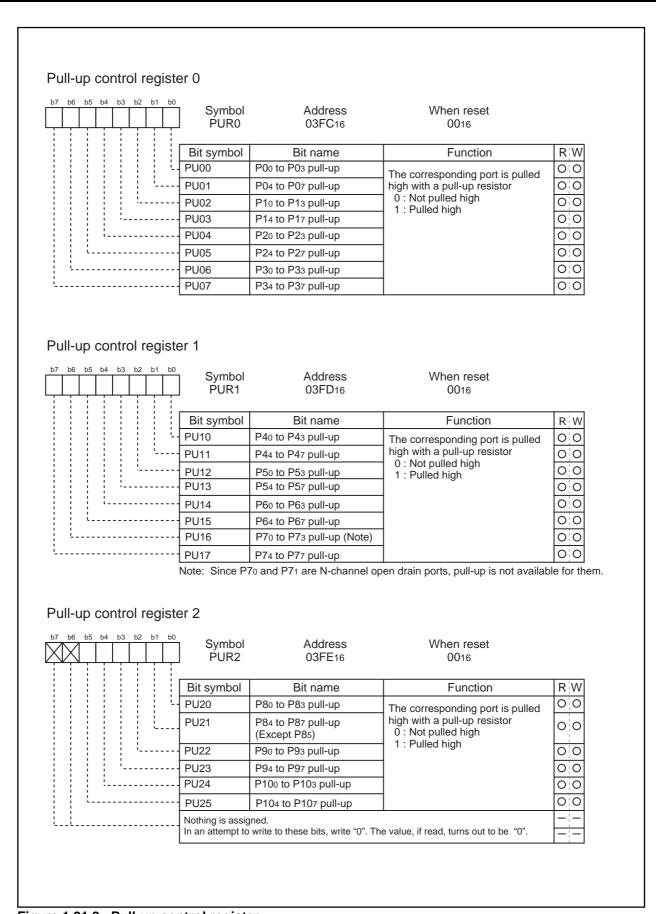


Figure 1.21.8. Pull-up control register

Table 1.21.1. Example connection of unused pins in single-chip mode

Pin name	Connection
Ports P0 to P10 (excluding P85)	After setting for input mode, connect every pin to Vss via a resistor; or after setting for output mode, leave these pins open.
XOUT (Note)	Open
NMI	Connect via resistor to Vcc (pull-up)
AVCC	Connect to VCC
AVSS, VREF, BYTE	Connect to Vss
CNVss	Connect via resistor to Vss (pull-down)

Note: With external clock input to XIN pin.

Table 1.21.2. Example connection of unused pins in memory expansion mode and microprocessor mode

Pin name	Connection
Ports P6 to P10 (excluding P85)	After setting for input mode, connect every pin to Vss or Vcc via a resistor; or after setting for output mode, leave these pins open.
BHE, ALE, HLDA, XOUT(Note), BCLK	Open
HOLD, RDY, NMI	Connect via resistor to Vcc (pull-up)
AVcc	Connect to Vcc
AVSS, VREF	Connect to Vss
CNVss	Connect via resistor to Vss (pull-down) in the memory expansion mode Connect via resistor to Vcc (pull-up) in the microprocessor mode

Note: With external clock input to XIN pin.

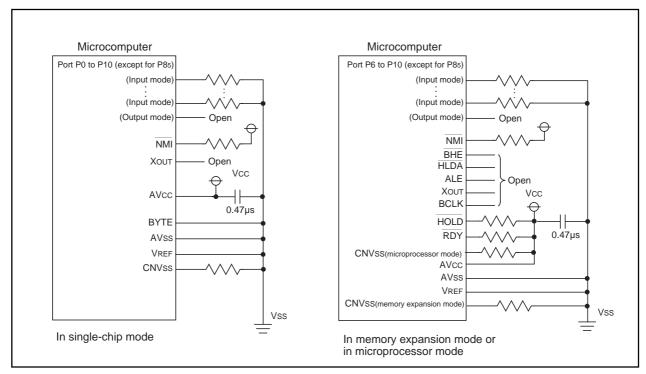


Figure 1.21.9. Example connection of unused pins



## **Usage Precaution**

## Timer A (timer mode)

(1) Reading the timer Ai register while a count is in progress allows reading, with arbitrary timing, the value of the counter. Reading the timer Ai register with the reload timing gets "FFF16". Reading the timer Ai register after setting a value in the timer Ai register with a count halted but before the counter starts counting gets a proper value.

## Timer A (event counter mode)

- (1) Reading the timer Ai register while a count is in progress allows reading, with arbitrary timing, the value of the counter. Reading the timer Ai register with the reload timing gets "FFF16" by underflow or "000016" by overflow. Reading the timer Ai register after setting a value in the timer Ai register with a count halted but before the counter starts counting gets a proper value.
- (2) When stop counting in free run type, set timer again.

## Timer A (one-shot timer mode)

- (1) Setting the count start flag to "0" while a count is in progress causes as follows:
  - The counter stops counting and a content of reload register is reloaded.
  - The TAiout pin outputs "L" level.
  - The interrupt request generated and the timer Ai interrupt request bit goes to "1".
- (2) The timer Ai interrupt request bit goes to "1" if the timer's operation mode is set using any of the following procedures:
  - Selecting one-shot timer mode after reset.
  - Changing operation mode from timer mode to one-shot timer mode.
  - Changing operation mode from event counter mode to one-shot timer mode.

Therefore, to use timer Ai interrupt (interrupt request bit), set timer Ai interrupt request bit to "0" after the above listed changes have been made.

### Timer A (pulse width modulation mode)

- (1) The timer Ai interrupt request bit becomes "1" if setting operation mode of the timer in compliance with any of the following procedures:
  - Selecting PWM mode after reset.
  - Changing operation mode from timer mode to PWM mode.
  - Changing operation mode from event counter mode to PWM mode.

Therefore, to use timer Ai interrupt (interrupt request bit), set timer Ai interrupt request bit to "0" after the above listed changes have been made.

(2) Setting the count start flag to "0" while PWM pulses are being output causes the counter to stop counting. If the TAiout pin is outputting an "H" level in this instance, the output level goes to "L", and the timer Ai interrupt request bit goes to "1". If the TAiout pin is outputting an "L" level in this instance, the level does not change, and the timer Ai interrupt request bit does not becomes "1".

### Timer B (timer mode, event counter mode)

(1) Reading the timer Bi register while a count is in progress allows reading, with arbitrary timing, the value of the counter. Reading the timer Bi register with the reload timing gets "FFFF16". Reading the timer Bi register after setting a value in the timer Bi register with a count halted but before the counter starts counting gets a proper value.



## Timer B (pulse period/pulse width measurement mode)

- (1) If changing the measurement mode select bit is set after a count is started, the timer Bi interrupt request bit goes to "1".
- (2) When the first effective edge is input after a count is started, an indeterminate value is transferred to the reload register. At this time, timer Bi interrupt request is not generated.

#### **A-D Converter**

- (1) Write to each bit (except bit 6) of A-D control register 0, to each bit of A-D control register 1, and to bit 0 of A-D control register 2 when A-D conversion is stopped (before a trigger occurs). In particular, when the Vref connection bit is changed from "0" to "1", start A-D conversion after an
- (2) When changing A-D operation mode, select analog input pin again.
- (3) Using one-shot mode or single sweep mode

  Read the correspondence A-D register after confirming A-D conversion is finished. (It is known by A-D conversion interrupt request bit.)
- (4) Using repeat mode, repeat sweep mode 0 or repeat sweep mode 1 Use the undivided main clock as the internal CPU clock.

## **Stop Mode and Wait Mode**

elapse of 1 µs or longer.

- (1) When returning from stop mode by hardware reset, RESET pin must be set to "L" level until main clock oscillation is stabilized.
- (2) When switching to either wait mode or stop mode, instructions occupying four bytes either from the WAIT instruction or from the instruction that sets the every-clock stop bit to "1" within the instruction queue are prefetched and then the program stops. So put at least four NOPs in succession either to the WAIT instruction or to the instruction that sets the every-clock stop bit to 1.

## Interrupts

- (1) Reading address 0000016
  - When maskable interrupt is occurred, CPU read the interrupt information (the interrupt number and interrupt request level) in the interrupt sequence.
    - The interrupt request bit of the certain interrupt written in address 0000016 will then be set to "0". Reading address 0000016 by software sets enabled highest priority interrupt source request bit to "0". Though the interrupt is generated, the interrupt routine may not be executed.
    - Though the interrupt is generated, the interrupt routine may not be t
  - Do not read address 0000016 by software.
- (2) Setting the stack pointer
  - The value of the stack pointer immediately after reset is initialized to 000016. Accepting an interrupt before setting a value in the stack pointer may become a factor of runaway. Be sure to set a value in the stack pointer before accepting an interrupt.
    - When using the NMI interrupt, initialize the stack point at the beginning of a program. Concerning the first instruction immediately after reset, generating any interrupts including the NMI interrupt is prohibited.



#### (3) The NMI interrupt

- As for the NMI interrupt pin, an interrupt cannot be disabled. Connect it to the Vcc pin via a resistor (pull-up) if unused. Be sure to work on it.
- Do not get either into stop mode or into wait mode with the NMI pin set to "L".

#### (4) External interrupt

• When the polarity of the INTo to INTo pins is changed, the interrupt request bit is sometimes set to "1". After changing the polarity, set the interrupt request bit to "0".

#### (5) Rewrite the interrupt control register

• To rewrite the interrupt control register, do so at a point that does not generate the interrupt request for that register. If there is possibility of the interrupt request occur, rewrite the interrupt control register after the interrupt is disabled. The program examples are described as follow:

### Example 1:

```
INT_SWITCH1:
```

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

NOP ; Four NOP instructions are required when using HOLD function.

NOP

FSET I ; Enable interrupts.

#### Example 2:

```
INT_SWITCH2:
```

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

MOV.W MEM, RO ; Dummy read. FSET I ; Enable interrupts.

### Example 3:

INT\_SWITCH3:

PUSHC FLG ; Push Flag register onto stack

FCLR I ; Disable interrupts.

AND.B #00h, 0055h; Clear TA0IC int. priority level and int. request bit.

POPC FLG ; Enable interrupts.

The reason why two NOP instructions (four when using the HOLD function) or dummy read are inserted before FSET I in Examples 1 and 2 is to prevent the interrupt enable flag I from being set before the interrupt control register is rewritten due to effects of the instruction queue.

 When a instruction to rewrite the interrupt control register is executed but the interrupt is disabled, the interrupt request bit is not set sometimes even if the interrupt request for that register has been generated. This will depend on the instruction. If this creates problems, use the below instructions to change the register.

Instructions: AND, OR, BCLR, BSET



#### **External ROM version**

The external ROM version is operated only in microprocessor mode, so be sure to perform the following:

- Connect CNVss pin to Vcc.
- Fix the processor mode bit to "112"

#### **Built-in PROM version**

#### (1) All built-in PROM versions

High voltage is required to program to the built-in PROM. Be careful not to apply excessive voltage. Be especially careful during power-on.

#### (2) One Time PROM version

One Time PROM versions shipped in blank (M30612E4FP, M30612E4GP, M30610ECFP, M30610ECGP), of which built-in PROMs are programmed by users, are also provided. For these microcomputers, a programming test and screening are not performed in the assembly process and the following processes. Therefore ROM write defectiveness occurs around 5 %. To improve their reliability after programming, we recommend to program and test as flow shown in Figure 1.22.1 before use.

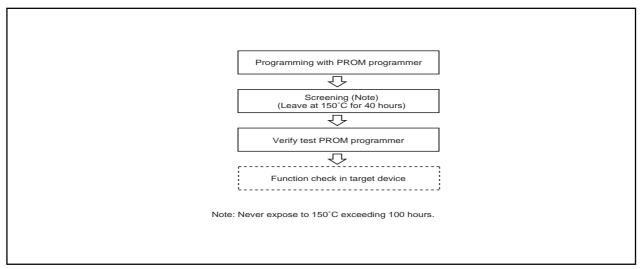


Figure 1.22.1. Programming and test flow for One Time PROM version

#### (3) EPROM version

- Cover the transparent glass window with a shield or others during the read mode because exposing to sun light or fluorescent lamp can cause erasing the information.
  - A shield to cover the transparent window is available from Mitsubishi Electric Corp. Be careful that the shield does not touch the EPROM lead pins.
- Clean the transparent glass before erasing. Fingers' flat and paste disturb the passage of ultraviolet rays and may affect badly the erasure capability.
- The EPROM version is a tool only for program development (for evaluation), and do not use it for the mass product run.



# Items to be submitted when ordering masked ROM version

Please submit the following when ordering masked ROM products:

- (1) Mask ROM confirmation form
- (2) Mark specification sheet
- (3) ROM data: EPROMs or floppy disks
- \*: In the case of EPROMs, there sets of EPROMs are required per pattern.
- \*: In the case of floppy disks, 3.5-inch double-sided high-density disk (IBM format) is required per pattern.



Table 1.24.1. Absolute maximum ratings

Symbol	Parameter		Condition	Rated value		Unit
Vcc	Supply voltage		Vcc = AVcc	-0.3 to 6.5 (Note 3)		V
AVcc	Analog supply v	roltage	Vcc = AVcc	-0.3 to 6.5 (Note 3)		V
Vı	Input voltage	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P72 to P77, P80 to P87, P90 to P97, P100 to P107, RESET, VREF, XIN		-0.3 to Vcc+0.3		V
Vı	Input voltage P70, P71, CNVss, BYTE			-0.3 to 6.5 (No	V	
Vo	Output voltage	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P72 to P77, P80 to P84, P86,P87, P90 to P97, P100 to P107, XOUT		-0.3 to Vcc+0.3		V
Vo	Output voltage	P70, P71		-0.3 to 6.5	(Note 3)	V
Pd	Power dissipation	on	Ta=25 °C	300		mW
Topr	Operating ambi	ent temperature		-20 to 85 / -40 to 89	5 (Note 2)	°C
Tstg	Storage tempera	ature		-65 to 150		°C

Note 1: When writing to EPROM , only CNVss is -0.3 to 13 (V) .

Note 2: Specify a product of -40 to 85°C to use it.

Note 3: -0.3V to 6.5V for M30610M8A, M30610MAA, M30610MCA, M30612M4A, M30612M8A, M30612MAA, M30612MCA, M30610SA and M30612SA.

Otherwise, -0.3V to 7.0V is used.



Table 1.24.2. Recommended operating conditions (referenced to Vcc = 2.7V to 5.5V at Ta = -20 to 85°C / -40 to 85°C (Note 3) unless otherwise specified)

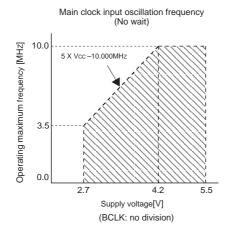
	Parameter			Standard				
Symbol				Min	Тур.	Max.	Unit	
Vcc	Supply voltage				2.7	5.0	5.5	V
AVcc	Analog supply volta	alog supply voltage				Vcc		V
Vss	Supply voltage					0		V
AVss	Analog supply volta	ge				0		V
VIH	HIGH input voltage	P72 to P77,	7, P40 to P47, P50 to P57, P60 to P67, 7, P80 to P87, P90 to P97, P100 to P107, ET, CNVss, BYTE		0.8Vcc		Vcc	V
		P70, P71			0.8Vcc		6.5	V
			P10 to P17, P2 le-chip mode)	20 to P27, P30	0.8Vcc		Vcc	V
		(data input f	P10 to P17, P2 function during rocessor mode	memory expansion	0.5Vcc		Vcc	V
V <sub>IL</sub> LOW input voltage	LOW input voltage	P31 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P107, X IN, RESET, CNVss, BYTE			0		0.2Vcc	V
		P00 to P07, P10 to P17, P20 to P27, P30 (during single-chip mode)					0.2Vcc	V
		(data input		P10 to P17, P20 to P27, P30 unction during memory expansion rocessor modes)			0.16Vcc	V
I <sub>OH</sub> (peak)	HIGH peak output current	P00 to P07, P10 to P17, P20 to P27,P30 to P37, P40 to P47, P50 to P57, P60 to P67,P72 to P77, P80 to P84,P86,P87,P90 to P97,P100 to P107					-10.0	mA
I <sub>OH</sub> (avg)	HIGH average output current	P00 to P07, P10 to P17, P20 to P27,P30 to P37, P40 to P47, P50 to P57, P60 to P67,P72 to P77, P80 to P84,P86,P87,P90 to P97,P100 to P107					-5.0	mA
I <sub>OL</sub> (peak)	LOW peak output current	P00 to P07, P10 to P17, P20 to P27,P30 to P37, P40 to P47, P50 to P57, P60 to P67,P70 to P77, P80 to P84,P86,P87,P90 to P97,P100 to P107					10.0	mA
I <sub>OL (avg)</sub>	LOW average output current	P00 to P07, P10 to P17, P20 to P27,P30 to P37, P40 to P47, P50 to P57, P60 to P67,P70 to P77, P80 to P84,P86,P87,P90 to P97,P100 to P107					5.0	mA
f (XIN)	Main clock input osc	cillation	No wait	Vcc =4.0V to 5.5V	0		10	MHz
` /   10	frequency			Vcc =2.7V to 4.0V	0		5 X Vcc -10.000	MHz
				Vcc =4.0V to 5.5V	0		10	MHz
			With wait	Vcc =2.7V to 4.0V	0		2.31 X Vcc +0.760	MHz
f (Xcin)	Subclock oscillation	frequency		•		32.768	50	kHz

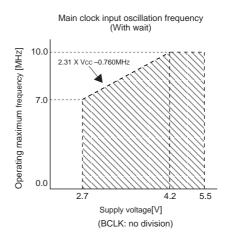
Note 1: The mean output current is the mean value within 100ms.

Note 2: The total IoL (peak) for ports P0, P1, P2, P86, P87, P9, and P10 must be 80mA max. The total IoH (peak) for ports P0, P1, P2, P86, P87, P9, and P10 must be 80mA max. The total IoL (peak) for ports P3, P4, P5, P6, P7, and P80 to P84 must be 80mA max. The total IoH (peak) for ports P3, P4, P5, P6, P72 to P77, and P80 to P84 must be 80mA max.

Note 3: Specify a product of -40 to 85°C to use it.

Note 4: The relationship between main clock input frequency and power supply voltage is as below.







Vcc = 5V

Table 1.24.3. Electrical characteristics (referenced to VCC = 5V, VSS = 0V at  $Ta = 25^{\circ}C$ , f(XIN) = 10MHz unless otherwise specified)

Symbol	Parameter			Measuring condition		Standard			Unit
Зуппоог		i aiailicici		ivieas	uring condition	Min	Тур.	Max.	Offic
Vон	HIGH output voltage	P00 to P07, P10 to F P30 to P37, P40 to F P60 to P67, P72 to F P86, P87, P90 to P9	P47, P50 to P57, P77, P80 to P84,	Іон=-5mА		3.0			V
Vон	HIGH output voltage	P00 to P07, P10 to F P30 to P37, P40 to F P60 to P67, P72 to F P86, P87, P90 to P9	P47, P50 to P57, P77, P80 to P84,	Іон=-200µА		4.7			V
	HIGH output	Хоит	HIGHPOWER	Iон=-1mA		3.0			V
Vон	voltage		LOWPOWER	Iон=-0.5mA		3.0			
	HIGH output voltage	Хсоит	HIGHPOWER LOWPOWER	With no load			3.0 1.6		V
VoL	LOW output voltage	P00 to P07, P10 to P P30 to P37, P40 to P P60 to P67, P70 to P P86, P87, P90 to P97	17, P20 to P27, 47, P50 to P57, 77, P80 to P84,	With no load	арриец		1.0	2.0	V
VoL	voltage	P00 to P07, P10 to P <sup>2</sup> P30 to P37, P40 to P <sup>4</sup> P60 to P67, P70 to P7 P86, P87, P90 to P97	17, P50 to P57, 77, P80 to P84,	IoL=200μA				0.45	V
	LOW output	Хоит	HIGHPOWER	IoL=1mA				2.0	V
Vol	voltage		LOWPOWER	IoL=0.5mA				2.0	
VOL	LOW output	Хсоит	HIGHPOWER	With no load	applied		0		V
	voltage	LIOUR RRY TAG	LOWPOWER	With no load	applied		0		
VT+-VT-	Hysteresis	HOLD, RDY, TAC TB0in to TB2in, II ADTRG, CTS0 to C CLK2,TA2out to	NTo to INT2, cts2, CL <u>Ko to</u>			0.2		0.8	V
		KIo to KI3, RxDo t	o RxD2						
VT+-VT-	Hysteresis	RESET				0.2		1.8	V
lıн	HIGH input current	P00 to P07, P10 to P P30 to P37, P40 to P P60 to P67, P70 to P P90 to P97, P100 to XIN, RESET, CNVss	47, P50 to P57, 77, P80 to P87, P107,	Vi=5V				5.0	μΑ
I <sub>IL</sub>	LOW input current	P00 to P07, P10 to P P30 to P37, P40 to P P60 to P67, P70 to P P90 to P97, P100 to XIN, RESET, CNVss	47, P50 to P57, 77, P80 to P87, P107,	Vi=0V				-5.0	μA
R <sub>PULLUP</sub>	Pull-up resistance	P00 to P07, P10 to P P30 to P37, P40 to P P60 to P67, P72 to P P86, P87, P90 to P93	47, P50 to P57, 77, P80 to P84,	Vi=0V		30.0	50.0	167.0	kΩ
R <sub>fXIN</sub>	Feedback re	sistance XIN					1.0		ΜΩ
R <sub>fXCIN</sub>	Feedback re	sistance Xcin					6.0		МΩ
V <sub>RAM</sub>	RAM retention	on voltage		When clock is	stopped	2.0			V
				In single-chip mode, the	f(XIN)=10MHz Square wave, no division		19.0	38.0	mA
				output pins	f(Xcin)=32kHz Square wave		90.0		μA
Icc	Power supply	y current		are open and other pins are Vss	f(XCIN)=32kHz When a WAIT instruction is executed(Note)		4.0		μA
					Ta=25°C when clock is stopped			1.0	μA
					Ta=85°C when clock is stopped			20.0	Per -

Note: With one timer operated using fc32.



Vcc = 5V

Table 1.24.4. A-D conversion characteristics (referenced to VCC = AVCC = VREF = 5V, VSS = AVSS = 0V at  $Ta = 25^{\circ}C$ , f(XIN) = 10MHz unless otherwise specified)

	Parameter Measuring condition					Standard		
Symbol			Min.	Тур.	Max.	Unit		
_	Resoluti	on	VREF = VC	С			10	Bits
_	Absolute	Sample & hold function not available	VREF = VCC	c = 5V			±3	LSB
	accuracy			ANo to AN7 input			±3	LSB
		Sample & hold function available(10bit)	VREF =VCC = 5V	ANEX0, ANEX1 input, External op-amp connection mode			±7	LSB
		Sample & hold function available(8bit)	VREF = VCC	C = 5V			±2	LSB
RLADDER	Ladder r	esistance	VREF = VC	2	10		40	kΩ
tconv	Convers	ion time(10bit)			3.3			μs
tconv	Convers	ion time(8bit)			2.8			μs
<b>t</b> SAMP	Samplin	g time			0.3			μs
VREF	Referen	ce voltage			2		Vcc	V
VIA	Analog i	nput voltage			0		VREF	V

Table 1.24.5. D-A conversion characteristics (referenced to VCC = 5V, VSS = AVSS = 0V, VREF = 5V at  $Ta = 25^{\circ}C$ , f(XIN) = 10MHz unless otherwise specified)

Coursels al	Domenton	NA	Standard			I limit
Symbol	Parameter	Measuring condition	Min.	Тур.	Max.	Unit
_	Resolution				8	Bits
_	Absolute accuracy				1.0	%
tsu	Setup time				3	μs
Ro	Output resistance		4	10	20	kΩ
Ivref	Reference power supply input current	(Note)			1.5	mA

Note: This applies when using one D-A converter, with the D-A register for the unused D-A converter set to "0016". The A-D converter's ladder resistance is not included.

Also, when the Vref is unconnected at the A-D control register, IVREF is sent.



$$Vcc = 5V$$

Timing requirements (referenced to Vcc = 5V, Vss = 0V at Ta = 25°C unless otherwise specified)

Table 1.24.6. External clock input

Symbol	Parameter	Stan	Unit	
	Palametei			Max.
tc	External clock input cycle time	100		ns
tw(H)	External clock input HIGH pulse width	40		ns
tw(L)	External clock input LOW pulse width	40		ns
tr	External clock rise time		15	ns
tf	External clock fall time		15	ns

Table 1.24.7. Memory expansion and microprocessor modes

Symbol	Parameter		Standard	
			Max.	Unit
tac1(RD-DB)	Data input access time (no wait)		(Note)	ns
tac2(RD-DB)	Data input access time (with wait)		(Note)	ns
tac3(RD-DB)	Data input access time (when accessing multiplex bus area)		(Note)	ns
tsu(DB-RD)	Data input setup time	40		ns
tsu(RDY-BCLK)	RDY input setup time	30		ns
tsu(HOLD-BCLK)	HOLD input setup time	40		ns
th(RD-DB)	Data input hold time	0		ns
th(BCLK -RDY)	RDY input hold time	0		ns
th(BCLK-HOLD)	HOLD input hold time	0		ns
td(BCLK-HLDA)	HLDA output delay time		40	ns

Note: Calculated according to the BCLK frequency as follows:

$$tac1(RD - DB) = \frac{10^9}{f(BCLK) \times 2} - 45$$
 [ns]

$$tac2(RD - DB) = \frac{3 \times 10^9}{f(BCLK) \times 2} - 45$$
 [ns]

$$tac3(RD - DB) = \frac{3 \times 10^9}{f(BCLK) \times 2} - 45$$
 [ns]

Vcc = 5V

Timing requirements (referenced to Vcc = 5V, Vss = 0V at Ta = 25°C unless otherwise specified)

Table 1.24.8. Timer A input (counter input in event counter mode)

Symbol	Demonstra		Standard	
	Parameter	Min.	Max.	Unit
tc(TA)	TAin input cycle time	100		ns
tw(TAH)	TAin input HIGH pulse width	40		ns
tw(TAL)	TAin input LOW pulse width	40		ns

#### Table 1.24.9. Timer A input (gating input in timer mode)

Symbol	Parameter	Standard		11.5
		Min.	Max.	Unit
tc(TA)	TAin input cycle time	400		ns
tw(TAH)	TAin input HIGH pulse width	200		ns
tw(TAL)	TAin input LOW pulse width	200		ns

#### Table 1.24.10. Timer A input (external trigger input in one-shot timer mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	Offit
tc(TA)	TAilN input cycle time	200		ns
tw(TAH)	TAim input HIGH pulse width	100		ns
tw(TAL)	TAin input LOW pulse width	100		ns

## Table 1.24.11. Timer A input (external trigger input in pulse width modulation mode)

Symbol	Parameter		Standard	
	Falantelei	Min.	Max.	Unit
tw(TAH)	TAin input HIGH pulse width	100		ns
tw(TAL)	TAin input LOW pulse width	100		ns

Table 1.24.12. Timer A input (up/down input in event counter mode)

Symbol	Dozomaton	Star	Linit	
	Parameter		Max.	Unit
tc(UP)	TAiout input cycle time	2000		ns
tw(UPH)	TAiout input HIGH pulse width	1000		ns
tw(UPL)	TAiout input LOW pulse width	1000		ns
tsu(UP-TIN)	TAiout input setup time	400		ns
th(TIN-UP)	TAiout input hold time	400		ns



Vcc = 5V

Timing requirements (referenced to Vcc = 5V, Vss = 0V at Ta = 25°C unless otherwise specified)

Table 1.24.13. Timer B input (counter input in event counter mode)

Symbol	Parameter	Stan	I lait	
		Min.	Max.	Unit
tc(TB)	TBin input cycle time (counted on one edge)	100		ns
tw(TBH)	TBiin input HIGH pulse width (counted on one edge)	40		ns
tw(TBL)	TBiin input LOW pulse width (counted on one edge)	40		ns
tc(TB)	TBiin input cycle time (counted on both edges)	200		ns
tw(TBH)	TBiin input HIGH pulse width (counted on both edges)	80		ns
tw(TBL)	TBilN input LOW pulse width (counted on both edges)	80		ns

#### Table 1.24.14. Timer B input (pulse period measurement mode)

Symbol	Parameter		Standard	
	Falantetel	Min.	Max.	Unit
tc(TB)	TBiin input cycle time	400		ns
tw(TBH)	TBiln input HIGH pulse width	200		ns
tw(TBL)	TBiin input LOW pulse width	200		ns

## Table 1.24.15. Timer B input (pulse width measurement mode)

Symbol	Parameter	Stan	dard	Unit
Symbol		Min.	Max.	Offic
tc(TB)	TBin input cycle time	400		ns
tw(TBH)	TBiin input HIGH pulse width	200		ns
tw(TBL)	TBilN input LOW pulse width	200		ns

## Table 1.24.16. A-D trigger input

Symbol	Parameter	Stan	dard	Unit
Symbol	Symbol	Min.	Max.	Offic
tc(AD)	ADTRG input cycle time (trigger able minimum)	1000		ns
tw(ADL)	ADTRG input LOW pulse width	125		ns

#### **Table 1.24.17. Serial I/O**

Symbol	Parameter	Stan	Unit	
Symbol	Falameter	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	200		ns
tw(CKH)	CLKi input HIGH pulse width	100		ns
tw(CKL)	CLKi input LOW pulse width	100		ns
td(C-Q)	TxDi output delay time		80	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	30		ns
th(C-D)	RxDi input hold time	90		ns

## Table 1.24.18. External interrupt INTi inputs

Symbol	Parameter	Star	ndard	Unit
	raidilletei	Min.	Max.	Offic
tw(INH)	INTi input HIGH pulse width	250		ns
tw(INL)	INTi input LOW pulse width	250		ns



$$Vcc = 5V$$

Switching characteristics (referenced to Vcc = 5V, Vss = 0V at Ta = 25°C, CM15 = "1" unless otherwise specified)

Table 1.24.19. Memory expansion mode and microprocessor mode (no wait)

0	Damanadan	Measuring condition	Stan	dard	1.1-21
Symbol	Parameter	weasuring condition	Min.	Max.	Unit
td(BCLK-AD)	Address output delay time			25	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		4		ns
th(RD-AD)	Address output hold time (RD standard)		0		ns
th(WR-AD)	Address output hold time (WR standard)		0		ns
td(BCLK-CS)	Chip select output delay time			25	ns
th(BCLK-CS)	Chip select output hold time (BCLK standard)		4		ns
td(BCLK-ALE)	ALE signal output delay time			25	ns
th(BCLK-ALE)	ALE signal output hold time	Figure 1.24.1	- 4		ns
td(BCLK-RD)	RD signal output delay time			25	ns
th(BCLK-RD)	RD signal output hold time		0		ns
td(BCLK-WR)	WR signal output delay time			25	ns
th(BCLK-WR)	WR signal output hold time		0		ns
td(BCLK-DB)	Data output delay time (BCLK standard)			40	ns
th(BCLK-DB)	Data output hold time (BCLK standard)		4		ns
td(DB-WR)	Data output delay time (WR standard)		(Note1)		ns
th(WR-DB)	Data output hold time (WR standard)(Note2)		0		ns

Note 1: Calculated according to the BCLK frequency as follows:

$$td(DB - WR) = \frac{10^{9}}{f(BCLK) \times 2} - 40$$
 [ns]

Note 2: This is standard value shows the timing when the output is off, and doesn't show hold time of data bus.

Hold time of data bus is different by capacitor volume and pull-up (pull-down) resistance value.

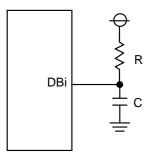
Hold time of data bus is expressed in

$$t = -CR \times In (1 - VoL / Vcc)$$

by a circuit of the right figure.

For example, when Vol = 0.2Vcc, C = 30pF, R = 1k $\Omega$ , hold time of output "L" level is

$$t = -30pF X 1k\Omega X In (1 - 0.2Vcc / Vcc)$$
  
= 6.7ns.





$$Vcc = 5V$$

Switching characteristics (referenced to VCC = 5V, VSS = 0V at  $Ta = 25^{\circ}C$ , CM15 = "1" unless otherwise specified)

Table 1.24.20. Memory expansion mode and microprocessor mode (with wait, accessing external memory)

Symbol	Parameter	Measuring condition	Stan	Standard	
Symbol	Parameter	medeaming containen	Min.	Max.	Unit
td(BCLK-AD)	Address output delay time			25	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		4		ns
th(RD-AD)	Address output hold time (RD standard)		0		ns
th(WR-AD)	Address output hold time (WR standard)		0		ns
td(BCLK-CS)	Chip select output delay time			25	ns
th(BCLK-CS)	Chip select output hold time (BCLK standard)		4		ns
td(BCLK-ALE)	ALE signal output delay time			25	ns
th(BCLK-ALE)	ALE signal output hold time	Figure 1.24.1	- 4		ns
td(BCLK-RD)	RD signal output delay time	1 19410 112 111		25	ns
th(BCLK-RD)	RD signal output hold time		0		ns
td(BCLK-WR)	WR signal output delay time			25	ns
th(BCLK-WR)	WR signal output hold time		0		ns
td(BCLK-DB)	Data output delay time (BCLK standard)	-		40	ns
th(BCLK-DB)	Data output hold time (BCLK standard)		4		ns
td(DB-WR)	Data output delay time (WR standard)		(Note1)		ns
th(WR-DB)	Data output hold time (WR standard)(Note2)		0		ns

Note 1: Calculated according to the BCLK frequency as follows:

$$td(DB - WR) = \frac{10^{9}}{f(BCLK)} - 40$$
 [ns]

Note 2: This is standard value shows the timing when the output is off, and doesn't show hold time of data bus.

Hold time of data bus is different by capacitor volume and pull-up (pull-down) resistance value.

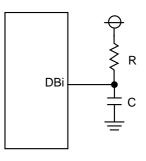
Hold time of data bus is expressed in

$$t = -CR \times In (1 - VoL / Vcc)$$

by a circuit of the right figure.

For example, when Vol = 0.2VCC, C = 30pF, R = 1k $\Omega$ , hold time of output "L" level is

$$t = -30pF X 1k\Omega X In (1 - 0.2Vcc / Vcc)$$
  
= 6.7ns.



Vcc = 5V

Switching characteristics (referenced to Vcc = 5V, Vss = 0V at Ta = 25°C, CM15 = "1" unless otherwise specified)

Table 1.24.21. Memory expansion mode and microprocessor mode (with wait, accessing external memory, multiplex bus area selected)

		Manager and distant	Stan	dard	
Symbol	Parameter	Measuring condition	Min.	Max.	Unit
td(BCLK-AD)	Address output delay time			25	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		4		ns
th(RD-AD)	Address output hold time (RD standard)		(Note)		ns
th(WR-AD)	Address output hold time (WR standard)		(Note)		ns
td(BCLK-CS)	Chip select output delay time			25	ns
th(BCLK-CS)	Chip select output hold time (BCLK standard)		4		ns
th(RD-CS)	Chip select output hold time (RD standard)		(Note)		ns
th(WR-CS)	Chip select output hold time (WR standard)		(Note)		ns
td(BCLK-RD)	RD signal output delay time			25	ns
th(BCLK-RD)	RD signal output hold time		0		ns
td(BCLK-WR)	WR signal output delay time			25	ns
th(BCLK-WR)	WR signal output hold time	Figure 1.24.1	0		ns
td(BCLK-DB)	Data output delay time (BCLK standard)	1 igule 1.24.1		40	ns
th(BCLK-DB)	Data output hold time (BCLK standard)		4		ns
td(DB-WR)	Data output delay time (WR standard)		(Note)		ns
<b>t</b> h(WR-DB)	Data output hold time (WR standard)		(Note)		ns
td(BCLK-ALE)	ALE signal output delay time (BCLK standard)			25	ns
th(BCLK-ALE)	ALE signal output hold time (BCLK standard)		<b>-4</b>		ns
td(AD-ALE)	ALE signal output delay time (Address standard)		(Note)		ns
th(ALE-AD)	ALE signal output hold time (Adderss standard)		50		ns
td(AD-RD)	Post-address RD signal output delay time		0		ns
td(AD-WR)	Post-address WR signal output delay time		0		ns
tdZ(RD-AD)	Address output floating start time			8	ns

Note: Calculated according to the BCLK frequency as follows:

$$th(RD - AD) = \frac{10^9}{f(BCLK) \times 2}$$
 [ns]

$$th(WR - AD) = \frac{10^9}{f(BCLK) \times 2}$$
 [ns]

$$th(RD-CS) = \frac{10^9}{f(BCLK) \times 2}$$
 [ns]

th(WR - CS) = 
$$\frac{10^9}{\text{f(BCLK) X 2}}$$
 [ns]

$$td(DB - WR) = \frac{10^9 \text{ X 3}}{f(BCLK) \text{ X 2}} - 40$$
 [ns

th(WR – DB) = 
$$\frac{10^9}{\text{f(BCLK) X 2}}$$
 [ns]

$$td(AD - ALE) = \frac{10^9}{f(BCLK) \times 2} - 25$$
 [ns]



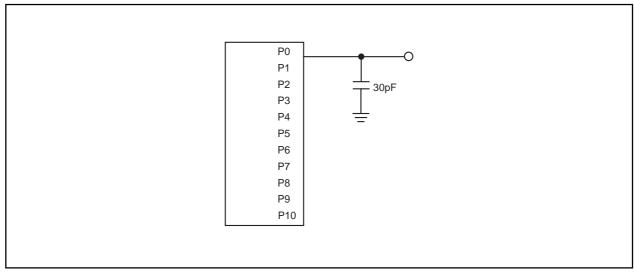


Figure 1.24.1. Port P0 to P10 measurement circuit

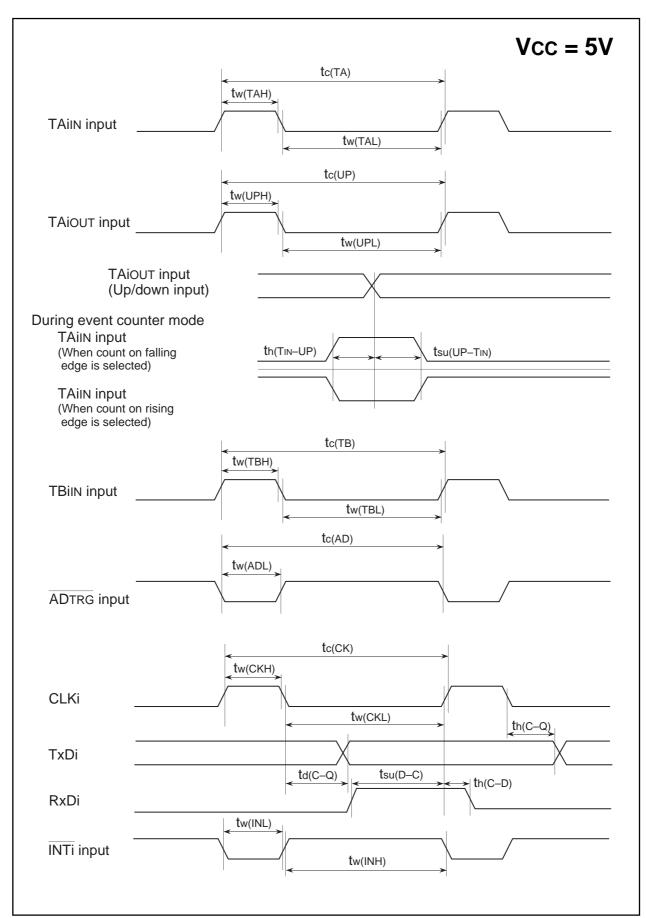


Figure 1.24.2. Vcc=5V timing diagram (1)



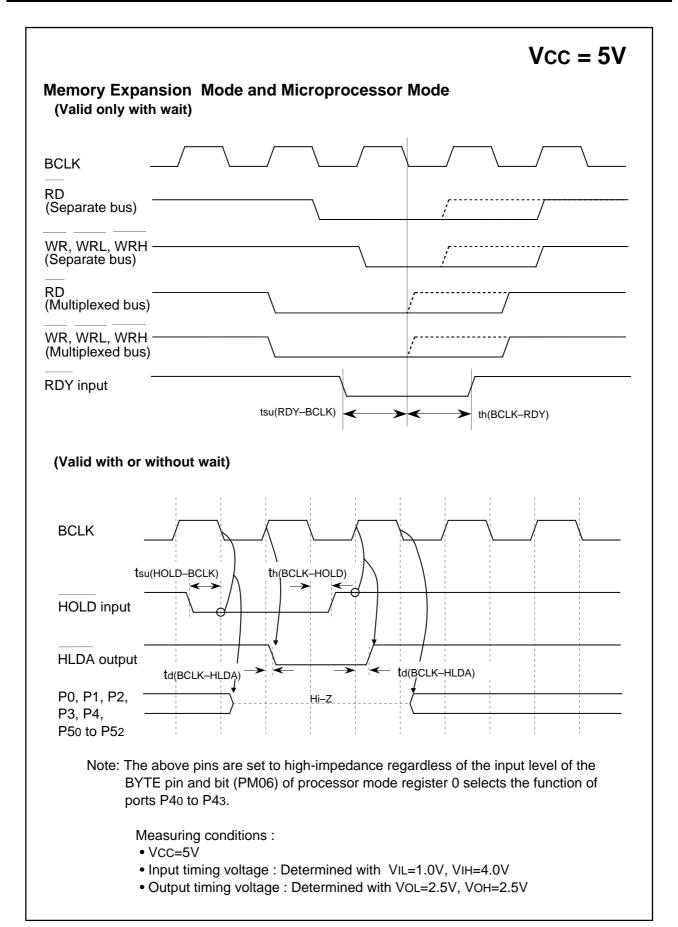
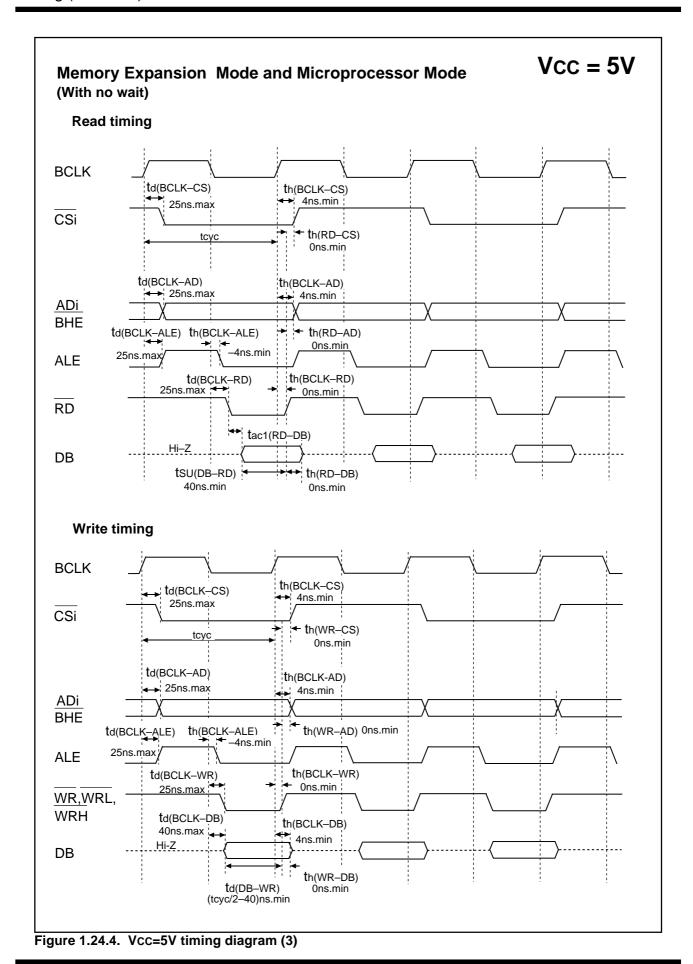


Figure 1.24.3. Vcc=5V timing diagram (2)





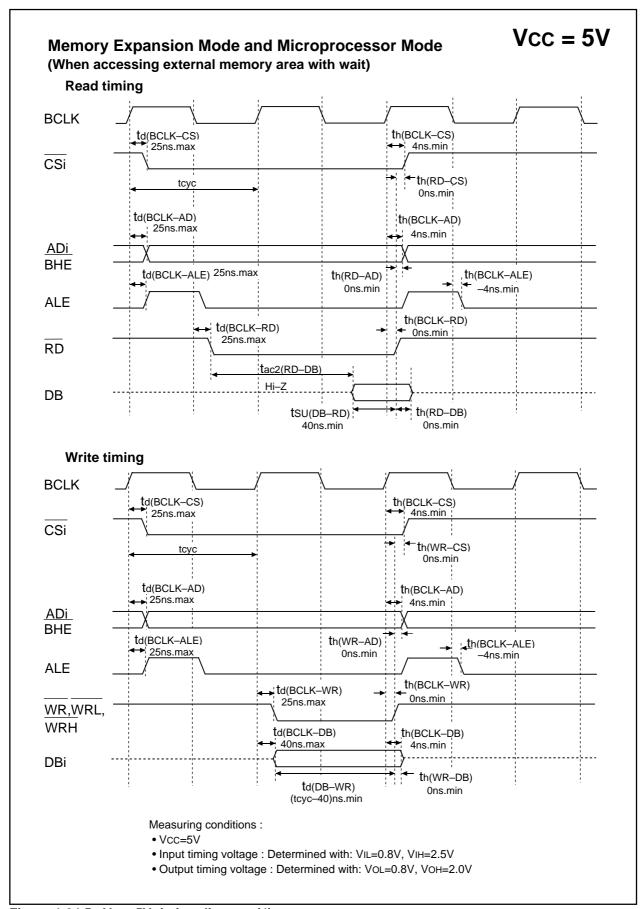


Figure 1.24.5. Vcc=5V timing diagram (4)



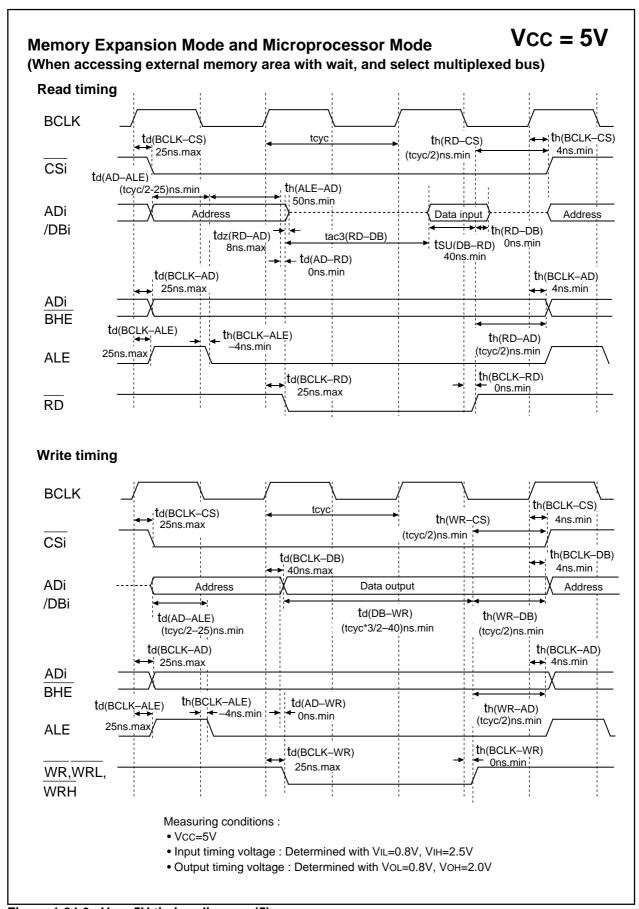


Figure 1.24.6. Vcc=5V timing diagram (5)



Vcc = 3V

Table 1.24.22. Electrical characteristics (referenced to VCC = 3V, VSS = 0V at Ta = 25°C, f(XIN) = 1

7MHz. with wait)

_	Day (		N /	ouring condition	S	tandard	d	l loi4	
Symbol		Parameter		Meas	suring condition	Min	Тур.	Max.	Unit
Vон	HIGH output voltage	P00 to P07,P10 to P30 to P37,P40 to P60 to P67,P72 to P86,P87,P90 to P9	P47,P50 to P57, P77,P80 to P84,	Iон=-1mA		2.5	,,		V
	HIGH output	voltage Xout	HIGHPOWER	Іон=-0.1mА		2.5			
Voн	піоп оцірці	vollage 7001	LOWPOWER	Іон=-50μΑ		2.5			V
	HIGH output	voltage Xcout	HIGHPOWER LOWPOWER	With no load ap	•		3.0 1.6		V
Vol	LOW output voltage	P00 to P07,P10 to P30 to P37,P40 to P60 to P67,P70 to P86,P87,P90 to P9	P47,P50 to P57, P77,P80 to P84,	IoL=1mA				0.5	V
Vol	LOW output v	oltage <sub>Хоит</sub>	HIGHPOWER	IoL=0.1mA				0.5	V
VOL	LOW output v		LOWPOWER	IoL=50µA				0.5	
	LOW output	voltage Хсоит	HIGHPOWER	With no load ap	•		0		V
VT+-VT-	Hysteresis	HOLD, RDY, TAC TB0IN to TB2IN, IN ADTRG, CTS0 to C CLK2,TA2OUT to 1 Klo to Kl3, RxD0 to	ITo to INT2, CTS2, C <u>LKo</u> to A4out,NMI,	With no load ap	oplied	0.2	0	0.8	V
VT+-VT-	Hysteresis	RESET	T TABLE			0.2		1.8	V
Ін	HIGH input current	P00 to P07,P10 to P30 to P37,P40 to P60 to P67,P70 to P90 to P97,P100 to XIN, RESET, CNV	P47,P50 to P57, P77,P80 to P87, p P107,	VI=3V		0.2		4.0	μA
Iц	LOW input current	P00 to P07,P10 to P30 to P37,P40 to P60 to P67,P70 to P90 to P97,P100 to XIN, RESET, CNV	P17,P20 to P27, P47,P50 to P57, P77,P80 to P87, D P107,	Vi=0V				-4.0	μΑ
R PULLUP	Pull-up resistance	P00 to P07,P10 to P30 to P37,P40 to P60 to P67,P72 to P86,P87,P90 to P9	P47,P50 to P57, P77,P80 to P84,	VI=0V		66.0	120.0	500.0	kΩ
R <sub>fXIN</sub>	Feedback res	sistance XIN					3.0		МΩ
R fXCIN	Feedback res	sistance Xcin					10.0		МΩ
$V_{RAM}$	RAM retention	n voltage		When clock is	stopped	2.0			V
					f(XIN)=7MHz Square wave, no division		6.0	15.0	mA
				In single-chip	f(Xcin)=32kHz Square wave		40.0		μA
lcc F	Power supply current	mode, the output pins are open and other	f(XCIN)=32kHz When a WAITinstruction is executed. Oscillation capacity High (Note)		2.8		μА		
			pins are Vss	f(XCIN)=32kHz When a WAIT instruction is executed. Oscillation capacity Low (Note)		0.9		μА	
	Ta=25°C when clock is stopped				1.0	μA			
					Ta=85°C when clock is stopped			20.0	μ, τ

Note: With one timer operated using fc32.



Vcc = 3V

Table 1.24.23. A-D conversion characteristics (referenced to VCC = AVCC = VREF = 3V, VSS = AVSS = 0V at  $Ta = 25^{\circ}C$ , f(XIN) = 7MHz unless otherwise specified)

0	Davamatar	Marana de la companya della companya della companya de la companya de la companya della companya	S	11.7			
Symbol		Parameter	Measuring condition	Min.	Тур.	Max	Unit
-	Resolution		VREF = VCC			10	Bits
-	Absolute accuracy	Sample & hold function not available (8 bit)	VREF = VCC = $3V$ , $\phi$ AD = $f(XIN)/2$			±2	LSB
RLADDER	Ladder resist	ance	VREF = VCC	10		40	kΩ
tconv	Conversion to	ime(8bit)		14.0			μs
VREF	Reference voltage			2.7		Vcc	V
VIA	Analog input	voltage		0		VREF	V

Table 1.24.24. D-A conversion characteristics (referenced to VCC = 3V, Vss = AVss = 0V, VREF = 3V at Ta =  $25^{\circ}$ C, f(XIN) = 7MHz unless otherwise specified)

	_		S			
Symbol	Parameter	Measuring condition	Min.	Тур.	Max	Unit
-	Resolution				8	Bits
-	Absolute accuracy				1.0	%
tsu	Setup time				3	μs
Ro	Output resistance		4	10	20	kΩ
Ivref	Reference power supply input current	(Note)			1.0	mA

Note: This applies when using one D-A converter, with the D-A register for the unused D-A converter set to "0016".

The A-D converter's ladder resistance is not included.

Also, when the Vref is unconnected at the A-D control register, IVREF is sent.



$$Vcc = 3V$$

Timing requirements (referenced to Vcc = 3V, Vss = 0V at Ta = 25°C unless otherwise specified)

Table 1.24.25. External clock input

C. mah al	Devenuetos	Star	l lm:4	
Symbol	Symbol Parameter		Max.	Unit
tc	External clock input cycle time	143		ns
tw(H)	External clock input HIGH pulse width	60		ns
tw(L)	External clock input LOW pulse width	60		ns
tr	External clock rise time		18	ns
tf	External clock fall time		18	ns

Table 1.24.26. Memory expansion and microprocessor modes

Symbol	Doromotor	Star	Standard		
	Parameter	Min.	Max.	Unit	
tac1(RD-DB)	Data input access time (no wait)		(Note)	ns	
tac2(RD-DB)	Data input access time (with wait)		(Note)	ns	
tac3(RD-DB)	Data input access time (when accessing multiplex bus area)		(Note)	ns	
tsu(DB-RD)	Data input setup time	80		ns	
tsu(RDY-BCLK)	RDY input setup time	60		ns	
tsu(HOLD-BCLK)	HOLD input setup time	80		ns	
th(RD-DB)	Data input hold time	0		ns	
th(BCLK -RDY)	RDY input hold time	0		ns	
th(BCLK-HOLD)	HOLD input hold time	0		ns	
td(BCLK-HLDA)	HLDA output delay time		100	ns	

Note: Calculated according to the BCLK frequency as follows:

$$tac1(RD - DB) = \frac{10^9}{f(BCLK) \times 2} - 90$$
 [ns]

$$tac2(RD - DB) = \frac{3 \times 10^9}{f(BCLK) \times 2} - 90$$
 [ns]

$$tac3(RD - DB) = \frac{3 \times 10^9}{f(BCLK) \times 2} - 90$$
 [ns]

Vcc = 3V

Timing requirements (referenced to Vcc = 3V, Vss = 0V at Ta = 25°C unless otherwise specified)

Table 1.24.27. Timer A input (counter input in event counter mode)

Symbol	Parameter	Standard	Unit	
	Falanielei	Min.	Max.	Unit
tc(TA)	TAin input cycle time	150		ns
tw(TAH)	TAin input HIGH pulse width	60		ns
tw(TAL)	TAin input LOW pulse width	60		ns

## Table 1.24.28. Timer A input (gating input in timer mode)

Symbol	Parameter	Standard		Unit	
	raidilletei	Min. Max.	Offic		
tc(TA)	TAil input cycle time	600		ns	
tw(TAH)	TAin input HIGH pulse width	300		ns	
tw(TAL)	TAin input LOW pulse width	300		ns	

#### Table 1.24.29. Timer A input (external trigger input in one-shot timer mode)

Symbol	Dorometer	Standard		Unit	
	Parameter	Min.	in. Max.	Unit	
tc(TA)	TAil input cycle time	300		ns	
tw(TAH)	TAil input HIGH pulse width	150		ns	
tw(TAL)	TAin input LOW pulse width	150		ns	

## Table 1.24.30. Timer A input (external trigger input in pulse width modulation mode)

Symbol	Demonstra	Standar	ndard	1.1-20
	Parameter	Min.	Max.	Unit
tw(TAH)	TAin input HIGH pulse width	150		ns
tw(TAL)	TAin input LOW pulse width	150		ns

Table 1.24.31. Timer A input (up/down input in event counter mode)

Symbol	Dorometer	Standard	Unit	
	Parameter	Min.	Max.	Unit
tc(UP)	TAiout input cycle time	3000		ns
tw(UPH)	TAiout input HIGH pulse width	1500		ns
tw(UPL)	TAiout input LOW pulse width	1500		ns
tsu(UP-TIN)	TAiout input setup time	600		ns
th(TIN-UP)	TAiout input hold time	600		ns



Vcc = 3V

Timing requirements (referenced to Vcc = 3V, Vss = 0V at Ta = 25°C unless otherwise specified)

Table 1.24.32. Timer B input (counter input in event counter mode)

Symbol Pa	Deservator	Standard		1.126
	Parameter	Min.	Max.	Unit
tc(TB)	TBilN input cycle time (counted on one edge)	150		ns
tw(TBH)	TBiin input HIGH pulse width (counted on one edge)	60		ns
tw(TBL)	TBiin input LOW pulse width (counted on one edge)	60		ns
tc(TB)	TBiin input cycle time (counted on both edges)	300		ns
tw(TBH)	TBilN input HIGH pulse width (counted on both edges)	160		ns
tw(TBL)	TBilN input LOW pulse width (counted on both edges)	160		ns

#### Table 1.24.33. Timer B input (pulse period measurement mode)

Symbol	Parameter	Standard		Unit
	i didiliciei	Min. Max.		
tc(TB)	TBin input cycle time	600		ns
tw(TBH)	TBiin input HIGH pulse width	300		ns
tw(TBL)	TBiln input LOW pulse width	300		ns

## Table 1.24.34. Timer B input (pulse width measurement mode)

Symbol	Parameter	Standard		Unit
	i didilicici	Min. Max	Max.	
tc(TB)	TBin input cycle time	600		ns
tw(TBH)	TBilN input HIGH pulse width	300		ns
tw(TBL)	TBin input LOW pulse width	300		ns

## Table 1.24.35. A-D trigger input

Symbol	Parameter	Standard	Unit	
	i diameter	Min.	Max.	Onne
tc(AD)	ADTRG input cycle time (trigger able minimum)	1500		ns
tw(ADL)	ADTRG input LOW pulse width	200		ns

#### **Table 1.24.36. Serial I/O**

Symbol	Parameter	Standard		Unit
Symbol	i didiliciei	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	300		ns
tw(CKH)	CLKi input HIGH pulse width	150		ns
tw(CKL)	CLKi input LOW pulse width	150		ns
td(C-Q)	TxDi output delay time		160	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	50		ns
th(C-D)	RxDi input hold time	90		ns

## Table 1.24.37. External interrupt INTi inputs

Symbol	Parameter	Standard		Unit
	i arameter	Min. Max.	Offic	
tw(INH)	INTi input HIGH pulse width	380		ns
tw(INL)	INTi input LOW pulse width	380		ns



$$Vcc = 3V$$

Switching characteristics (referenced to VCC = 3V, VSS = 0V at  $Ta = 25^{\circ}C$ , CM15 = "1" unless otherwise specified)

Table 1.24.38. Memory expansion and microprocessor modes (with no wait)

0	Development	Measuring condition	Stan	dard	11.26
Symbol	Parameter	Measuring condition	Min.	Max.	Unit
td(BCLK-AD)	Address output delay time			60	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		4		ns
th(RD-AD)	Address output hold time (RD standard)		0		ns
th(WR-AD)	Address output hold time (WR standard)		0		ns
td(BCLK-CS)	Chip select output delay time			60	ns
th(BCLK-CS)	Chip select output hold time (BCLK standard)		4		ns
td(BCLK-ALE)	ALE signal output delay time			60	ns
th(BCLK-ALE)	ALE signal output hold time	Figure 1.24.1	-4		ns
td(BCLK-RD)	RD signal output delay time			60	ns
th(BCLK-RD)	RD signal output hold time		0		ns
td(BCLK-WR)	WR signal output delay time			60	ns
th(BCLK-WR)	WR signal output hold time		0		ns
td(BCLK-DB)	Data output delay time (BCLK standard)			80	ns
th(BCLK-DB)	Data output hold time (BCLK standard)		4		ns
td(DB-WR)	Data output delay time (WR standard)		(Note1)		ns
th(WR-DB)	Data output hold time (WR standard)(Note2)		0		ns

Note 1: Calculated according to the BCLK frequency as follows:

$$td(DB - WR) = \frac{10^9}{f(BCLK) \times 2} - 80$$
 [ns]

Note 2: This is standard value shows the timing when the output is off, and doesn't show hold time of data bus.

Hold time of data bus is different by capacitor volume and pull-up (pull-down) resistance value.

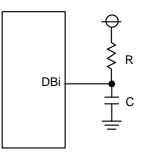
Hold time of data bus is expressed in

$$t = -CR \times In (1 - VoL / VCC)$$

by a circuit of the right figure.

For example, when VoL = 0.2VCC, C = 30pF, R =  $1k\Omega$ , hold time of output "L" level is

$$t = -30pF X 1k\Omega X In (1 - 0.2Vcc / Vcc)$$
  
= 6.7ns.





$$Vcc = 3V$$

Switching characteristics (referenced to VCC = 3V, VSS = 0V at  $Ta = 25^{\circ}C$ , CM15 = "1" unless otherwise specified)

Table 1.24.39. Memory expansion and microprocessor modes

(when accessing external memory area with wait)

0	B	Magazzing condition	Stan	dard	
Symbol	Parameter	Measuring condition	Min.	Max.	Unit
td(BCLK-AD)	Address output delay time			60	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		4		ns
th(RD-AD)	Address output hold time (RD standard)		0		ns
th(WR-AD)	Address output hold time (WR standard)		0		ns
td(BCLK-CS)	Chip select output delay time			60	ns
th(BCLK-CS)	Chip select output hold time (BCLK standard)		4		ns
td(BCLK-ALE)	ALE signal output delay time			60	ns
th(BCLK-ALE)	ALE signal output hold time	Figure 1.24.1	- 4		ns
td(BCLK-RD)	RD signal output delay time	9		60	ns
th(BCLK-RD)	RD signal output hold time		0		ns
td(BCLK-WR)	WR signal output delay time			60	ns
th(BCLK-WR)	WR signal output hold time		0		ns
td(BCLK-DB)	Data output delay time (BCLK standard)			80	ns
th(BCLK-DB)	Data output hold time (BCLK standard)		4		ns
td(DB-WR)	Data output delay time (WR standard)		(Note1)		ns
th(WR-DB)	Data output hold time (WR standard)(Note2)		0		ns

Note 1: Calculated according to the BCLK frequency as follows:

$$td(DB - WR) = \frac{10^9}{f(BCLK)} - 80$$
 [ns]

Note 2: This is standard value shows the timing when the output is off, and doesn't show hold time of data bus.

Hold time of data bus is different by capacitor volume and pull-up (pull-down) resistance value.

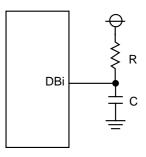
Hold time of data bus is expressed in

$$t = -CR \times In (1 - VoL / Vcc)$$

by a circuit of the right figure.

For example, when VoL = 0.2Vcc, C = 30pF, R = 1k $\Omega$ , hold time of output "L" level is

$$t = -30pF X 1k\Omega X In (1 - 0.2Vcc / Vcc)$$
  
= 6.7ns.



Vcc = 3V

Switching characteristics (referenced to Vcc = 3V, Vss = 0V at Ta = 25°C, CM15 = "1" unless otherwise specified)

Table 1.24.40. Memory expansion and microprocessor modes
(when accessing external memory area with wait, and select multiplexed bus)

		B. 4	Stan	dard	Unit
Symbol	Parameter	Measuring condition	Min.	Max.	
td(BCLK-AD)	Address output delay time			60	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		4		ns
th(RD-AD)	Address output hold time (RD standard)		(Note)		ns
th(WR-AD)	Address output hold time (WR standard)		(Note)		ns
td(BCLK-CS)	Chip select output delay time			60	ns
th(BCLK-CS)	Chip select output hold time (BCLK standard)		4		ns
th(RD-CS)	Chip select output hold time (RD standard)		(Note)		ns
th(WR-CS)	Chip select output hold time (WR standard)		(Note)		ns
td(BCLK-RD)	RD signal output delay time	Figure 1.24.1		60	ns
th(BCLK-RD)	RD signal output hold time		0		ns
td(BCLK-WR)	WR signal output delay time			60	ns
th(BCLK-WR)	WR signal output hold time		0		ns
td(BCLK-DB)	Data output delay time (BCLK standard)			80	ns
th(BCLK-DB)	Data output hold time (BCLK standard)		4		ns
td(DB-WR)	Data output delay time (WR standard)		(Note)		ns
th(WR-DB)	Data output hold time (WR standard)		(Note)		ns
td(BCLK-ALE)	ALE signal output delay time (BCLK standard)			60	ns
th(BCLK-ALE)	ALE signal output hold time (BCLK standard)		- 4		ns
td(AD-ALE)	ALE signal output delay time (Address standard)		(Note)		ns
th(ALE-AD)	ALE signal output hold time(Address standard)		50		ns
td(AD-RD)	Post-address RD signal output delay time		0		ns
td(AD-WR)	Post-address WR signal output delay time		0		ns
tdZ(RD-AD)	Address output floating start time			8	ns

Note: Calculated according to the BCLK frequency as follows:

$$th(RD - AD) = \frac{10^9}{f(BCLK) \times 2}$$
 [ns]

th(WR - AD) = 
$$\frac{10^{9}}{f(BCLK) \times 2}$$
 [ns]

th(RD - CS) = 
$$\frac{10^{9}}{\text{f(BCLK) X 2}}$$
 [ns]

th(WR - CS) = 
$$\frac{10^9}{\text{f(BCLK) X 2}}$$
 [ns]

$$td(DB - WR) = \frac{10^9 \text{ X 3}}{f(BCLK) \text{ X 2}} - 80 \text{ [ns]}$$

th(WR – DB) = 
$$\frac{10^{9}}{f(BCLK) \times 2}$$
 [ns]

$$td(AD - ALE) = \frac{10^9}{f(BCLK) \times 2} - 60$$
 [ns]



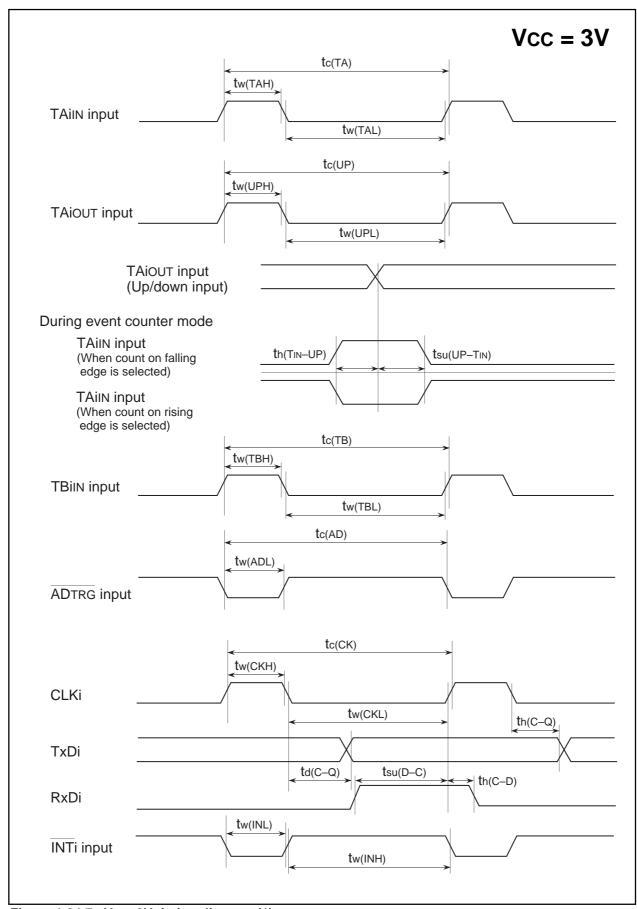
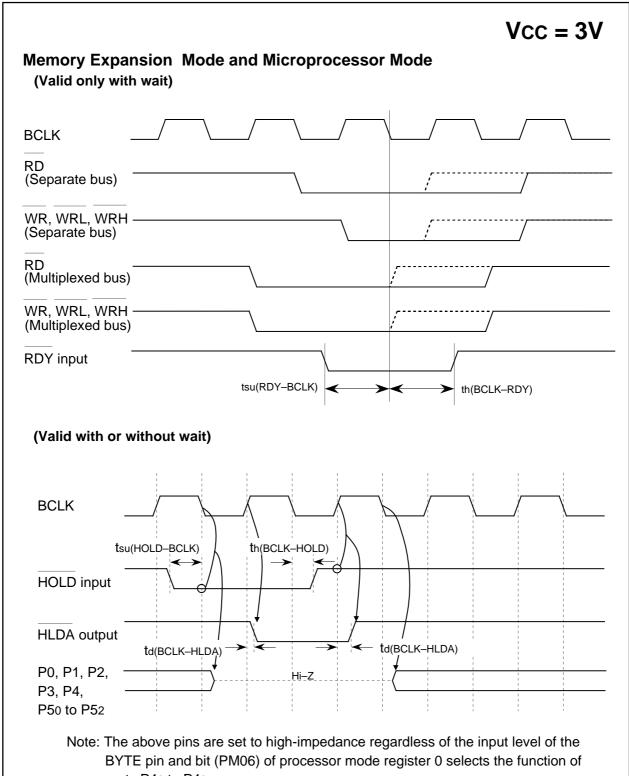


Figure 1.24.7. Vcc=3V timing diagram (1)





ports P40 to P43.

Measuring conditions:

- VCC=3V
- Input timing voltage : Determined with VIL=0.6V, VIH=2.4V
- Output timing voltage: Determined with VOL=1.5V, VOH=1.5V

Figure 1.24.8. Vcc=3V timing diagram (2)



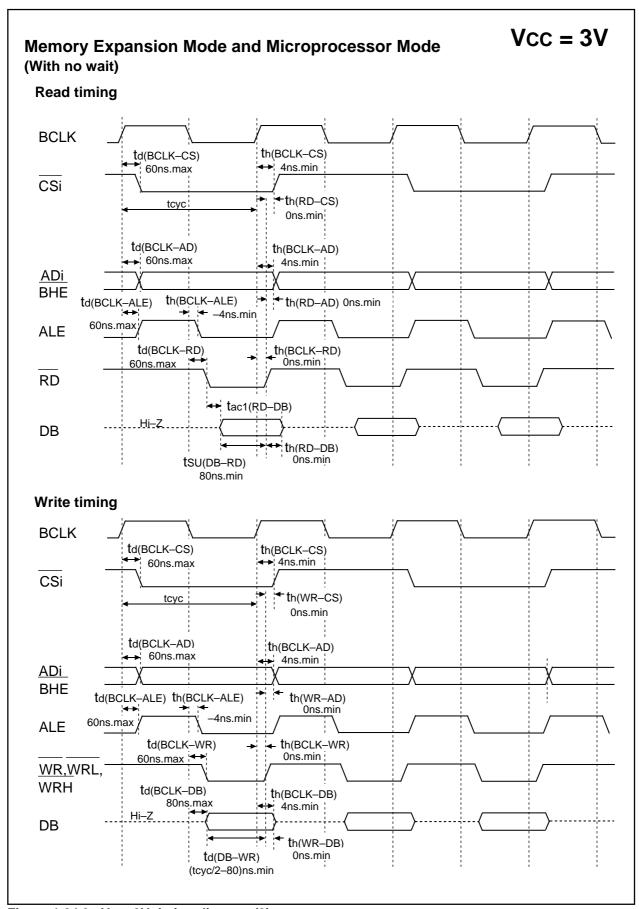


Figure 1.24.9. Vcc=3V timing diagram (3)



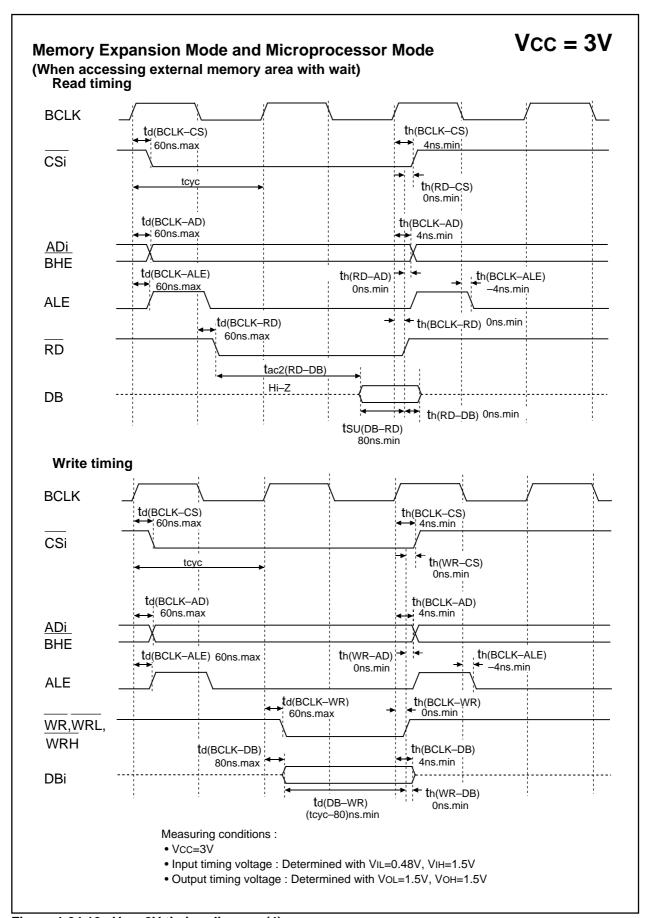


Figure 1.24.10. Vcc=3V timing diagram (4)

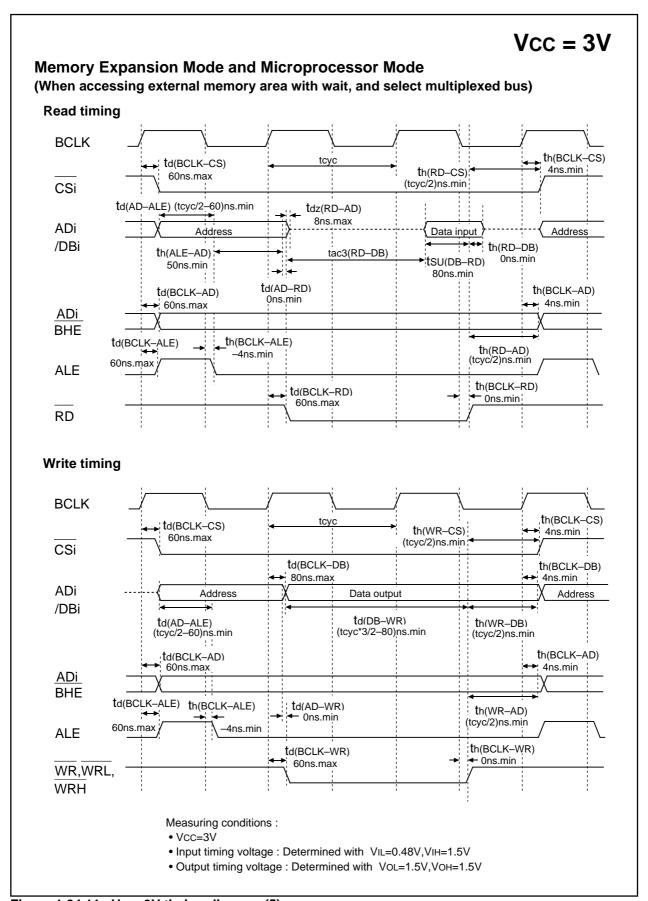


Figure 1.24.11. Vcc=3V timing diagram (5)

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# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30610M8A-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number
-----------------

	Date :	
±	Section head signature	Supervisor signature
Receipt		

Note: Please complete all items marked %.

% Cus		Company		TEL				Submitted by	Supervisor
	Customer	name		( )	٥				
	Guotomor	Date issued	Date :			ารรุ	sign		

#### % 1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

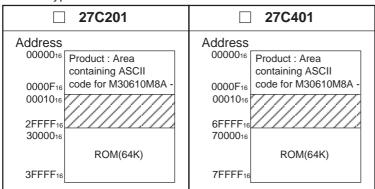
☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Microcomputer type No.:	☐ M30610M8A-XXXFP	☐ M30610M8A-XXXGF
-------------------------	-------------------	-------------------

Checksum code for total EPROM area : (hex)

#### EPROM type:



- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30610M8A-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Both address and data are shown in hex.

Address		
0000016	'M '	$=4D_{16}$
0000116	'3'	= 3316
0000216	0'	= 3016
0000316	'6'	= 3616
0000416	'1'	= 3116
0000516	'0'	= 3016
0000616	'M'	= 4D <sub>16</sub>
0000716	'8'	= 3816

' A '	= 4116
'—'	= 2D <sub>16</sub>
	FF <sub>16</sub>
	FF <sub>16</sub>
	FF <sub>16</sub>
	FF <sub>16</sub>
	FF <sub>16</sub>
	FF <sub>16</sub>
	'A'



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MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT
MICROCOMPUTER M30610M8A-XXXFP/GP
MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EPROM type	27	C201		27C401	1
Code entered in source program	△ .SECTION△AS △ .ORG △ 0C000 △ .BYTE △ ' M30		△ .ORG	TION△ASCIICODE, ROM DATA △ 080000H - △ ' M30610M8A- '	
Note: The ROM c in the check		I if the type No. written to	the EPRO	OM does not match the type No.	
☐ In the case of	of floppy disks				
the floppy disks there is any dis products we pr	s you give in to us, a screpancy between to oduce. Check thoro	and forms them into mas the contents of these ma ughly the contents of the	ks. Hence ask files an e mask file:	ration utilities out of those held on , we assume liability provided that do the ROM data to be burned into s you give in.	t
Microcompu	uter type No. :	☐ M30610M8A-XXX	FP	☐ M30610M8A-XXXGP	
File code :				(hex)	
Mask file name :				.MSK (alpha-numeric 8-digit)	
	ions				
For our referenthe products yo		our products, please rep	ly to the fo	llowing questions about the usage	e of
` ` □ (	kind of XIN-XOUT ose Ceramic resonator External clock input	cillation circuit is used?  Quartz-crystal			



What frequency do you use? f(XIN) =

MHz

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Thank you cooperation.

% 4. Special item (Indicate none if there is no specified item)

	MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30610M8A-XXXFP/GP MASK ROM CONFIRMATION FORM			Mask ROM number	
(2)	Which kind of XCIN-XCOUT oscillati  ☐ Ceramic resonator ☐ External clock input  What frequency do you use?  f(XCIN) = kHz	☐ Quartz-crystal oscillator			
(3)	Which operation mode do you use ☐ Single-chip mode ☐ Microprocessor mode	?  Memory expansion mode			
(4)	Which operating ambient temperated □ −10 °C to 75 °C □ −10 °C to 85 °C		_	10 °C to 75 °C 10 °C to 85 °C	
(5)	Which operating supply voltage do ☐ 2.7V to 3.2V ☐ 4.2V to 4.7V	o you use? □ 3.2V to 3.7V □ 4.7V to 5.2V		7V to 4.2V 2V to 5.5V	



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# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30610MAA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

	Date :	
±	Section head signature	Supervisor signature
Receipt		

Note: Please complete all items marked %.

<b>\</b> °⁄		Company		TEL ( )			Submitted by	Supervisor
		name				ance ature		
*	Customer	Date issued	Date :			lssua signa		

#### % 1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Microcomputer type No.:	☐ M30610MAA-XXXFP	☐ M30610MAA-XXXGP
, ,,		

Checksum code for total EPROM area : (hex)

#### EPROM type:

☐ 27C201	☐ 27C401
Address 0000016 Product : Area containing ASCII code for M30610MAA - 0001016 27FFF16 2800016 ROM(96K)	Address 0000016 Product : Area containing ASCII code for M30610MAA - 0001016 67FFF16 6800016 ROM(96K) 7FFFF16

- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30610MAA-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Both address and data are shown in hex.

Address					
0000016	'M '	= 4D <sub>16</sub>			
0000116	'3'	= 3316			
0000216	'0'	= 3016			
0000316	'6'	= 3616			
0000416	'1'	= 3116			
0000516	'0'	= 3016			
0000616	'M '	= 4D <sub>16</sub>			
0000716	'A'	= 4116			

Address		
0000816	' A '	= 4116
0000916	<u> </u>	= 2D <sub>16</sub>
0000A <sub>16</sub>		FF <sub>16</sub>
0000B <sub>16</sub>		FF16
0000C <sub>16</sub>		FF <sub>16</sub>
0000D <sub>16</sub>		FF <sub>16</sub>
0000E <sub>16</sub>		FF16
0000F <sub>16</sub>		FF <sub>16</sub>



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# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30610MAA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EPROM type	27C201		27C401			
Code entered in source program	$\triangle$ .ORG $\triangle$ 0C000	7 0C0000H		TION△ASCIICODE, ROM DATA G △ 080000H E △ ' M30610MAA- '		
Note: The ROM cannot be processed if the type No. written to the EPROM does not match the type No. in the check sheet.						
☐ In the case of	of floppy disks					
Mitsubishi processes the mask files generated by the mask file generation utilities out of those held on the floppy disks you give in to us, and forms them into masks. Hence, we assume liability provided that there is any discrepancy between the contents of these mask files and the ROM data to be burned into products we produce. Check thoroughly the contents of the mask files you give in. Prepare 3.5 inches 2HD(IBM format) floppy disks. And store only one mask file in a floppy disk.						
Microcompu	uter type No. :	☐ M30610MAA-XXX	(FP	☐ M30610MAA-XXXGP		
File code :				(hex)		
Mask file na	ame :			.MSK (alpha-numeric 8-digit)		
the separate m for submission For the M3061	sification differs acco nark specification sh to Mitsubishi.	neet (for each package), mit the 100P6S mark sp	attach tha	er entering the mark specification on at sheet to this masking check sheet a sheet. For the M30610MAA-XXXGP		
	ions					
For our reference when of testing our products, please reply to the following questions about the usage of the products you ordered.						
(1) Which kind of XIN-XOUT oscillation circuit is used?  ☐ Ceramic resonator ☐ Quartz-crystal oscillator ☐ External clock input ☐ Other ( )  What frequency do you use?						



 $\mathsf{MHz}$ 

f(XIN) =

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MITSUBISHI ELECTRIC SIN	Mask ROM number					
MICROCOMPUTER M3061 MASK ROM CONFIRM						
(2) Which kind of XCIN-XCOUT oscilla  ☐ Ceramic resonator ☐ External clock input What frequency do you use? f(XCIN) = kHz	☐ Quartz-crystal oscillator					
(3) Which operation mode do you us ☐ Single-chip mode ☐ Microprocessor mode	se?  Memory expansion mode					
(4) Which operating ambient temper  □ -10 °C to 75 °C  □ -10 °C to 85 °C	□-20 °C to 75 °C	□ -40 °C to 75 °C □ -40 °C to 85 °C				
(5) Which operating supply voltage of □ 2.7V to 3.2V □ 4.2V to 4.7V		☐ 3.7V to 4.2V ☐ 5.2V to 5.5V				
Thank you cooperation.						

% 4. Special item (Indicate none if there is no specified item)



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# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30610MCA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	
-----------------	--

	Date :	
±	Section head signature	Supervisor signature
Receipt		

Note: Please complete all items marked %.

		Company		TEL			Submitted by	Supervisor
\%/	0	name		(	)	ance ature		
*	Customer	Date issued	Date :			Issua		

#### % 1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

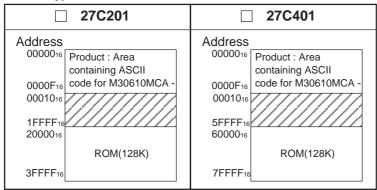
☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Microcomputer type No. :   M30610	MCA-XXXFP ☐ M30610MCA-XXXGP
-----------------------------------	-----------------------------

Checksum code for total EPROM area : (hex)

#### EPROM type:



- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30610MCA-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Both address and data are shown in hex.

Address		
0000016	'M '	= 4D <sub>16</sub>
0000116	'3'	= 3316
0000216	0	= 3016
0000316	6	= 3616
0000416	'1'	= 3116
0000516	0	= 3016
0000616	'M'	$=4D_{16}$
0000716	- ن	= 4316

Address		
0000816	' A '	= 4116
0000916	<u>.</u>	= 2D <sub>16</sub>
0000A <sub>16</sub>		FF <sub>16</sub>
0000B <sub>16</sub>		FF <sub>16</sub>
0000C <sub>16</sub>		FF <sub>16</sub>
0000D <sub>16</sub>		FF <sub>16</sub>
0000E <sub>16</sub>		FF <sub>16</sub>
0000F <sub>16</sub>		FF <sub>16</sub>



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# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30610MCA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EPROM type	27	C201			27C401	
Code entered in source program	△ .SECTION△AS △ .ORG △ 0C000 △ .BYTE △ 'M30	0H	)M DATA	△ .ORG	FION $\triangle$ ASCIICODE, $ $ $\triangle$ 080000H $ $ $\triangle$ $ $ M30610MCA- $ $	ROM DATA
Note: The ROM of in the check		d if the type No	. written to	the EPR	OM does not match the	ne type No.
☐ In the case	of floppy disks					
the floppy disk there is any dis products we pr	s you give in to us, a screpancy between oduce. Check thoro	and forms then the contents o oughly the cont	n into mas f these ma ents of the	sks. Hence ask files ar e mask file	ration utilities out of the, we assume liability and the ROM data to be you give in.  e mask file in a floppy	provided that e burned into
Microcomp	uter type No. :	☐ M30610	MCA-XXX	FP	☐ M30610MCA-XXX	(GP
File code :					(hex)	
Mask file na	ame :				.MSK (alpha-nume	ric 8-digit)
the separate m for submission For the M3061	cification differs acco nark specification sh to Mitsubishi.	eet (for each p	backage),	attach tha	r entering the mark sp t sheet to this maskin sheet. For the M306	g check sheet
	ions					
For our referenthe products yo		our products, p	olease rep	ly to the fo	ollowing questions abo	out the usage of
∵ □ ( □ E What fr	kind of XIN-XOUT oso Ceramic resonator External clock input equency do you use IN) =	☐ Quai ☐ Othe	rtz-crystal	oscillator )		



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	MITSUBISHI ELECTRIC SIN		Mask ROM number	
	MICROCOMPUTER M30610 MASK ROM CONFIRM	_		
(2)	Which kind of XCIN-XCOUT oscilla  Ceramic resonator External clock input  What frequency do you use?  f(XCIN) = kHz	☐ Quartz-crystal oscillator		
(3)	Which operation mode do you us ☐ Single-chip mode ☐ Microprocessor mode	e?  Memory expansion mode		
(4)	Which operating ambient tempera  ☐ -10 °C to 75 °C  ☐ -10 °C to 85 °C			10 °C to 75 °C 10 °C to 85 °C
(5)	Which operating supply voltage of □ 2.7V to 3.2V □ 4.2V to 4.7V	lo you use? □ 3.2V to 3.7V □ 4.7V to 5.2V	_	7V to 4.2V 2V to 5.5V
Thank	you cooperation.			
	al item (Indicate none if there is no	o specified item)		



GZZ-SH12-35B <79A1>

# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612M4A-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	
-----------------	--

	Date :	
t t	Section head signature	Supervisor signature
Receipt		

Note: Please complete all items marked %.

		Company	TEL			Submitted by	Supervisor
<b>%</b>	Customer	Company name	(	)	lance		
<b>70</b> `	Guotomor	Date issued	Date :		Issu		

#### % 1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Checksum code for total EPROM area : (hex)

## EPROM type:

☐ 27C201	☐ 27C401
Address	Address
0000016	0000016

- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30612M4A-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Address		
0000016	'M '	= 4D <sub>16</sub>
0000116	'3'	= 3316
0000216	'0'	= 3016
0000316	6'	= 3616
0000416	'1'	= 3116
0000516	'2'	= 3216
0000616	'M '	= 4D <sub>16</sub>
0000716	'4'	= 3416

Address		
0000816	' A '	= 4116
0000916	'-'	= 2D <sub>16</sub>
0000A <sub>16</sub>		FF <sub>16</sub>
0000B <sub>16</sub>		FF <sub>16</sub>
0000C <sub>16</sub>		FF <sub>16</sub>
0000D <sub>16</sub>		FF <sub>16</sub>
0000E <sub>16</sub>		FF <sub>16</sub>
0000F <sub>16</sub>		FF16



١	C77—	CLI11	— 35P	270 A	1 👡

## MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612M4A-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EPROM type	27	C201			27C401	
Code entered in source program	△ .SECTION△AS △ .ORG △ 0C000 △ .BYTE △ ' M30	0H		ORG 2	ION△ASCIICODE, ROM DAT △ 080000H △ ' M30612M4A- '	Ā
Note: The ROM c in the check		d if the type No. wri	itten to th	ne EPRO	DM does not match the type No	<u> </u>
$\square$ In the case $\circ$	of floppy disks					
the floppy disks there is any dis products we pr	s you give in to us, a screpancy between oduce. Check thoro	and forms them into the contents of the bughly the contents	o masks. se mask of the m	. Hence, files an ask files	ation utilities out of those held we assume liability provided to the ROM data to be burned is you give in. mask file in a floppy disk.	hat
Microcompu	uter type No. :	☐ M30612M4A	\-XXXFP	[	☐ M30612M4A-XXXGP	
File code :					(hex)	
Mask file na	ame :				.MSK (alpha-numeric 8-digit	)
the separate m for submission For the M3061	sification differs acco nark specification sh to Mitsubishi.	eet (for each pack	age), atta	ach that	entering the mark specification sheet to this masking check sheet. For the M30612M4A-XX	heet
	ions					
For our referen the products yo		our products, pleas	se reply to	o the fol	lowing questions about the usa	age of
` ' □ (	kind of XIN-XOUT osc Ceramic resonator External clock input	☐ Quartz-c	rystal osc			



What frequency do you use? f(XIN) =

MHz

GZZ-SH12-35B <79A1>

	MITSUBISHI ELECTRIC SIN MICROCOMPUTER M30612		Ĺ	Mask ROM number	
'	MASK ROM CONFIRMA				
. ,	hich kind of XCIN-XCOUT oscilla  Ceramic resonator External clock input hat frequency do you use?  f(XCIN) = kHz	☐ Quartz-crystal oscillator			
(3) WI	hich operation mode do you us Single-chip mode Microprocessor mode	e? ☐ Memory expansion mode			
(4) WI	hich operating ambient tempera ☐-10 °C to 75 °C ☐-10 °C to 85 °C			10 °C to 75 °C 10 °C to 85 °C	
(5) WI	hich operating supply voltage d ☐ 2.7V to 3.2V ☐ 4.2V to 4.7V			7V to 4.2V 2V to 5.5V	
Thank you	u cooperation.				
	tem (Indicate none if there is no	o specified item)			



GZZ-SH12-34B <79A1>

# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612M8A-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number
-----------------

	Date :	
Ħ	Section head signature	Supervisor signature
Receipt		

Note: Please complete all items marked %.

		Company		TEL			Submitted by	Supervisor
<b>%</b>	Customer	name		(	)	ance		
**	Customer	Date issued	Date :			lssu sign		

#### % 1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

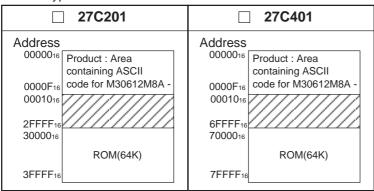
☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Microcomputer type No. : M30612M8A-XXXFP M30612M8A-XXXGP

Checksum code for total EPROM area : (hex)

#### EPROM type:



- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30612M8A-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Address		
0000016	'M '	$=4D_{16}$
0000116	'3'	= 3316
0000216	0'	= 3016
0000316	6'	= 3616
0000416	'1'	= 3116
0000516	'2'	= 3216
0000616	'M '	$=4D_{16}$
0000716	'8'	= 3816

Address		
0000816	' A '	= 4116
0000916	'-'	= 2D <sub>16</sub>
0000A <sub>16</sub>		FF16
0000B <sub>16</sub>		FF16
0000C <sub>16</sub>		FF16
0000D <sub>16</sub>		FF16
0000E <sub>16</sub>		FF16
0000F <sub>16</sub>		FF16



GZZ-SH12-34B <79A1>

f(XIN) =

# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612M8A-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EPROM type	270	C201					27C401
Code entered in source program	△ .SECTION△AS △ .ORG △ 0C0000 △ .BYTE △ ' M30	0H		DAT	$\triangle$ .SECTION $\triangle$ ASCIICODE, ROM DATA $\triangle$ .ORG $\triangle$ 080000H $\triangle$ .BYTE $\triangle$ ' M30612M8A- '		
Note: The ROM c in the check		if the typ	oe No. w	/ritten	to the I	EPR	OM does not match the type No.
☐ In the case of	of floppy disks						
the floppy disks there is any dis products we pr	s you give in to us, a screpancy between t oduce. Check thoro	and forms the conte ughly the	them in ents of the conten	nto ma nese r ts of t	asks. H nask file he mas	ence es a k file	eration utilities out of those held on e, we assume liability provided that nd the ROM data to be burned into es you give in. e mask file in a floppy disk.
Microcompu	uter type No. :	☐ M3	0612M8	8A-XX	XFP		☐ M30612M8A-XXXGP
File code :							(hex)
Mask file na	ame :						.MSK (alpha-numeric 8-digit)
the separate m for submission For the M3061	sification differs acco nark specification sho to Mitsubishi.	eet (for e	ach pac	kage)	, attach	tha	er entering the mark specification on at sheet to this masking check sheet sheet. For the M30612M8A-XXXGP,
	ions						
For our referenthe products yo		our produ	icts, plea	ase re	ply to t	he fo	ollowing questions about the usage of
( E	kind of XIN-XOUT osc Ceramic resonator External clock input equency do you use		ircuit is    Quartz-  Other (	-crysta		ator )	



MHz

GZZ-SH12-34B <79A1>

MITSUBISHI ELECTRIC S	Mask ROM number	
MICROCOMPUTER M306 MASK ROM CONFIRM		
(2) Which kind of XCIN-XCOUT oscilla  ☐ Ceramic resonator ☐ External clock input  What frequency do you use?  f(XCIN) = kHz	☐ Quartz-crystal oscillator	
(3) Which operation mode do you us ☐ Single-chip mode ☐ Microprocessor mode	se?  Memory expansion mode	
(4) Which operating ambient temper □ -10 °C to 75 °C □ -10 °C to 85 °C		☐ -40 °C to 75 °C ☐ -40 °C to 85 °C
(5) Which operating supply voltage (☐ 2.7V to 3.2V ☐ 4.2V to 4.7V	do you use? ☐ 3.2V to 3.7V ☐ 4.7V to 5.2V	☐ 3.7V to 4.2V ☐ 5.2V to 5.5V
Thank you cooperation.		

% 4. Special item (Indicate none if there is no specified item)



GZZ-SH12-55B <71A1>

# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612MAA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	
-----------------	--

	Date :	
ţ	Section head signature	Supervisor signature
Receipt		

Note: Please complete all items marked %.

		Company		TEL		Submitted by	Supervisor	
<b>%</b>	Customer	name		(	)	iance ature		
<b>^</b> `	Gustomer	Date issued	Date :			Issu sign		

#### % 1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Microcomputer type No.:	☐ M30612MAA-XXXFP	☐ M30612MAA-XXXGP

Checksum code for total EPROM area : (hex)

#### EPROM type:

☐ 27C201	☐ 27C401
Address 0000016	Address 0000016

- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30612MAA-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Address		
0000016	'M '	= 4D <sub>16</sub>
0000116	'3'	= 3316
0000216	'0'	= 3016
0000316	'6'	= 3616
0000416	'1'	= 3116
0000516	'2'	= 3216
0000616	'M '	= 4D <sub>16</sub>
0000716	'A'	= 4116

Address		
0000816	' A '	= 4116
0000916	<u>.</u>	= 2D <sub>16</sub>
0000A <sub>16</sub>		FF <sub>16</sub>
0000B <sub>16</sub>		FF <sub>16</sub>
0000C <sub>16</sub>		FF <sub>16</sub>
0000D <sub>16</sub>		FF <sub>16</sub>
0000E <sub>16</sub>		FF <sub>16</sub>
0000F <sub>16</sub>		FF <sub>16</sub>



GZZ-SH11-55B <71A1>

# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612MAA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EPROM type	27	C201		27C401
Code entered in source program	1 ^ 0=0 ^ 10====:		A ∴ SECTION ASCIICODE, ROM DATA A ∴ ORG △ 080000H A ∴ BYTE △ ' M30612MAA- '	
Note: The ROM of in the check		d if the type No. written to	the EPR	OM does not match the type No.
☐ In the case	of floppy disks			
the floppy disk there is any dis products we pr	s you give in to us, a screpancy between oduce. Check thoro	and forms them into mas the contents of these ma oughly the contents of the	sks. Hence ask files ar e mask file	ration utilities out of those held on e, we assume liability provided that he had the ROM data to be burned into es you give in. e mask file in a floppy disk.
Microcomp	uter type No. :	☐ M30612MAA-XXX	FP	☐ M30612MAA-XXXGP
File code :				(hex)
Mask file na	ame :			.MSK (alpha-numeric 8-digit)
%2. Mark specifica			Λ	
				r entering the mark specification on t sheet to this masking check sheet
			ecification	sheet. For the M30612MAA-XXXGP
¾ 3. Usage Condit	ions			
For our referer the products yo		our products, please rep	ly to the fo	ollowing questions about the usage of
(1) Which kind of XIN-XOUT oscillation circuit is used?  ☐ Ceramic resonator ☐ Quartz-crystal oscillator ☐ External clock input ☐ Other ( )  What frequency do you use?				



f(XIN) =

MHz

GZZ-SH11-55B <71A1>

#### Mask ROM number MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612MAA-XXXFP/GP MASK ROM CONFIRMATION FORM (2) Which kind of XCIN-XCOUT oscillation circuit is used? ☐ Ceramic resonator ☐ Quartz-crystal oscillator ☐ External clock input Other ( What frequency do you use? f(XCIN) =(3) Which operation mode do you use? ☐ Single-chip mode ☐ Memory expansion mode ☐ Microprocessor mode (4) Which operating ambient temperature do you use? ☐-20 °C to 75 °C ☐-20 °C to 85 °C ☐ -40 °C to 75 °C ☐ −10 °C to 75 °C (5) Which operating supply voltage do you use? ☐ 2.7V to 3.2V ☐ 3.2V to 3.7V ☐ 3.7V to 4.2V ☐ 4.2V to 4.7V ☐ 4.7V to 5.2V ☐ 5.2V to 5.5V Thank you cooperation.

4. Special item (Indicate none if there is no specified item)



GZZ-SH11-54B <71A1>

# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612MCA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

	Date :	
±	Section head signature	Supervisor signature
Receipt		
, a		

Note: Please complete all items marked %.

		Company		TEL			Submitted by	Supervisor
\°/	0 1	name		(	)	ance ature		
*	Customer	Date issued	Date :			Issua		

#### **%** 1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

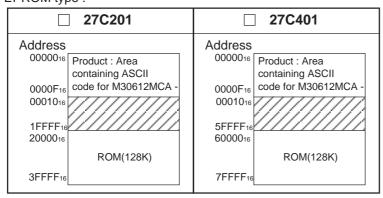
☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Microcomputer type No. : ☐ M30612MCA-XXXFP ☐ M30612MCA-XXX	omputer type No.:	☐ M30612MCA-XXXFP	☐ M30612MCA-XXXGP
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Checksum code for total EPROM area : (hex)

## EPROM type:



- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30612MCA-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Address		
0000016	'M '	= 4D <sub>16</sub>
0000116	'3'	= 3316
0000216	'0'	= 3016
0000316	'6'	= 3616
0000416	'1'	= 3116
0000516	'2'	= 3216
0000616	'M '	= 4D <sub>16</sub>
0000716	'C'	= 4316

Address		
0000816	' A '	= 4116
0000916	<u> </u>	= 2D <sub>16</sub>
0000A <sub>16</sub>		FF <sub>16</sub>
0000B <sub>16</sub>		FF <sub>16</sub>
0000C <sub>16</sub>		FF <sub>16</sub>
0000D <sub>16</sub>		FF <sub>16</sub>
0000E <sub>16</sub>		FF <sub>16</sub>
0000F <sub>16</sub>		FF <sub>16</sub>



$\sim$ 77	CIIAA	E 4 D	<71A1>
(7//—	2411-	- 545	1A15</td

# MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30612MCA-XXXFP/GP MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EPROM type	27C201				27C401		
Code entered in source program	△ .SECTION△ASCIICODE, ROM DATA △ .ORG △ 0C0000H △ .BYTE △ ' M30612MCA- '			△.	△ .SECTION△ ASCIICODE, ROM DATA △ .ORG △ 080000H △ .BYTE △ ' M30612MCA- '		
Note: The ROM of in the check		I if the type N	o. writte	n to the	EPR	ROM does not match the type No.	
☐ In the case of	of floppy disks						
the floppy disk there is any dis products we pr	s you give in to us, a screpancy between oduce. Check thoro	and forms the the contents o ughly the cor	m into n of these itents of	nasks. F mask fil the mas	lence les a sk file	eration utilities out of those held on e, we assume liability provided that nd the ROM data to be burned into es you give in. he mask file in a floppy disk.	
Microcomp	uter type No. :	☐ M30612	2MCA-X	XXFP		☐ M30612MCA-XXXGP	
File code :						hex)	
Mask file na	ame :					.MSK (alpha-numeric 8-digit)	
the separate m for submission For the M3061	cification differs acco nark specification sh to Mitsubishi.	eet (for each mit the 100P6	package	e), attac	h tha	er entering the mark specification on at sheet to this masking check sheet a sheet. For the M30612MCA-XXXGF	
	ions						
For our referenthe products yo		our products,	please r	eply to	the fo	ollowing questions about the usage o	
∵ □ ( □ E What fr	kind of XIN-XOUT osc Ceramic resonator External clock input equency do you use IN) =	□ Qua □ Oth	artz-crys		lator )		



GZZ-SH11-54B <71A1>

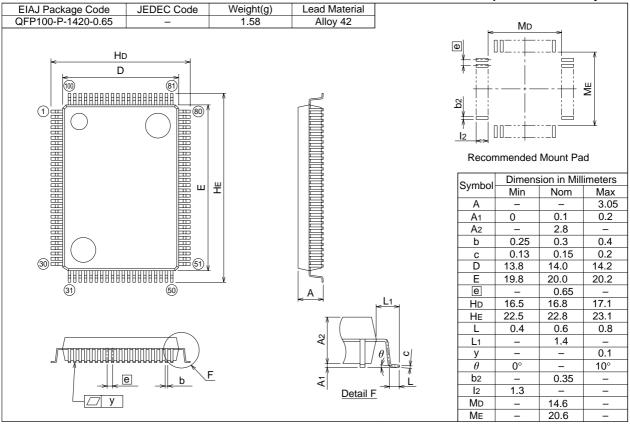
MITSUBISHI ELECTRIC	Mask ROM number					
MICROCOMPUTER M3 MASK ROM CONF						
(2) Which kind of XCIN-XCOUT of Ceramic resonator  ☐ External clock input  What frequency do you use  f(XCIN) =  ☐ I	<ul><li>Quartz-crystal oscillator</li><li>Other ( )</li></ul>					
(3) Which operation mode do y ☐ Single-chip mode ☐ Microprocessor mod	☐ Memory expansion mode					
(4) Which operating ambient te  □ -10 °C to 75 °C  □ -10 °C to 85 °C	emperature do you use?  —20 °C to 75 °C  —20 °C to 85 °C	□ -40 °C to 75 °C □ -40 °C to 85 °C				
(5) Which operating supply volt  ☐ 2.7V to 3.2V  ☐ 4.2V to 4.7V	tage do you use? □3.2V to 3.7V □4.7V to 5.2V	☐ 3.7V to 4.2V ☐ 5.2V to 5.5V				
Thank you cooperation.						

4. Special item (Indicate none if there is no specified item)



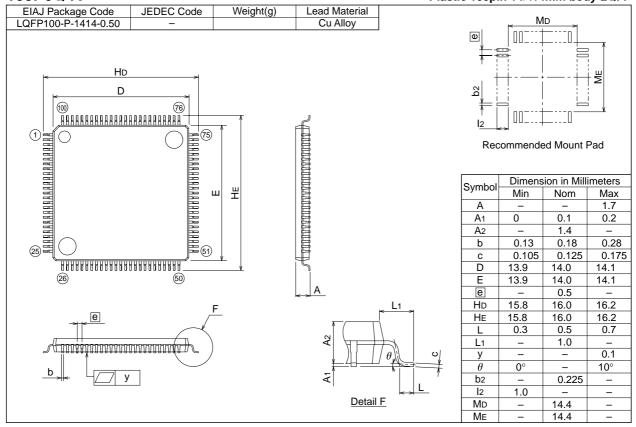
## 100P6S-A

#### Plastic 100pin 14×20mm body QFP



## 100P6Q-A

#### Plastic 100pin 14×14mm body LQFP



# Differences between M16C/61 group and M30600M8

Type name		M16C/61 group	M30600M8	
Internal memory	ROM	See Figure 4. ROM Expansion	64 K bytes	
size	RAM	4 K to 10 K bytes	10 K bytes	
Chip select		CS0 3000016 to FFFFF16 (besides internal area) CS1 2800016 to 2FFFF16 CS2 0800016 to 27FFF16 CS3 0400016 to 07FFF16	CS0 9000016 to FFFF16 (besides internal area) CS1 1000016 to 8FFFF16 CS2 0800016 to 0FFFF16 CS3 0400016 to 07FFF16	
Internal area on memory expansion mode		SFR area 0000016 to 003FF16 RAM area 0040016 to 03FF16 ROM area D000016 to FFFF16 (PM16=0) ROM area F800016 to FFFF16 (PM16=1) (Note)	SFR area 0000016 to 003FF16 RAM area 0040016 to 03FFF16 ROM area D000016 to FFFFF16 (FIX)	
Serial I/O		3 channel (clocked SIO / UART) :2 channel (clocked SIO / UART / SIM)	2 channel (clocked SIO / UART)	
Port P70 to P73 function		Port P70 TxD2 / TA00UT Port P71 RxD2 / TA0IN Port P72 CLK2 / TA10UT Port P73 CTS2 / RTS2 / TA1IN	Port P70 TA0out Port P71 TA0in Port P72 TA1out Port P73 TA1in	
Port output style		Port P70 and Port P71 are N-channel open drain Others are CMOS	All Ports are CMOS	
Port P93 and P94 pull-up set up condition		All of the following:  • Pull-up is selected.  • DA output is enabled.  • Input port is selected.	Both of the following:  • Pull-up is selected.  • Input port is selected.	
Interrupt sources		Internal 20 sources External 5 sources Software 4 sources Add 3 sources -trans., recv. and arbit. for UART2	Internal 17 sources External 5 sources Software 4 sources	
DMA request		DMA0 DMA1 1100 UART2 trans. UART2 trans. 1101 UART2 recv. UART2 recv. 1110 A-D A-D 1111 UART1 trans. UART1 recv.	DMA0 DMA1 1100 UART1 trans. UART1 trans. 1101 UART1 recv. UART1 recv. 1110 A-D A-D 1111 prohibited prohibited	

Note: M30612M4A/E4 only.



Internally reserved for ROM(possible to use for external devices under PM16=1)

# Memory map Comparison

CFFFF16 D000016 02BFF<sub>16</sub> 02C00<sub>16</sub> EFFFF<sub>16</sub> F0000<sub>16</sub> 003FF<sub>16</sub> 00400<sub>16</sub> FFFFF16 0000016 1000016 M30600M8 Memory area (ROM 64K bytes, RAM 10K bytes) Internal ROM Internal RAM Single-chip mode SFR area Inhibited Memory expansion mode Internal RAM Internal ROM Internally reserved Internally reserved SFR area External memory area Internal RAM Microprocessor mode SFR area memory External External area(possible to use for external devices) 07FFF16 0800016 0FFFF16 1000016 8FFFF16 9000016 FFFFF<sub>16</sub> 0400016 CS0 (256K:Memory expansion) (448K:Microprocessor) CS1(512K) CS2(128K) CS3(16K) Internal area Inhibited CS1(32K) CS3(16K) 0400016 07FFF16 0800016 27FFF16 2800016 2FFFF16 3000016 FFFFF16 M30612M4A Memory area (ROM 32K bytes, RAM 4K bytes) Internal RAM Microprocessor mode SFR area Internally reserved memory External Memory expansion mode Internal RAM Internal ROM External SFR area memory Internally reserved area Internal ROM Internal RAM Single-chip mode SFR area Inhibited CFFFF16 D000016 F7FFF<sub>16</sub> F8000<sub>16</sub> 003FF<sub>16</sub> 0040016 013FF<sub>16</sub> 0140016 FFFFF16 1000016 0000016



## -Keep safety first in your circuit designs!-

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